

### FEATURES

- Low cost 3.3 V CMOS MxFE for broadband modems
- 12-bit DAC
  - 2×/4× interpolation filter
  - 200 MSPS DAC update rate
- Integrated 23 dBm line driver with 19.5 dB gain control
- 12-bit, 80 MSPS ADC
  - 12 dB to +48 dB low noise RxPGA (<2.5 nV/√Hz)
- Third order, programmable low-pass filter
- Flexible digital data path interface
  - Half- and full-duplex operation
  - Backward-compatible with AD9975 and AD9876
- Various power-down/reduction modes
- Internal clock multiplier (PLL)
- 2 auxiliary programmable clock outputs
- Available in 64-lead chip scale package or bare die

### APPLICATIONS

- Powerline networking
- VDSL and HPNA

### FUNCTIONAL BLOCK DIAGRAM

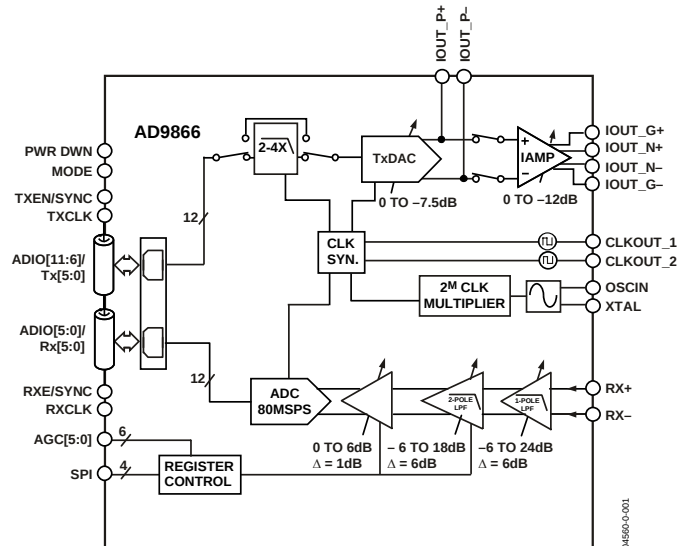


Figure 1.

### GENERAL DESCRIPTION

The AD9866 is a mixed-signal front end (MxFE®) IC for transceiver applications requiring Tx and Rx path functionality with data rates up to 80 MSPS. Its flexible digital interface, power saving modes, and high Tx-to-Rx isolation make it well-suited for half- and full-duplex applications. The digital interface is extremely flexible allowing simple interfaces to digital back ends that support half- or full-duplex data transfers, thus often allowing the AD9866 to replace discrete ADC and DAC solutions. Power saving modes include the ability to reduce power consumption of individual functional blocks or to power down unused blocks in half-duplex applications. A serial port interface (SPI®) allows software programming of the various functional blocks. An on-chip PLL clock multiplier and synthesizer provide all the required internal clocks, as well as two external clocks from a single crystal or clock source.

The Tx signal path consists of a bypassable 2×/4× low-pass interpolation filter, a 12-bit TxDAC, and a line driver. The transmit path signal bandwidth can be as high as 34 MHz at an input data rate of 80 MSPS. The TxDAC provides differential current outputs that can be steered directly to an external load

or to an internal low distortion current amplifier. The current amplifier (IAMP) can be configured as a current- or voltage-mode line driver (with two external npn transistors) capable of delivering in excess of 23 dBm peak signal power. Tx power can be digitally controlled over a 19.5 dB range in 0.5 dB steps.

The receive path consists of a programmable amplifier (RxPGA), a tunable low pass filter (LPF), and a 12-bit ADC. The low noise RxPGA has a programmable gain range of –12 dB to +48 dB in 1 dB steps. Its input referred noise is less than 3.3 nV/√Hz for gain settings beyond 30 dB. The receive path LPF cutoff frequency can be set over a 15 MHz to 35 MHz range or simply bypassed. The 12-bit ADC achieves excellent dynamic performance over a 5 MSPS to 80 MSPS span. Both the RxPGA and the ADC offer scalable power consumption allowing power/performance optimization.

The AD9866 provides a highly integrated solution for many broadband modems. It is available in a space saving, 64-lead lead frame chip scale package (LFCSP), and is specified over the commercial (–40°C to +85°C) temperature range.

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## SPECIFICATIONS

### Tx PATH SPECIFICATIONS

AVDD = 3.3 V  $\pm$  5%, DVDD = CLKVDD = DRVDD = 3.3 V  $\pm$  10%;  $f_{\text{OSCIN}}$  = 50 MHz,  $f_{\text{DAC}}$  = 200 MHz,  $R_{\text{SET}}$  = 2.0 k $\Omega$ , unless otherwise noted.

Table 1.

| Parameter                                                                     | Temp | Test Level | Min  | Typ       | Max   | Unit                            |
|-------------------------------------------------------------------------------|------|------------|------|-----------|-------|---------------------------------|
| <b>TxDAC DC CHARACTERISTICS</b>                                               |      |            |      |           |       |                                 |
| Resolution                                                                    | Full |            |      | 12        |       | Bits                            |
| Update Rate                                                                   | Full | II         |      |           | 200   | MSPS                            |
| Full-Scale Output Current (IOUTP_FS)                                          | Full | IV         | 2    |           | 25    | mA                              |
| Gain Error <sup>1</sup>                                                       | 25°C | I          |      | $\pm 2$   |       | % FS                            |
| Offset Error                                                                  | 25°C | V          |      | 2         |       | $\mu$ A                         |
| Voltage Compliance Range                                                      | Full |            | −1   |           | +1.5  | V                               |
| <b>TxDAC GAIN CONTROL CHARACTERISTICS</b>                                     |      |            |      |           |       |                                 |
| Minimum Gain                                                                  | 25°C | V          |      | −7.5      |       | dB                              |
| Maximum Gain                                                                  | 25°C | V          |      | 0         |       | dB                              |
| Gain Step Size                                                                | 25°C | V          |      | 0.5       |       | dB                              |
| Gain Step Accuracy                                                            | 25°C | IV         |      | Monotonic |       |                                 |
| Gain Range Error                                                              | 25°C | V          |      | $\pm 2$   |       | dB                              |
| <b>TxDAC AC CHARACTERISTICS<sup>2</sup></b>                                   |      |            |      |           |       |                                 |
| Fundamental                                                                   |      |            |      | 0.5       |       | dBm                             |
| Signal-to-Noise and Distortion (SINAD)                                        | Full | IV         | 66.6 | 69.2      |       | dBc                             |
| Signal-to-Noise Ratio (SNR)                                                   | Full | IV         | 68.4 | 69.8      |       | dBc                             |
| Total Harmonic Distortion (THD)                                               | Full | IV         |      | −79       | −68.7 | dBc                             |
| Spurious-Free Dynamic Range (SFDR)                                            | Full | IV         | 68.5 | 81        |       | dBc                             |
| <b>IAMP DC CHARACTERISTICS</b>                                                |      |            |      |           |       |                                 |
| IOUTN Full-Scale Current = IOUTN+ + IOUTN−                                    | Full | IV         | 2    |           | 105   | mA                              |
| IOUTG Full-Scale Current = IOUTG+ + IOUTG−                                    | Full | IV         | 2    |           | 150   | mA                              |
| AC Voltage Compliance Range                                                   | Full | IV         | 1    |           | 7     | V                               |
| <b>IAMPN AC CHARACTERISTICS<sup>3</sup></b>                                   |      |            |      |           |       |                                 |
| Fundamental                                                                   | 25°C |            |      | 13        |       | dBm                             |
| IOUTN SFDR (Third Harmonic)                                                   | Full | IV         | 43.3 | 45.2      |       | dBc                             |
| <b>IAMP GAIN CONTROL CHARACTERISTICS</b>                                      |      |            |      |           |       |                                 |
| Minimum Gain                                                                  | 25°C | V          |      | −19.5     |       | dB                              |
| Maximum Gain                                                                  | 25°C | V          |      | 0         |       | dB                              |
| Gain Step Size                                                                | 25°C | V          |      | 0.5       |       | dB                              |
| Gain Step Accuracy                                                            | 25°C | IV         |      | Monotonic |       | dB                              |
| IOUTN Gain Range Error                                                        | 25°C | V          |      | 0.5       |       | dB                              |
| <b>REFERENCE</b>                                                              |      |            |      |           |       |                                 |
| Internal Reference Voltage <sup>4</sup>                                       | 25°C | I          |      | 1.23      |       | V                               |
| Reference Error                                                               | Full | V          |      | 0.7       | 3.4   | %                               |
| Reference Drift                                                               | Full | V          |      | 30        |       | ppm/°C                          |
| <b>Tx DIGITAL FILTER CHARACTERISTICS (2<math>\times</math> INTERPOLATION)</b> |      |            |      |           |       |                                 |
| Latency (Relative to 1/ $f_{\text{DAC}}$ )                                    | Full | V          |      | 43        |       | Cycles                          |
| −0.2 dB Bandwidth                                                             | Full | V          |      | 0.2187    |       | $f_{\text{OUT}}/f_{\text{DAC}}$ |
| −3 dB Bandwidth                                                               | Full | V          |      | 0.2405    |       | $f_{\text{OUT}}/f_{\text{DAC}}$ |
| Stop-Band Rejection (0.289 $f_{\text{DAC}}$ to 0.711 $f_{\text{DAC}}$ )       | Full | V          |      | 50        |       | dB                              |
| <b>Tx DIGITAL FILTER CHARACTERISTICS (4<math>\times</math> Interpolation)</b> |      |            |      |           |       |                                 |
| Latency (Relative to 1/ $f_{\text{DAC}}$ )                                    | Full | V          |      | 96        |       | Cycles                          |
| −0.2 dB Bandwidth                                                             | Full | V          |      | 0.1095    |       | $f_{\text{OUT}}/f_{\text{DAC}}$ |
| −3 dB Bandwidth                                                               | Full | V          |      | 0.1202    |       | $f_{\text{OUT}}/f_{\text{DAC}}$ |
| Stop Band Rejection (0.289 $f_{\text{OSCIN}}$ to 0.711 $f_{\text{OSCIN}}$ )   | Full | V          |      | 50        |       | dB                              |

| Parameter                                   | Temp | Test Level | Min | Typ    | Max | Unit   |
|---------------------------------------------|------|------------|-----|--------|-----|--------|
| PLL CLK MULTIPLIER                          |      |            |     |        |     |        |
| OSCIN Frequency Range                       | Full | IV         | 5   |        | 80  | MHz    |
| Internal VCO Frequency Range                | Full | IV         | 20  |        | 200 | MHz    |
| Duty Cycle                                  | Full | II         | 40  |        | 60  | %      |
| OSCIN Impedance                             | 25°C | V          |     | 100//3 |     | MΩ//pF |
| CLKOUT1 Jitter <sup>5</sup>                 | 25°C | III        |     | 12     |     | ps rms |
| CLKOUT2 Jitter <sup>6</sup>                 | 25°C | III        |     | 6      |     | ps rms |
| CLKOUT1 and CLKOUT2 Duty Cycle <sup>7</sup> | Full | III        | 45  |        | 55  | %      |

<sup>1</sup> Gain error and gain temperature coefficients are based on the ADC only (with a fixed 1.23 V external reference and a 1 V p-p differential analog input).

<sup>2</sup> TxDAC IOUTFS = 20 mA, differential output with 1:1 transformer with source and load termination of 50 Ω, F<sub>OUT</sub> = 5 MHz, 4× interpolation.

<sup>3</sup> IOUN full-scale current = 80 mA, f<sub>OSCIN</sub> = 80 MHz, f<sub>DAC</sub> = 160 MHz, 2× interpolation.

<sup>4</sup> Use external amplifier to drive additional load.

<sup>5</sup> Internal VCO operates at 200 MHz, set to divide-by-1.

<sup>6</sup> Because CLKOUT2 is a divided down version of OSCIN, its jitter is typically equal to OSCIN.

<sup>7</sup> CLKOUT2 is an inverted replica of OSCIN, if set to divide-by-1.

## Rx PATH SPECIFICATIONS

AVDD = 3.3 V ± 5%, DVDD = CLKVDD = DRVDD = 3.3 V ± 10%; half- or full-duplex operation with CONFIG = 0 default power bias settings, unless otherwise noted.

Table 2.

| Parameter                                                                     | Temp | Test Level | Min | Typ       | Max | Unit   |
|-------------------------------------------------------------------------------|------|------------|-----|-----------|-----|--------|
| Rx INPUT CHARACTERISTICS                                                      |      |            |     |           |     |        |
| Input Voltage Span (RxPGA gain = −10 dB)                                      | Full | III        |     | 6.33      |     | V p-p  |
| Input Voltage Span (RxPGA gain = +48 dB)                                      | Full | III        |     | 8         |     | mV p-p |
| Input Common-Mode Voltage                                                     | 25°C | III        |     | 1.3       |     | V      |
| Differential Input Impedance                                                  | 25°C | III        |     | 400       |     | Ω      |
|                                                                               |      |            |     | 4.0       |     | pF     |
| Input Bandwidth (with RxLPF Disabled, RxPGA = 0 dB)                           | 25°C | III        |     | 53        |     | MHz    |
| Input Voltage Noise Density (RxPGA Gain = 36 dB, f <sub>−3 dB</sub> = 26 MHz) | 25°C | III        |     | 2.7       |     | nV/√Hz |
| Input Voltage Noise Density (RxPGA Gain = 48 dB, f <sub>−3 dB</sub> = 26 MHz) | 25°C | III        |     | 2.4       |     | nV/√Hz |
| RxPGA CHARACTERISTICS                                                         |      |            |     |           |     |        |
| Minimum Gain                                                                  | 25°C | III        |     | −12       |     | dB     |
| Maximum Gain                                                                  | 25°C | III        |     | 48        |     | dB     |
| Gain Step Size                                                                | 25°C | III        |     | 1         |     | dB     |
| Gain Step Accuracy                                                            | 25°C | III        |     | Monotonic |     | dB     |
| Gain Range Error                                                              | 25°C | III        |     | 0.5       |     | dB     |
| RxLPF CHARACTERISTICS                                                         |      |            |     |           |     |        |
| Cutoff Frequency (f <sub>−3 dB</sub> ) range                                  | Full | III        | 15  |           | 35  | MHz    |
| Attenuation at 55.2 MHz with f <sub>−3 dB</sub> = 21 MHz                      | 25°C | III        |     | 20        |     | dB     |
| Pass-Band Ripple                                                              | 25°C | III        |     | ±1        |     | dB     |
| Settling Time to 5 dB RxPGA Gain Step @ f <sub>ADC</sub> = 50 MSPS            | 25°C | III        |     | 20        |     | ns     |
| Settling Time to 60 dB RxPGA Gain Step @ f <sub>ADC</sub> = 50 MSPS           | 25°C | III        |     | 100       |     | ns     |
| ADC DC CHARACTERISTICS                                                        |      |            |     |           |     |        |
| Resolution                                                                    | NA   | NA         |     | 12        |     | Bits   |
| Conversion Rate                                                               | FULL | II         | 5   |           | 80  | MSPS   |

| Parameter                                                                    | Temp | Test Level | Min  | Typ   | Max   | Unit   |
|------------------------------------------------------------------------------|------|------------|------|-------|-------|--------|
| Rx PATH LATENCY <sup>1</sup>                                                 |      |            |      |       |       |        |
| Full-Duplex Interface                                                        | Full | V          |      | 10.5  |       | Cycles |
| Half-Duplex Interface                                                        | Full | V          |      | 10.0  |       | Cycles |
| Rx PATH COMPOSITE AC PERFORMANCE @ $f_{ADC} = 50 \text{ MSPS}$ <sup>2</sup>  |      |            |      |       |       |        |
| RxPGA Gain = 48 dB (Full-Scale = 8.0 mV p-p)                                 |      |            |      |       |       |        |
| Signal-to-Noise (SNR)                                                        | 25°C | III        |      | 43.7  |       | dBc    |
| Total Harmonic Distortion (THD)                                              | 25°C | III        |      | -71   |       | dBc    |
| RxPGA Gain = 24 dB (Full-Scale = 126 mV p-p)                                 |      |            |      |       |       |        |
| Signal-to-Noise (SNR)                                                        | 25°C | III        |      | 63.1  |       | dBc    |
| Total Harmonic Distortion (THD)                                              | 25°C | III        |      | -67.2 |       | dBc    |
| RxPGA Gain = 0 dB (Full-Scale = 2.0 V p-p)                                   |      |            |      |       |       |        |
| Signal-to-Noise (SNR)                                                        | Full | IV         |      | 64.3  |       | dBc    |
| Total Harmonic Distortion (THD)                                              | Full | IV         |      | -67.3 |       | dBc    |
| Rx PATH COMPOSITE AC PERFORMANCE @ $f_{ADC} = 80 \text{ MSPS}$ <sup>3</sup>  |      |            |      |       |       |        |
| RxPGA Gain = 48 dB (Full-Scale = 8.0 mV p-p)                                 |      |            |      |       |       |        |
| Signal-to-Noise (SNR)                                                        | 25°C | III        |      | 41.8  |       | dBc    |
| Total Harmonic Distortion (THD)                                              | 25°C | III        |      | -67   |       | dBc    |
| RxPGA Gain = 24 dB (Full-Scale = 126 mV p-p)                                 |      |            |      |       |       |        |
| Signal-to-Noise (SNR)                                                        | 25°C | III        |      | 58.6  |       | dBc    |
| Total Harmonic Distortion (THD)                                              | 25°C | III        |      | -62.9 |       | dBc    |
| RxPGA Gain = 0 dB (Full-Scale = 2.0 V p-p)                                   |      |            |      |       |       |        |
| Signal-to-Noise (SNR)                                                        | 25°C | II         | 61.1 | 62.9  |       | dBc    |
| Total Harmonic Distortion (THD)                                              | 25°C | II         |      | -70.8 | -60.8 | dBc    |
| Rx-to-Tx PATH FULL-DUPLEX ISOLATION<br>(1 V p-p, 10 MHz Sine Wave Tx Output) |      |            |      |       |       |        |
| RxPGA Gain = 40 dB                                                           |      |            |      |       |       |        |
| IOU $\overline{TP}$ ± Pins to RX± Pins                                       | 25°C | III        |      | 83    |       | dBc    |
| IOU $\overline{TG}$ ± Pins to RX± Pins                                       | 25°C | III        |      | 37    |       | dBc    |
| RxPGA Gain = 0 dB                                                            |      |            |      |       |       |        |
| IOU $\overline{TP}$ ± Pins to RX± Pins                                       | 25°C | III        |      | 123   |       | dBc    |
| IOU $\overline{TG}$ ± Pins to RX± Pins                                       | 25°C | III        |      | 77    |       | dBc    |

<sup>1</sup> Includes RxPGA, ADC pipeline, and ADIO bus delay relative to  $f_{ADC}$ .

<sup>2</sup>  $f_{IN} = 5 \text{ MHz}$ ,  $A_{IN} = -1.0 \text{ dBFS}$ , LPF cutoff frequency set to 15.5 MHz with Reg. 0x08 = 0x80.

<sup>3</sup>  $f_{IN} = 5 \text{ MHz}$ ,  $A_{IN} = -1.0 \text{ dBFS}$ , LPF cutoff frequency set to 26 MHz with Reg. 0x08 = 0x80.

## POWER SUPPLY SPECIFICATIONS

$AVDD = 3.3 \text{ V}$ ,  $DVDD = CLKVDD = DRVDD = 3.3 \text{ V}$ ;  $R_{SET} = 2 \text{ k}\Omega$ , full-duplex operation with  $f_{DATA} = 80 \text{ MSPS}$ ,<sup>1</sup> unless otherwise noted.

Table 3.

| Parameter                                       | Temp | Test Level | Min   | Typ | Max   | Unit |
|-------------------------------------------------|------|------------|-------|-----|-------|------|
| SUPPLY VOLTAGES                                 |      |            |       |     |       |      |
| AVDD                                            | Full | V          | 3.135 | 3.3 | 3.465 | V    |
| CLKVDD                                          | Full | V          | 3.0   | 3.3 | 3.6   | V    |
| DVDD                                            | Full | V          | 3.0   | 3.3 | 3.6   | V    |
| DRVDD                                           | Full | V          | 3.0   | 3.3 | 3.6   | V    |
| IS_TOTAL (Total Supply Current)                 | Full | II         |       | 406 | 475   | mA   |
| POWER CONSUMPTION                               |      |            |       |     |       |      |
| $I_{AVDD} + I_{CLKVDD}$ (Analog Supply Current) |      | IV         |       | 311 | 342   | mA   |
| $I_{DVDD} + I_{DRVDD}$ (Digital Supply Current) | Full | IV         |       | 95  | 133   | mA   |

| Parameter                                                                                        | Temp | Test Level | Min | Typ  | Max  | Unit |
|--------------------------------------------------------------------------------------------------|------|------------|-----|------|------|------|
| POWER CONSUMPTION (Half-Duplex Operation with $f_{\text{DATA}} = 50 \text{ MSPS}$ ) <sup>1</sup> |      |            |     |      |      |      |
| Tx Mode                                                                                          |      |            |     |      |      |      |
| $I_{\text{AVDD}} + I_{\text{CLKVDD}}$                                                            | 25°C | IV         |     | 112  | 130  | mA   |
| $I_{\text{DVDD}} + I_{\text{DRVDD}}$                                                             | 25°C | IV         |     | 46   | 49.5 | mA   |
| Rx Mode                                                                                          |      |            |     |      |      |      |
| $I_{\text{AVDD}} + I_{\text{CLKVDD}}$                                                            | 25°C |            |     | 225  | 253  | mA   |
| $I_{\text{DVDD}} + I_{\text{DRVDD}}$                                                             | 25°C |            |     | 36.5 | 39   | mA   |
| POWER CONSUMPTION OF FUNCTIONAL BLOCKS <sup>2</sup> ( $I_{\text{AVDD}} + I_{\text{CLKVDD}}$ )    |      |            |     |      |      |      |
| RxPGA and LPF                                                                                    | 25°C | III        |     | 87   |      | mA   |
| ADC                                                                                              | 25°C | III        |     | 108  |      | mA   |
| TxDAC                                                                                            | 25°C | III        |     | 38   |      | mA   |
| IAMP (Programmable)                                                                              | 25°C | III        | 10  |      | 120  | mA   |
| Reference                                                                                        | 25°C | III        |     | 170  |      | mA   |
| CLK PLL and Synthesizer                                                                          | 25°C | III        |     | 107  |      | mA   |
| MAXIMUM ALLOWABLE POWER DISSIPATION                                                              | Full | IV         |     |      | 1.66 | W    |
| STANDBY POWER CONSUMPTION                                                                        |      |            |     |      |      |      |
| $I_{\text{S\_TOTAL}}$ (Total Supply Current)                                                     | Full |            |     | 13   |      | mA   |
| POWER-DOWN DELAY (USING PWR_DWN PIN)                                                             |      |            |     |      |      |      |
| RxPGA and LPF                                                                                    | 25°C | III        |     | 440  |      | ns   |
| ADC                                                                                              | 25°C | III        |     | 12   |      | ns   |
| TxDAC                                                                                            | 25°C | III        |     | 20   |      | ns   |
| IAMP                                                                                             | 25°C | III        |     | 20   |      | ns   |
| CLK PLL and Synthesizer                                                                          | 25°C | III        |     | 27   |      | ns   |
| POWER-UP DELAY (USING PWR_DWN PIN)                                                               |      |            |     |      |      |      |
| RxPGA and LPF                                                                                    | 25°C | III        |     | 7.8  |      | μs   |
| ADC                                                                                              | 25°C | III        |     | 88   |      | ns   |
| TxDAC                                                                                            | 25°C | III        |     | 13   |      | μs   |
| IAMP                                                                                             | 25°C | III        |     | 20   |      | ns   |
| CLK PLL and Synthesizer                                                                          | 25°C | III        |     | 20   |      | μs   |

<sup>1</sup> Default power-up settings for MODE = LOW and CONFIG = LOW.

<sup>2</sup> Default power-up settings for MODE = HIGH and CONFIG = LOW,  $I_{\text{OUTP\_FS}} = 20 \text{ mA}$ , does not include IAMP's current consumption, which is application dependent.

## DIGITAL SPECIFICATIONS

$\text{AVDD} = 3.3 \text{ V} \pm 5\%$ ,  $\text{DVDD} = \text{CLKVDD} = \text{DRVDD} = 3.3 \text{ V} \pm 10\%$ ;  $R_{\text{SET}} = 2 \text{ k}\Omega$ , unless otherwise noted.

Table 4.

| Parameter                                                                         | Temp | Test Level | Min                  | Typ     | Max     | Unit         |
|-----------------------------------------------------------------------------------|------|------------|----------------------|---------|---------|--------------|
| CMOS LOGIC INPUTS                                                                 |      |            |                      |         |         |              |
| High Level Input Voltage                                                          | Full | VI         | $\text{DRVDD} - 0.7$ |         |         | V            |
| Low Level Input Voltage                                                           | Full | VI         |                      |         | 0.4     | V            |
| Input Leakage Current                                                             |      |            |                      |         | 12      | μA           |
| Input Capacitance                                                                 | Full | VI         |                      | 3       |         | pF           |
| CMOS LOGIC OUTPUTS ( $C_{\text{LOAD}} = 5 \text{ pF}$ )                           |      |            |                      |         |         |              |
| High Level Output Voltage ( $I_{\text{OH}} = 1 \text{ mA}$ )                      | Full | VI         | $\text{DRVDD} - 0.7$ |         |         | V            |
| Low Level Output Voltage ( $I_{\text{OH}} = 1 \text{ mA}$ )                       | Full | VI         |                      |         | 0.4     | V            |
| Output Rise/Fall Time (High Strength Mode and $C_{\text{LOAD}} = 15 \text{ pF}$ ) | Full | VI         |                      |         | 1.5/2.3 | ns           |
| Output Rise/Fall Time (Low Strength Mode and $C_{\text{LOAD}} = 15 \text{ pF}$ )  | Full | VI         |                      | 1.9/2.7 |         | ns           |
| Output Rise/Fall Time (High Strength Mode and $C_{\text{LOAD}} = 5 \text{ pF}$ )  | Full | VI         |                      | 0.7/0.7 |         | ns           |
| Output Rise/Fall Time (Low Strength Mode and $C_{\text{LOAD}} = 5 \text{ pF}$ )   | Full | VI         |                      | 1.0/1.0 |         | ns           |
| RESET                                                                             |      |            |                      |         |         |              |
| Minimum Low Pulse Width (Relative to $f_{\text{ADC}}$ )                           |      |            | 1                    |         |         | Clock cycles |

**SERIAL PORT TIMING SPECIFICATIONS**

AVDD = 3.3 V  $\pm$  5%, DVDD = CLKVDD = DRVDD = 3.3 V  $\pm$  10%, unless otherwise noted.

**Table 5.**

| Parameter                                                                | Temp | Test Level | Min | Typ | Max | Unit |
|--------------------------------------------------------------------------|------|------------|-----|-----|-----|------|
| WRITE OPERATION (See Figure 46)                                          |      |            |     |     |     |      |
| SCLK Clock Rate ( $f_{\text{SCLK}}$ )                                    | Full | IV         |     |     | 32  | MHz  |
| SCLK Clock High ( $t_{\text{HI}}$ )                                      | Full | IV         | 14  |     |     | ns   |
| SCLK Clock Low ( $t_{\text{LOW}}$ )                                      | Full | IV         | 14  |     |     | ns   |
| SDIO to SCLK Setup Time ( $t_{\text{DS}}$ )                              | Full | IV         | 14  |     |     | ns   |
| SCLK to SDIO Hold Time ( $t_{\text{DH}}$ )                               | Full | IV         | 0   |     |     | ns   |
| $\overline{\text{SEN}}$ to SCLK Setup Time ( $t_{\text{S}}$ )            | Full | IV         | 14  |     |     | ns   |
| SCLK to $\overline{\text{SEN}}$ Hold Time ( $t_{\text{H}}$ )             | Full | IV         | 0   |     |     | ns   |
| READ OPERATION (See Figure 47 and Figure 48)                             |      |            |     |     |     |      |
| SCLK Clock Rate ( $f_{\text{SCLK}}$ )                                    | Full | IV         |     |     | 32  | MHz  |
| SCLK Clock High ( $t_{\text{HI}}$ )                                      | Full | IV         | 14  |     |     | ns   |
| SCLK Clock Low ( $t_{\text{LOW}}$ )                                      | Full | IV         | 14  |     |     | ns   |
| SDIO to SCLK Setup Time ( $t_{\text{DS}}$ )                              | Full | IV         | 14  |     |     | ns   |
| SCLK to SDIO Hold Time ( $t_{\text{DH}}$ )                               | Full | IV         | 0   |     |     | ns   |
| SCLK to SDIO (or SDO) Data Valid Time ( $t_{\text{DV}}$ )                | Full | IV         |     |     | 14  | ns   |
| $\overline{\text{SEN}}$ to SDIO Output Valid to Hi-Z ( $t_{\text{EZ}}$ ) | Full | IV         |     | 2   |     | ns   |

**HALF-DUPLEX DATA INTERFACE (ADIO PORT) TIMING SPECIFICATIONS**

AVDD = 3.3 V  $\pm$  5%, DVDD = CLKVDD = DRVDD = 3.3 V  $\pm$  10%, unless otherwise noted.

**Table 6.**

| Parameter                                            | Temp | Test Level | Min | Typ | Max | Unit |
|------------------------------------------------------|------|------------|-----|-----|-----|------|
| READ OPERATION <sup>1</sup> (See Figure 50)          |      |            |     |     |     |      |
| Output Data Rate                                     | Full | II         | 5   |     | 80  | MSPS |
| Three-State Output Enable Time ( $t_{\text{PZL}}$ )  | Full | II         |     |     | 3   | ns   |
| Three-State Output Disable Time ( $t_{\text{PLZ}}$ ) | Full | II         |     |     | 3   | ns   |
| Rx Data Valid Time ( $t_{\text{VT}}$ )               | Full | II         | 1.5 |     |     | ns   |
| Rx Data Output Delay ( $t_{\text{OD}}$ )             | Full | II         |     |     | 4   | ns   |
| WRITE OPERATION (See Figure 49)                      |      |            |     |     |     |      |
| Input Data Rate (1 $\times$ Interpolation)           | Full | II         | 20  |     | 80  | MSPS |
| Input Data Rate (2 $\times$ Interpolation)           | Full | II         | 10  |     | 80  | MSPS |
| Input Data Rate (4 $\times$ Interpolation)           | Full | II         | 5   |     | 50  | MSPS |
| Tx Data Setup Time ( $t_{\text{DS}}$ )               | Full | II         | 1   |     |     | ns   |
| Tx Data Hold Time ( $t_{\text{DH}}$ )                | Full | II         | 2.5 |     |     | ns   |
| Latch Enable Time ( $t_{\text{EN}}$ )                | Full | II         |     |     | 3   | ns   |
| Latch Disable Time ( $t_{\text{DIS}}$ )              | Full | II         |     |     | 3   | ns   |

<sup>1</sup>  $C_{\text{LOAD}} = 5$  pF for digital data outputs.

**FULL-DUPLEX DATA INTERFACE (Tx AND Rx PORT) TIMING SPECIFICATIONS**

AVDD = 3.3 V  $\pm$  5%, DVDD = CLKVDD = DRVDD = 3.3 V  $\pm$  10%, unless otherwise noted.

**Table 7.**

| Parameter                                      | Temp | Test Level | Min | Typ | Max | Unit |
|------------------------------------------------|------|------------|-----|-----|-----|------|
| Tx PATH INTERFACE (See Figure 53)              |      |            |     |     |     |      |
| Input Nibble Rate (2 $\times$ Interpolation)   | Full | II         | 20  |     | 160 | MSPS |
| Input Nibble Rate (4 $\times$ Interpolation)   | Full | II         | 10  |     | 100 | MSPS |
| Tx Data Setup Time ( $t_{DS}$ )                | Full | II         | 2.5 |     |     | ns   |
| Tx Data Hold Time ( $t_{DH}$ )                 | Full | II         | 1.5 |     |     | ns   |
| Rx PATH INTERFACE <sup>1</sup> (See Figure 54) |      |            |     |     |     |      |
| Output Nibble Rate                             | Full | II         | 10  |     | 160 | MSPS |
| Rx Data Valid Time ( $t_{DV}$ )                | Full | II         | 3   |     |     | ns   |
| Rx Data Hold Time ( $t_{DH}$ )                 | Full | II         | 0   |     |     | ns   |

<sup>1</sup>  $C_{LOAD}$  = 5 pF for digital data outputs.

## ABSOLUTE MAXIMUM RATINGS

Table 8.

| Parameter                             | Rating                  |
|---------------------------------------|-------------------------|
| <b>ELECTRICAL</b>                     |                         |
| AVDD, CLKVDD Voltage                  | 3.9 V maximum           |
| DVDD, DRVDD Voltage                   | 3.9 V maximum           |
| RX+, RX−, REFT, REFB                  | −0.3 V to AVDD + 0.3 V  |
| IOUTP+, IOUTP−                        | −1.5 V to AVDD + 0.3 V  |
| IOUTN+, IOUTN−, IOUTG+, IOUTG−        | −0.3 V to 7 V           |
| OSCIN, XTAL                           | −0.3 V to CLVDD + 0.3 V |
| REFIO, REFADJ                         | −0.3 V to AVDD + 0.3 V  |
| Digital Input and Output Voltage      | −0.3 V to DRVDD + 0.3 V |
| Digital Output Current                | 5 mA maximum            |
| <b>ENVIRONMENTAL</b>                  |                         |
| Operating Temperature Range (Ambient) | −40°C to +85°C          |
| Maximum Junction Temperature          | 125°C                   |
| Storage Temperature Range (Ambient)   | −65°C to +150°C         |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

### THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Careful attention to PCB thermal design is required.

The exposed pad (EPAD) must be soldered to the ground plane for the 64-lead LFCSP. The EPAD provides an electrical, thermal, and mechanical connection to the board.

Junction temperature ( $T_J$ ) can be estimated using the following equations:

$$T_J = T_T + (\Psi_{JT} \times P),$$

or

$$T_J = T_B + (\Psi_{JB} \times P)$$

where:

$T_T$  is the temperature measured at the top of the package.

$P$  is the total device power dissipation.

$T_B$  is the temperature measured at the board.

$\Psi_{JT}$  and  $\Psi_{JB}$  are thermal characteristic parameters obtained with  $\theta_{JA}$  in still air test conditions.

Table 9. Thermal Resistance

| Package              | $\theta_{JA}$ | $\theta_{JC}$ | Unit |
|----------------------|---------------|---------------|------|
| CP-64-3 <sup>1</sup> | 23.32         | 0.7           | °C/W |

<sup>1</sup> Test condition 1: typical  $\theta_{JA}$  and  $\theta_{JC}$  values are specified for a 4-layer, JESD51-7 high effective thermal conductivity test board for leaded surface-mount packages.  $\theta_{JA}$  is obtained in still air conditions (JESD51-2). Airflow increases heat dissipation, effectively reducing  $\theta_{JA}$ .  $\theta_{JC}$  is obtained with the test case temperature monitored at the bottom of the exposed pad.

### EXPLANATION OF TEST LEVELS

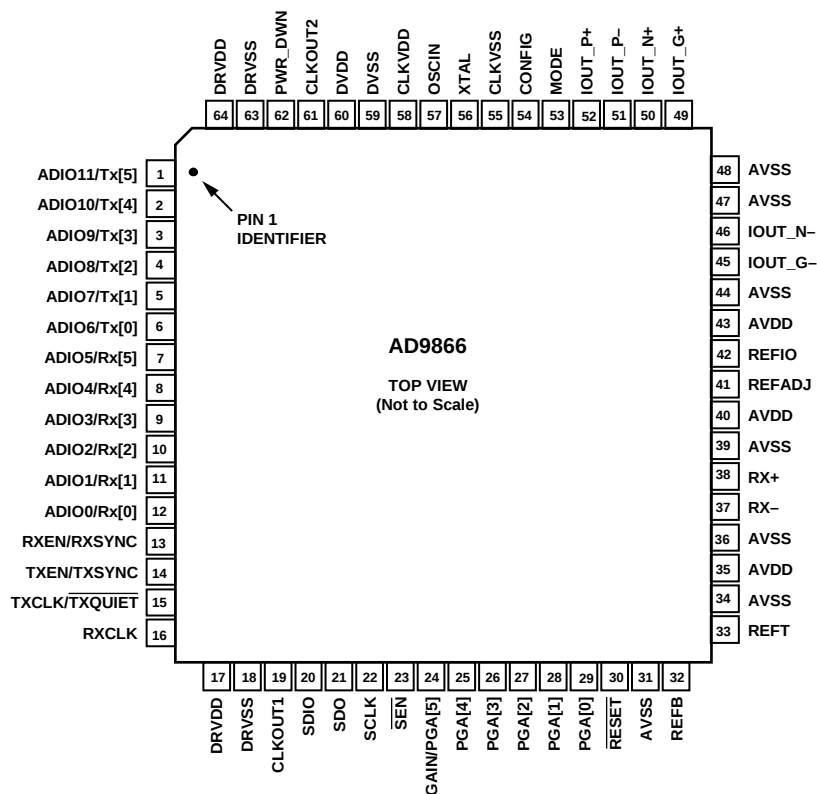
- I 100% production tested.
- II 100% production tested at 25°C and guaranteed by design and characterization at specified temperatures.
- III Sample tested only.
- IV Parameter is guaranteed by design and characterization testing.
- V Parameter is a typical value only.
- VI 100% production tested at 25°C and guaranteed by design and characterization for industrial temperature range.

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



## NOTES

1. THE EXPOSED PAD MUST BE SOLDERED TO GND.

Figure 2. Pin Configuration

04560-0-002

Table 10. Pin Function Descriptions

| Pin No. | Mnemonic    | Mode <sup>1</sup> | Description                     |
|---------|-------------|-------------------|---------------------------------|
| 1       | ADIO11      | HD                | MSB of ADIO Buffer              |
|         | Tx[5]       | FD                | MSB of Tx Nibble Input          |
| 2 to 5  | ADIO10 to 7 | HD                | Bits 10 to 7 of ADIO Buffer     |
|         | Tx[4 to 1]  | FD                | Bits 4 to 1 of Tx Nibble Input  |
| 6       | ADIO6       | HD                | Bit 6 of ADIO Buffer            |
|         | Tx[0]       | FD                | LSB of Tx Nibble Input          |
| 7       | ADIO5       | HD                | Bit 5 of ADIO Buffer            |
|         | Rx[5]       | FD                | MSB of Rx Nibble Output         |
| 8, 9    | ADIO4, 3    | HD                | Bits 4 to 3 of ADIO Buffer      |
|         | Rx[4, 3]    | FD                | Bits 4 to 3 of Rx Nibble Output |
| 10      | ADIO2       | HD                | Bit 2 of ADIO Buffer            |
|         | Rx[2]       | FD                | Bit 2 of Rx Nibble Output       |
| 11      | ADIO1       | HD                | Bit 1 of ADIO Buffer            |
|         | Rx[1]       | FD                | Bit 1 of Rx Nibble Output       |
| 12      | ADIO0       | HD                | LSB of ADIO Buffer              |
|         | Rx[0]       | FD                | LSB of Rx Nibble Output         |
| 13      | RXEN        | HD                | ADIO Buffer Control Input       |
|         | RXSYNC      | FD                | Rx Data Synchronization Output  |
| 14      | TXEN        | HD                | Tx Path Enable Input            |
|         | TXSYNC      | FD                | Tx Data Synchronization Input   |

| Pin No.                    | Mnemonic                    | Mode <sup>1</sup> | Description                                                      |
|----------------------------|-----------------------------|-------------------|------------------------------------------------------------------|
| 15                         | TXCLK                       | HD                | ADIO Sample Clock Input                                          |
|                            | $\overline{\text{TXQUIET}}$ | FD                | Fast TxDAC/IAMP Power-Down                                       |
| 16                         | RXCLK                       | HD                | ADIO Request Clock Input                                         |
|                            |                             | FD                | Rx and Tx Clock Output at $2 \times f_{\text{ADC}}$              |
| 17, 64                     | DRVDD                       |                   | Digital Output Driver Supply Input                               |
| 18, 63                     | DRVSS                       |                   | Digital Output Driver Supply Return                              |
| 19                         | CLKOUT1                     |                   | $f_{\text{DAC}}/N$ Clock Output ( $L = 1, 2, 4, \text{ or } 8$ ) |
| 20                         | SDIO                        |                   | Serial Port Data Input/Output                                    |
| 21                         | SDO                         |                   | Serial Port Data Output                                          |
| 22                         | SCLK                        |                   | Serial Port Clock Input                                          |
| 23                         | $\overline{\text{SEN}}$     |                   | Serial Port Enable Input                                         |
| 24                         | GAIN                        | FD                | Tx Data Port (Tx[5:0]) Mode Select                               |
|                            | PGA[5]                      | HD or FD          | MSB of PGA Input Data Port                                       |
| 25 to 29                   | PGA[4 to 0]                 | HD or FD          | Bits 4 to 0 of PGA Input Data Port                               |
| 30                         | $\overline{\text{RESET}}$   |                   | Reset Input (Active Low)                                         |
| 31, 34, 36, 39, 44, 47, 48 | AVSS                        |                   | Analog Ground                                                    |
| 32, 33                     | REFB, REFT                  |                   | ADC Reference Decoupling Nodes                                   |
| 35, 40, 43                 | AVDD                        |                   | Analog Power Supply Input                                        |
| 37, 38                     | RX−, RX+                    |                   | Receive Path − and + Analog Inputs                               |
| 41                         | REFADJ                      |                   | TxDAC Full-Scale Current Adjust                                  |
| 42                         | REFIO                       |                   | TxDAC Reference Input/Output                                     |
| 45                         | IOUT_G−                     |                   | −Tx Amp Current Output_Sink                                      |
| 46                         | IOUT_N−                     |                   | −Tx Mirror Current Output_Sink                                   |
| 49                         | IOUT_G+                     |                   | +Tx Amp Current Output_Sink                                      |
| 50                         | IOUT_N+                     |                   | +Tx Mirror Current Output_Sink                                   |
| 51                         | IOUT_P−                     |                   | −TxDAC Current Output_Source                                     |
| 52                         | IOUT_P+                     |                   | +TxDAC Current Output_Source                                     |
| 53                         | MODE                        |                   | Digital Interface Mode Select Input<br>LOW = HD, HIGH = FD       |
| 54                         | CONFIG                      |                   | Power-Up SPI Register Default Setting Input                      |
| 55                         | CLKVSS                      |                   | Clock Oscillator/Synthesizer Supply Return                       |
| 56                         | XTAL                        |                   | Crystal Oscillator Inverter Output                               |
| 57                         | OSCIN                       |                   | Crystal Oscillator Inverter Input                                |
| 58                         | CLKVDD                      |                   | Clock Oscillator/Synthesizer Supply                              |
| 59                         | DVSS                        |                   | Digital Supply Return                                            |
| 60                         | DVDD                        |                   | Digital Supply Input                                             |
| 61                         | CLKOUT2                     |                   | $f_{\text{OSCIN}}/L$ Clock Output, ( $L = 1, 2, \text{ or } 4$ ) |
| 62                         | PWR_DWN                     |                   | Power-Down Input                                                 |
|                            | EPAD                        |                   | The exposed pad must be soldered to GND.                         |

<sup>1</sup> HD = half-duplex mode; FD = full-duplex mode.

## TYPICAL PERFORMANCE CHARACTERISTICS

### Rx PATH TYPICAL PERFORMANCE CHARACTERISTICS

AVDD = CLKVDD = DVDD = DRVDD = 3.3 V,  $f_{\text{OSCIN}} = f_{\text{ADC}} = 50$  MSPS, low-pass filter's  $f_{-3\text{dB}} = 22$  MHz,  $A_{\text{IN}} = -1$  dBFS,  $R_{\text{IN}} = 50 \Omega$ , half- or full-duplex interface, default power bias settings.

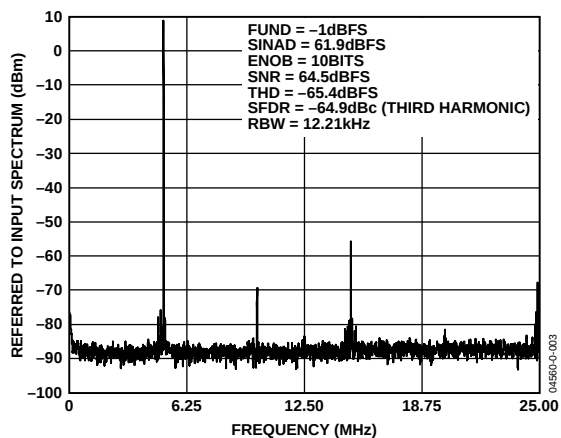


Figure 3. Spectral Plot with 4k FFT of Input Sinusoid with  $R_{\text{xPGA}} = 0$  dB and  $P_{\text{IN}} = 9$  dBm

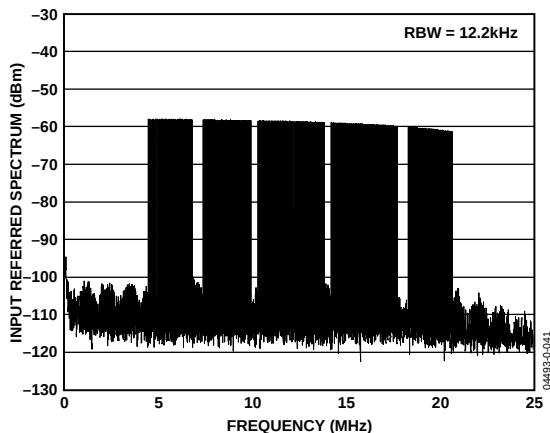


Figure 4. Spectral Plot with 4k FFT of 84-Carrier DMT Signal with  $\text{PAR} = 10.2$  dB,  $P_{\text{IN}} = -33.7$  dBm, and  $R_{\text{xPGA}} = 36$  dB

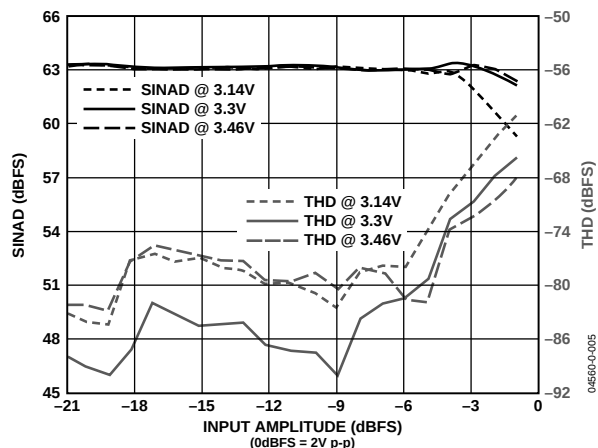


Figure 5. SINAD and THD vs. Input Amplitude and Supply ( $f_{\text{IN}} = 8$  MHz, LPF  $f_{-3\text{dB}} = 26$  MHz;  $R_{\text{xPGA}} = 0$  dB)

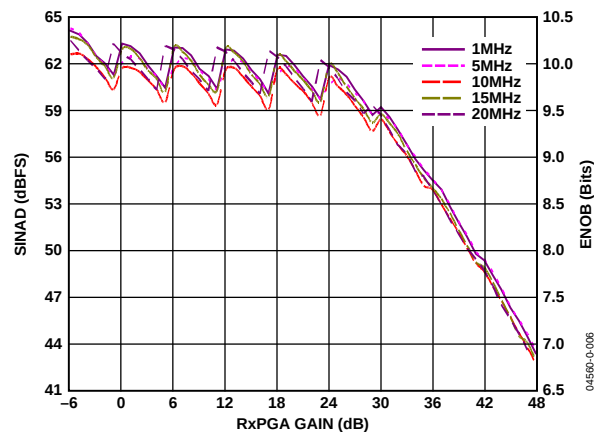


Figure 6. SINAD/ENOB vs.  $R_{\text{xPGA}}$  Gain and Frequency

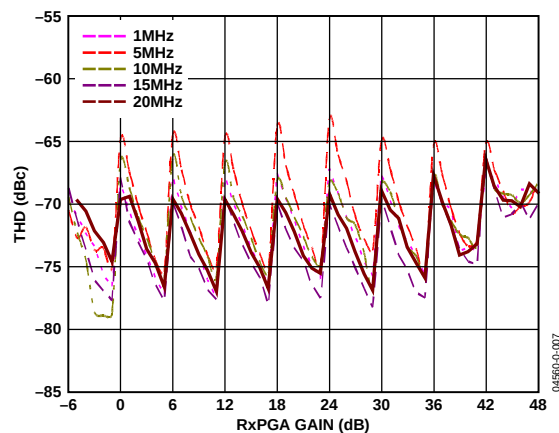


Figure 7. THD vs.  $R_{\text{xPGA}}$  Gain and Frequency

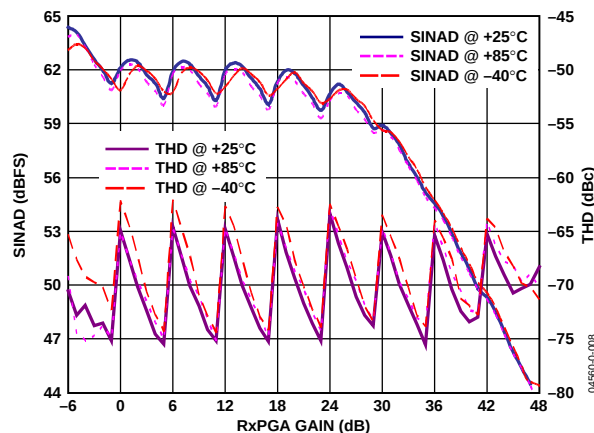


Figure 8. SINAD/THD Performance vs.  $R_{\text{xPGA}}$  Gain and Temperature ( $f_{\text{IN}} = 5$  MHz)

## Rx PATH TYPICAL PERFORMANCE CHARACTERISTICS

AVDD = CLKVDD = DVDD = DRVDD = 3.3 V,  $f_{\text{OSCIN}} = f_{\text{ADC}} = 80$  MSPS, low-pass filter's  $f_{-3\text{dB}} = 30$  MHz,  $A_{\text{IN}} = -1$  dBFS,  $R_{\text{IN}} = 50\ \Omega$ , half- or full-duplex interface, default power bias settings.

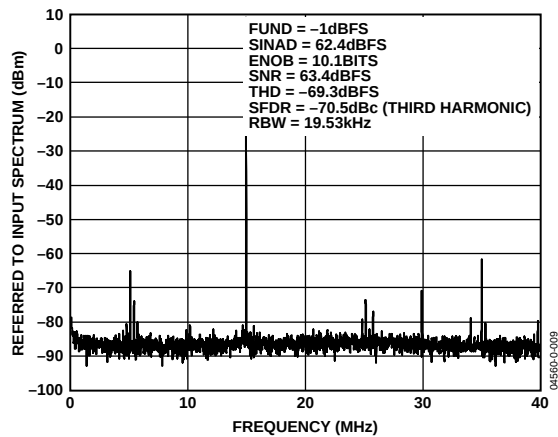


Figure 9. Spectral Plot with 4k FFT of Input Sinusoid with  $R_{\text{xPGA}} = 0$  dB and  $P_{\text{IN}} = 9$  dBm

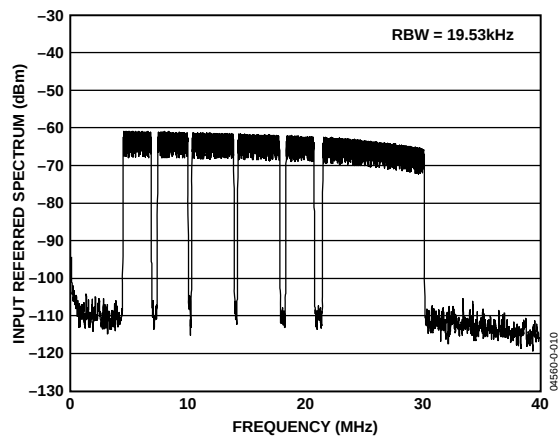


Figure 10. Spectral Plot with 4K FFT of 111-Carrier DMT Signal with  $\text{PAR} = 11$  dB,  $P_{\text{IN}} = -33.7$  dBm, LPF's  $f_{-3\text{dB}} = 32$  MHz and  $R_{\text{xPGA}} = 36$  dB

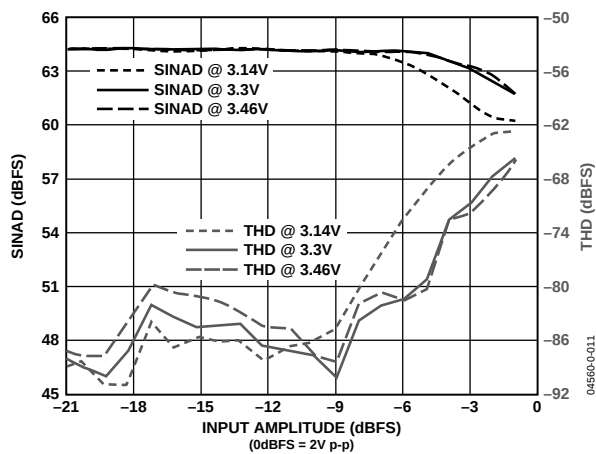


Figure 11. SINAD and THD vs. Input Amplitude and Supply ( $f_{\text{IN}} = 8$  MHz, LPF  $f_{-3\text{dB}} = 26$  MHz;  $R_{\text{xPGA}} = 0$  dB)

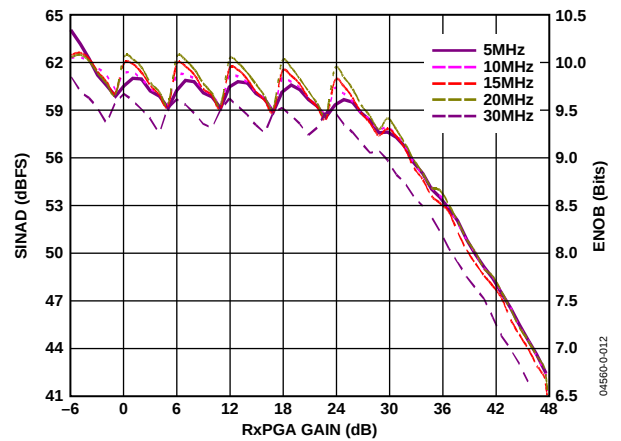


Figure 12. SINAD/ENOB vs.  $R_{\text{xPGA}}$  Gain and Frequency

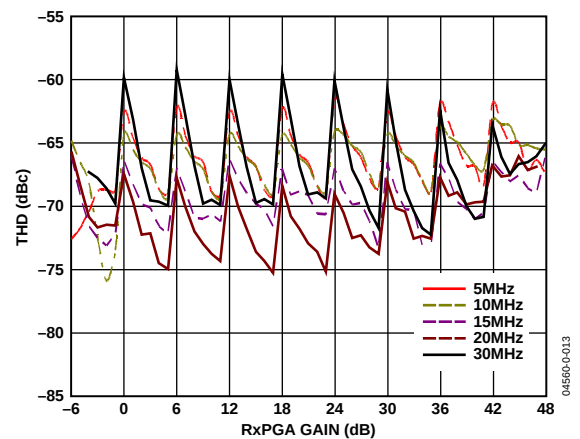


Figure 13. THD vs.  $R_{\text{xPGA}}$  Gain and Frequency

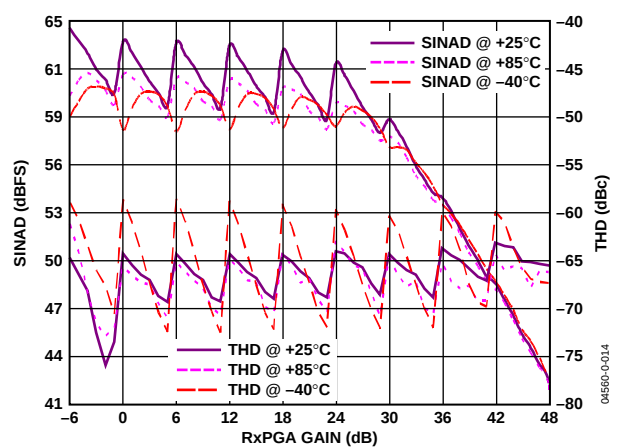


Figure 14. SINAD/THD Performance vs.  $R_{\text{xPGA}}$  Gain and Temperature ( $f_{\text{IN}} = 10$  MHz)

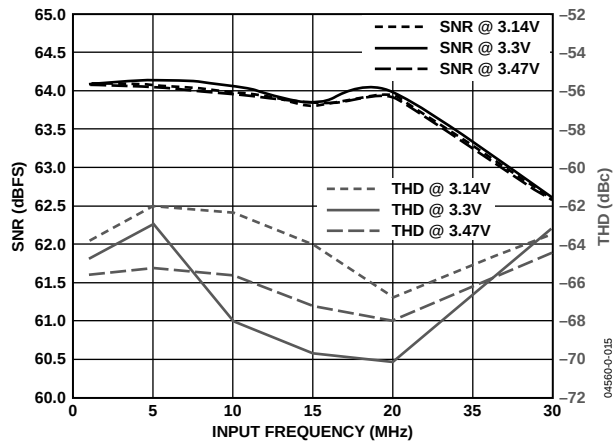


Figure 15. SNR and THD vs. Input Frequency and Supply  
(LPF  $f_{-3dB}$  = 26 MHz; RxPGA = 0 dB)

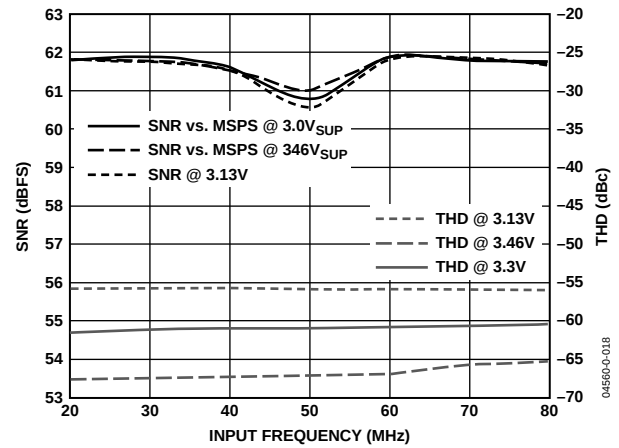


Figure 18. SNR and THD vs. Sample Rate and Supply  
(LPF Disabled; RxPGA = 0 dB;  $f_{IN}$  = 8 MHz)

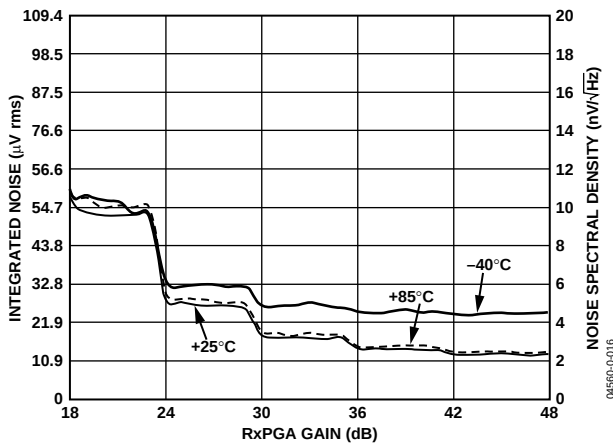


Figure 16. Input Referred Integrated Noise and Noise Spectral Density  
vs. RxPGA Gain (LPF  $f_{-3dB}$  = 26 MHz)

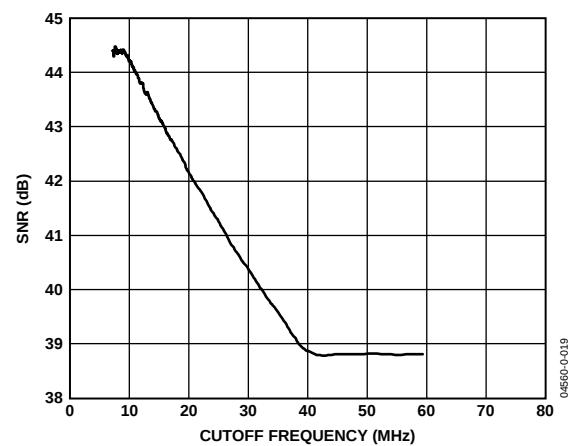


Figure 19. SNR vs. Filter Cutoff Frequency  
(50 MSPS;  $f_{IN}$  = 5 MHz;  $A_{IN}$  = -1 dB; RxPGA = 48 dB)

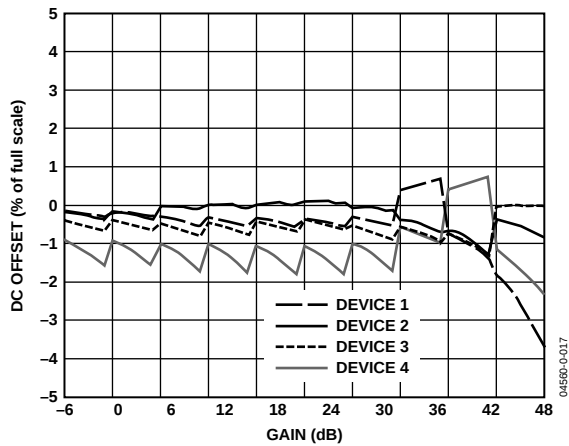


Figure 17. Rx DC Offset vs. RxPGA Gain

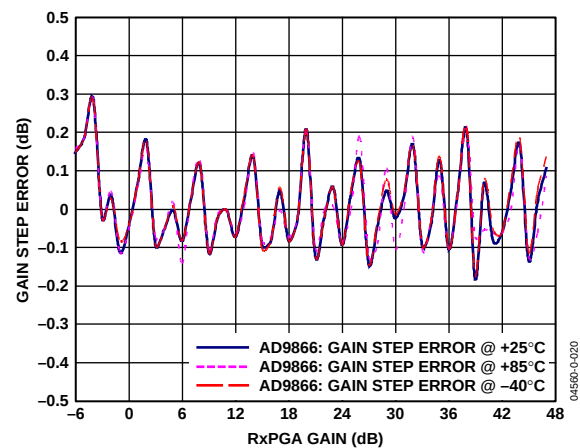


Figure 20. RxPGA Gain Step Error vs. Gain ( $f_{IN}$  = 10 MHz)

## Rx PATH TYPICAL PERFORMANCE CHARACTERISTICS

AVDD = CLKVDD = DVDD = DRVDD = 3.3 V,  $f_{\text{OSCIN}} = f_{\text{ADC}} = 50$  MSPS, low-pass filter disabled, RxPGA = 0 dB, AIN = -1 dBFS, RIN = 50  $\Omega$ , half- or full-duplex interface, default power bias settings.

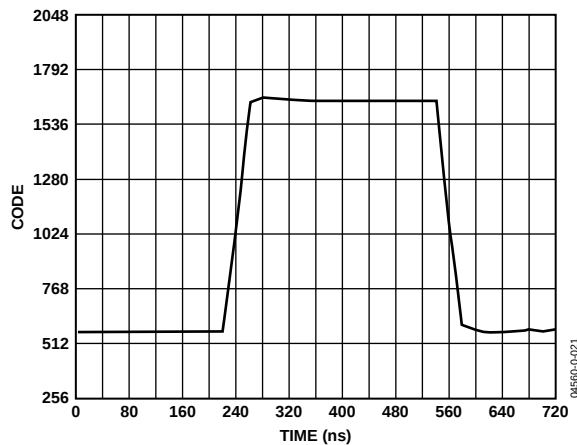


Figure 21. RxPGA Settling Time -12 dB to +48 dB Transition for DC Input ( $f_{\text{ADC}} = 50$  MSPS, LPF Disabled)

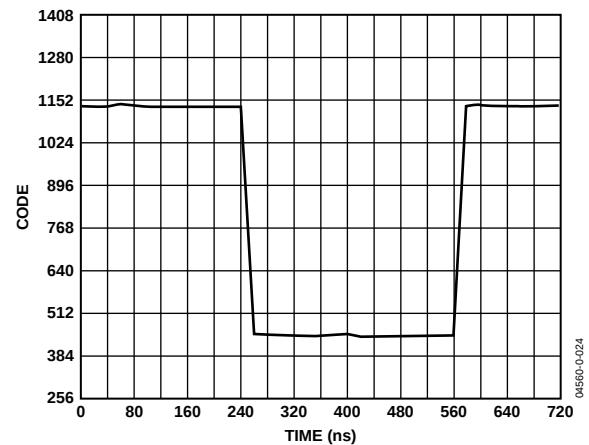


Figure 24. RxPGA Settling Time for 0 dB to +5 dB Transition for DC Input ( $f_{\text{ADC}} = 50$  MSPS, LPF Disabled)

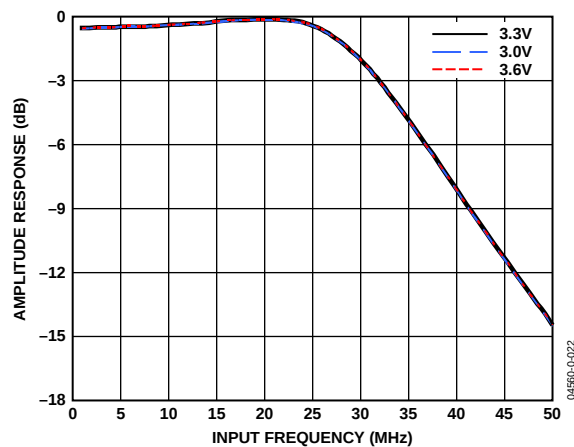


Figure 22. Rx Low-Pass Filter Amplitude Response vs. Supply ( $f_{\text{ADC}} = 50$  MSPS,  $f_{-3\text{ dB}} = 33$  MHz, RxPGA = 0 dB)

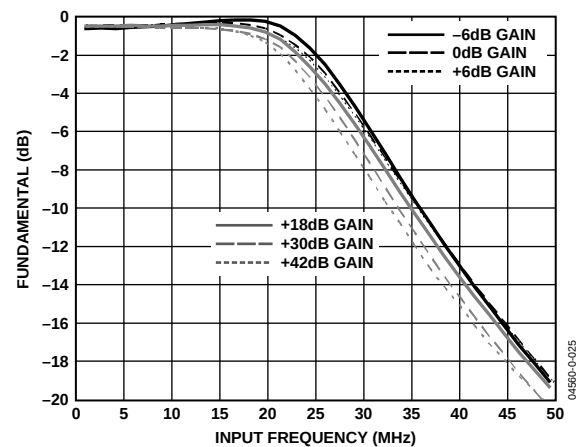


Figure 25. Rx Low-Pass Filter Amplitude Response vs. RxPGA Gain (LPF's  $f_{-3\text{ dB}} = 33$  MHz)

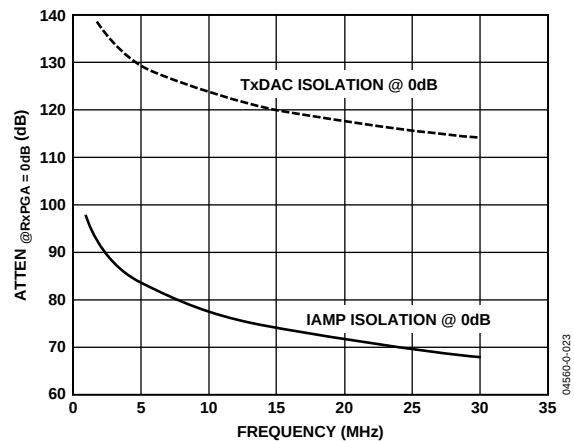


Figure 23. Rx to Tx Full-Duplex Isolation @ 0 RxPGA Setting (Note:  $\text{ATTEN}_{\text{@RxPGA} = x\text{ dB}} = \text{ATTEN}_{\text{@RxPGA} = 0\text{ dB}} - \text{RxPGA Gain}$ )

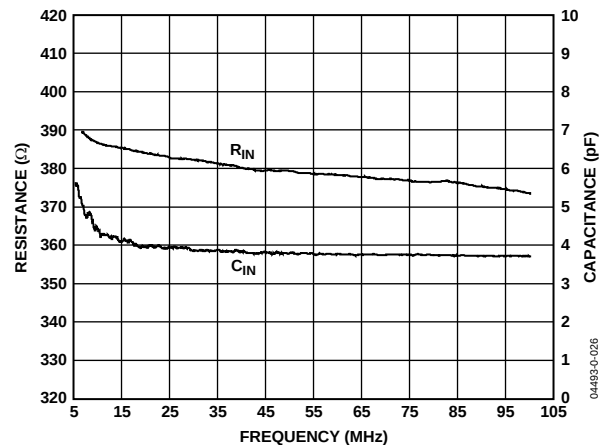


Figure 26. Rx Input Impedance vs. Frequency

## TxDAC PATH TYPICAL PERFORMANCE CHARACTERISTICS

AVDD = CLKVDD = DVDD = DRVDD = 3.3 V,  $f_{\text{OSCIN}}$  = 50 MSPS and 80 MSPS, RSET = 1.96 k $\Omega$ , 2:1 transformer coupled output (see Figure 63) into 50  $\Omega$  load half-or full-duplex interface, default power bias settings.

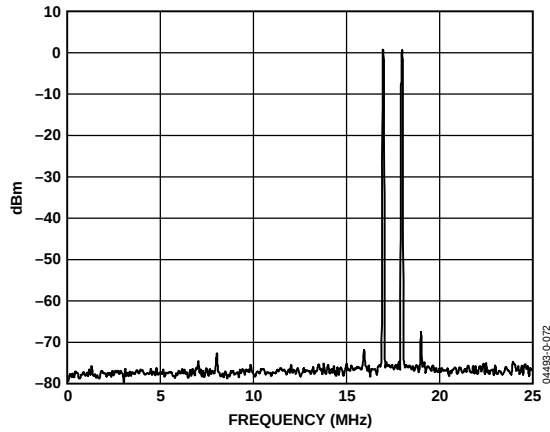


Figure 27. Dual-Tone Spectral Plot of TxDAC's Output  
( $f_{\text{DATA}}$  = 50 MSPS, 4 $\times$  Interpolation, 10 dBm Peak Power,  
 $F_1$  = 17 MHz,  $F_2$  = 18 MHz)

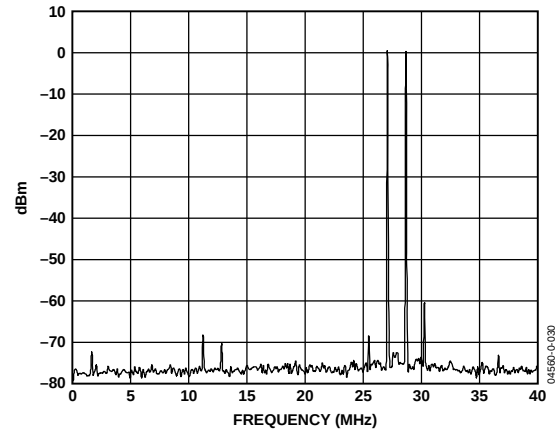


Figure 30. Dual-Tone Spectral Plot of TxDAC's Output  
( $f_{\text{DATA}}$  = 80 MSPS, 2 $\times$  Interpolation, 10 dBm Peak Power,  
 $F_1$  = 27.1 MHz,  $F_2$  = 28.7 MHz)

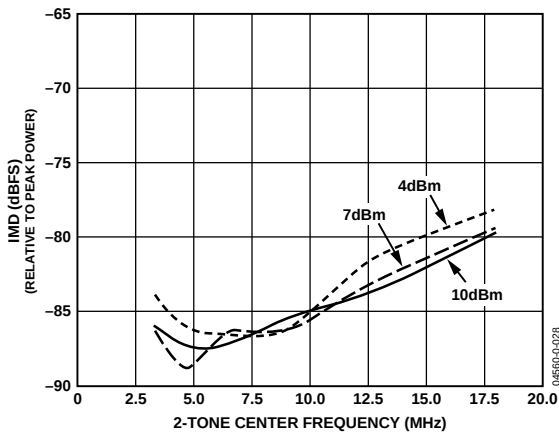


Figure 28. 2-Tone IMD Frequency Sweep vs. Peak Power  
with  $f_{\text{DATA}}$  = 50 MSPS, 4 $\times$  Interpolation

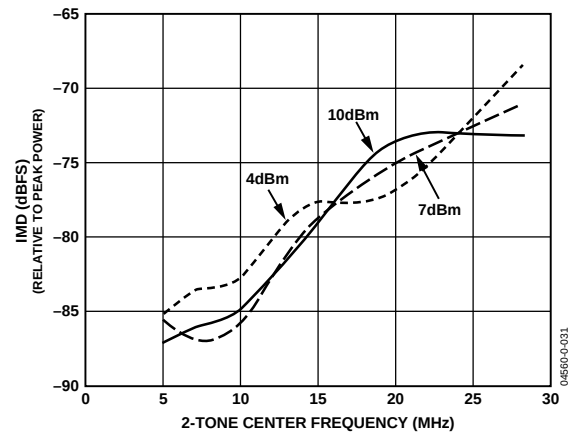


Figure 31. 2-Tone IMD Frequency Sweep vs. Peak Power  
with  $f_{\text{DATA}}$  = 80 MSPS, 2 $\times$  Interpolation

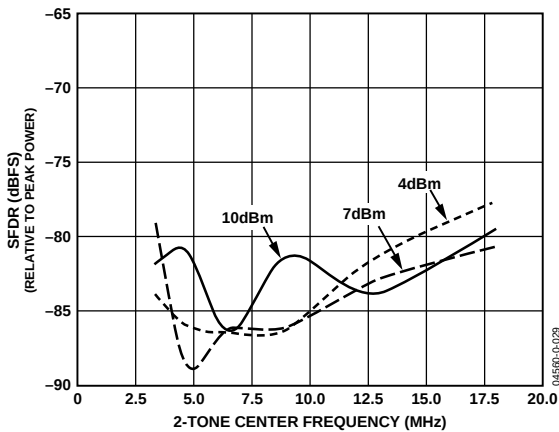


Figure 29. 2-Tone Worst Spur Frequency Sweep vs. Peak Power  
with  $f_{\text{DATA}}$  = 50 MSPS, 4 $\times$  Interpolation

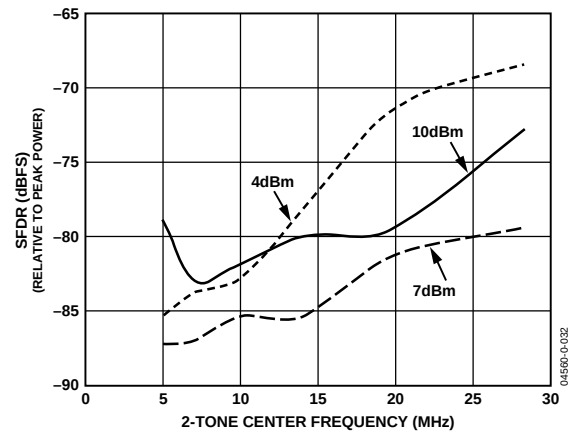


Figure 32. 2-Tone Worst Spur Frequency Sweep vs. Peak Power  
with  $f_{\text{DATA}}$  = 80 MSPS, 2 $\times$  Interpolation

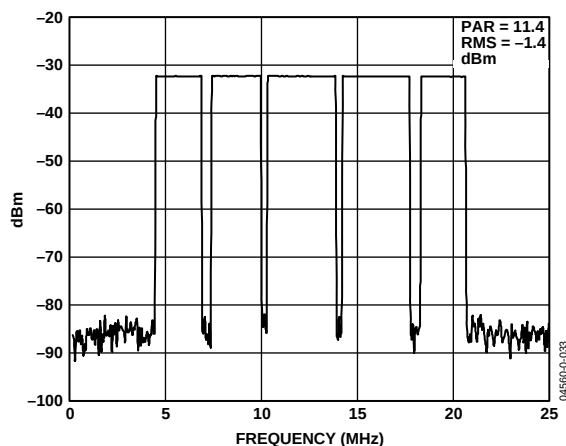


Figure 33. Spectral Plot of 84-Carrier OFDM Test Vector  
( $f_{DATA} = 50$  MSPS, 4× Interpolation)

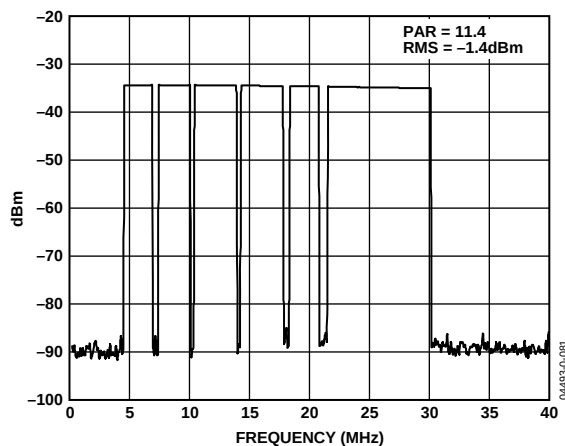


Figure 36. Spectral Plot of 111-Carrier OFDM Test Vector  
( $f_{DATA} = 80$  MSPS, 2× Interpolation)

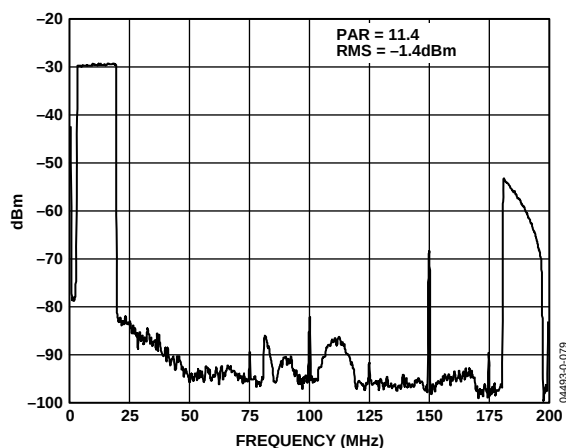


Figure 34. Wideband Spectral Plot of 88-Subcarrier OFDM Test Vector  
( $f_{DATA} = 50$  MSPS, 4× Interpolation)

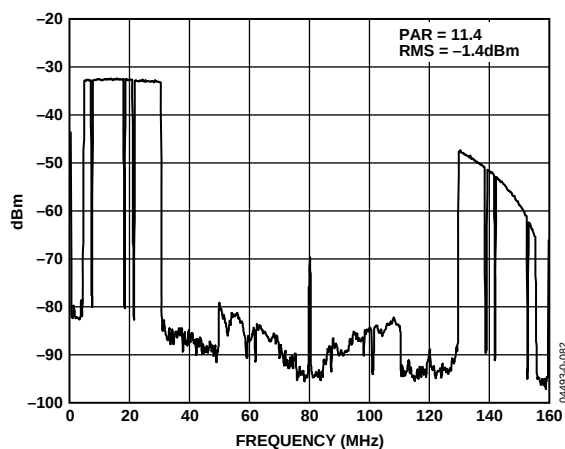


Figure 37. Wideband Spectral Plot of 111-Carrier OFDM Test Vector  
( $f_{DATA} = 80$  MSPS, 2× Interpolation)

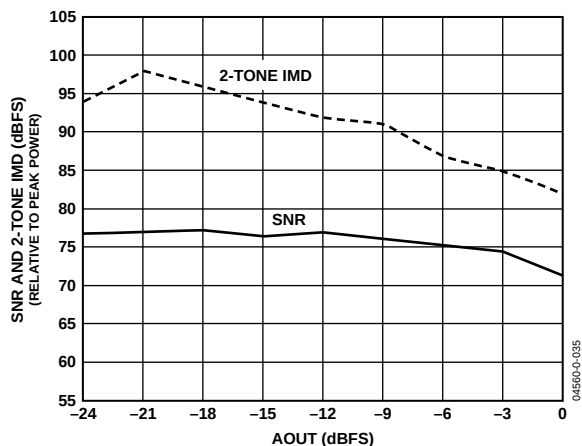


Figure 35. SNR and SFDR vs.  $P_{OUT}$   
( $f_{OUT} = 12.55$  MHz,  $f_{DATA} = 50$  MSPS, 4× Interpolation)

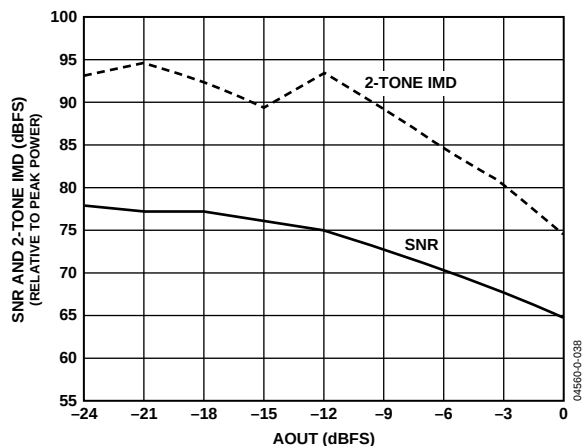


Figure 38. SNR and SFDR vs.  $P_{OUT}$   
( $f_{OUT} = 20$  MHz,  $f_{DATA} = 80$  MSPS, 2× Interpolation)

## IAMP PATH TYPICAL PERFORMANCE CHARACTERISTICS

AVDD = CLKVDD = DVDD = DRVDD = 3.3 V,  $f_{OSCIN} = 50$  MSPS,  $R_{SET} = 1.58$  k $\Omega$ , 1:1 transformer coupled output (see Figure 64 and Figure 65) into 50  $\Omega$  load, half- or full-duplex interface, default power bias settings.

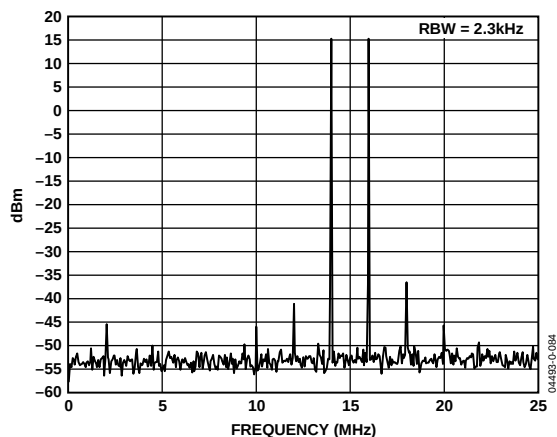


Figure 39. Dual-Tone Spectral Plot of IAMPN Output (IAMP Settings of  $I = 12.5$  mA,  $N = 4$ ,  $G = 0$ , 2:1 Transformer into 75  $\Omega$  Loader, VCM = 4.8 V)

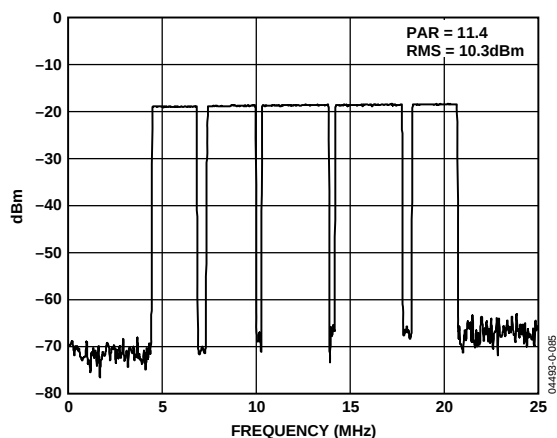


Figure 40. Spectral Plot of 84-Carrier OFDM Test Vector Using IAMPN in Current-Mode Configuration (IAMP Settings of  $I = 10$  mA,  $N = 4$ ,  $G = 0$ ; VCM = 4.8 V)

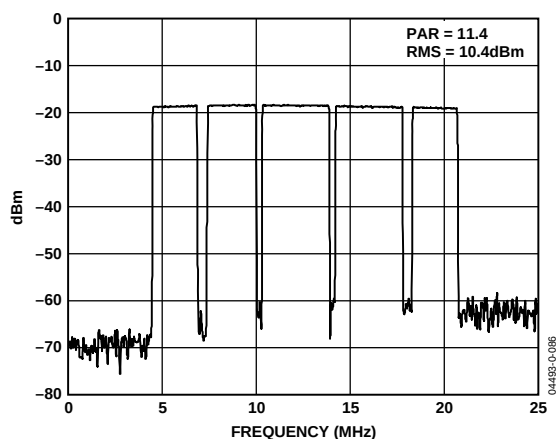


Figure 41. Spectral Plot of 84-Carrier OFDM Test Vector Using IAMP in Voltage-Mode Configuration with AVDD = 5 V (PBR951 Transistors, IAMP Settings of  $I = 6$  mA,  $N = 2$ ,  $G = 6$ )

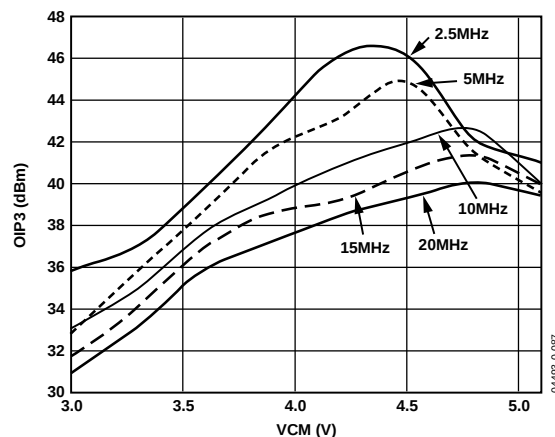


Figure 42. IOUTN Third-Order Intercept vs. Common-Mode Voltage (IAMP Settings of  $I = 12.5$  mA,  $N = 4$ ,  $G = 0$ , 2:1 Transformer into 75  $\Omega$  Load)

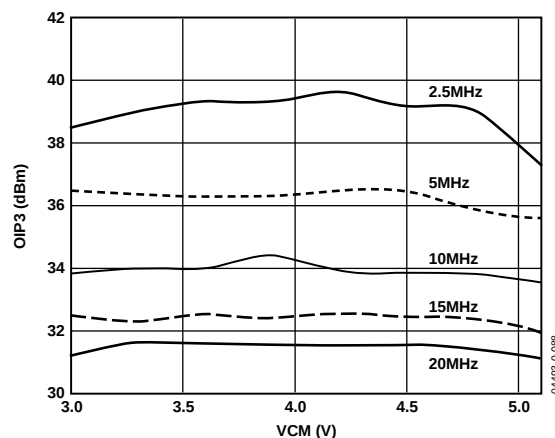


Figure 43. IOUTG Third-Order Intercept vs. Common-Mode Voltage (IAMP Settings of  $I = 4.25$  mA,  $N = 0$ ,  $G = 6$ , 2:1 Transformer into 75  $\Omega$  Load)

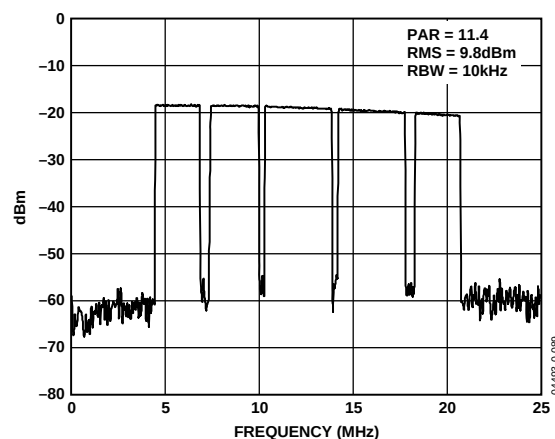


Figure 44. Spectral Plot of 84-Carrier OFDM Test Vector Using IAMP in Voltage-Mode Configuration with AVDD = 3.3 V (PBR951 Transistors, IAMP Settings of  $I = 6$  mA,  $N = 2$ ,  $G = 6$ )

## SERIAL PORT

Table 11. SPI Register Mapping

| Address<br>(Hex) <sup>1</sup>             | Bit<br>Break-<br>down | Description               | Width | Power-Up Default Value |            |                        |            | Comments                                                                                                                                                                               |
|-------------------------------------------|-----------------------|---------------------------|-------|------------------------|------------|------------------------|------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                           |                       |                           |       | MODE = 0 (Half-Duplex) |            | MODE = 1 (Full-Duplex) |            |                                                                                                                                                                                        |
|                                           |                       |                           |       | CONFIG = 0             | CONFIG = 1 | CONFIG = 0             | CONFIG = 1 |                                                                                                                                                                                        |
| SPI PORT CONFIGURATION AND SOFTWARE RESET |                       |                           |       |                        |            |                        |            |                                                                                                                                                                                        |
| 0x00                                      | (7)                   | 4-Wire SPI                | 1     | 0                      | 0          | 0                      | 0          | Default SPI configuration is 3-wire, MSB first.                                                                                                                                        |
|                                           | (6)                   | LSB First                 | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (5)                   | S/W Reset                 | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
| POWER CONTROL REGISTERS (VIA PWR_DWN PIN) |                       |                           |       |                        |            |                        |            |                                                                                                                                                                                        |
| 0x01                                      | (7)                   | Clock Syn.                | 1     | 0                      | 0          | 0                      | 0          | PWR_DWN = 0.<br>Default setting is for all blocks powered on.                                                                                                                          |
|                                           | (6)                   | TxDAC/IAMP                | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (5)                   | Tx Digital                | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (4)                   | REF                       | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (3)                   | ADC CML                   | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (2)                   | ADC                       | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (1)                   | PGA Bias                  | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (0)                   | RxPGA                     | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
| 0x02                                      | (7)                   | CLK Syn.                  | 1     | 0                      | 0          | 0                      | 1*         | PWR_DWN = 1.<br>Default setting* is for all functional blocks powered down except PLL.<br>*MODE = CONFIG = 1.<br>Setting has PLL powered down with OSCIN input routed to RXCLK output. |
|                                           | (6)                   | TxDAC/IAMP                | 1     | 1                      | 1          | 1                      | 1          |                                                                                                                                                                                        |
|                                           | (5)                   | Tx Digital                | 1     | 1                      | 1          | 1                      | 1          |                                                                                                                                                                                        |
|                                           | (4)                   | REF                       | 1     | 1                      | 1          | 1                      | 1          |                                                                                                                                                                                        |
|                                           | (3)                   | ADC CML                   | 1     | 1                      | 1          | 1                      | 1          |                                                                                                                                                                                        |
|                                           | (2)                   | ADC                       | 1     | 1                      | 1          | 1                      | 1          |                                                                                                                                                                                        |
|                                           | (1)                   | PGA Bias                  | 1     | 1                      | 1          | 1                      | 1          |                                                                                                                                                                                        |
|                                           | (0)                   | RxPGA                     | 1     | 1                      | 1          | 1                      | 1          |                                                                                                                                                                                        |
| HALF-DUPLEX POWER CONTROL                 |                       |                           |       |                        |            |                        |            |                                                                                                                                                                                        |
| 0x03                                      | (7:3)                 | Tx OFF Delay              | 5     | 0xFF                   | 0xFF       | N/A                    | N/A        | Default setting is for TXEN input to control power on/off of Tx/Rx path.<br>Tx driver delayed by 31 1/f <sub>DATA</sub> clock cycles.                                                  |
|                                           | (2)                   | Rx _TXEN                  | 1     |                        |            |                        |            |                                                                                                                                                                                        |
|                                           | (1)                   | Tx PWRDN                  | 1     |                        |            |                        |            |                                                                                                                                                                                        |
|                                           | (0)                   | Rx PWRDN                  | 1     |                        |            |                        |            |                                                                                                                                                                                        |
| PLL CLOCK MULTIPLIER/SYNTHESIZER CONTROL  |                       |                           |       |                        |            |                        |            |                                                                                                                                                                                        |
| 0x04                                      | (5)                   | Duty Cycle Enable         | 1     | 0                      | 0          | 0                      | 0          | Default setting is Duty Cycle Restore disabled, ADC CLK from OSCIN input, and PLL multiplier × 2 setting.<br>*PLL multiplier × 4 setting.                                              |
|                                           | (4)                   | f <sub>ADC</sub> from PLL | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (3:2)                 | PLL Divide-N              | 2     | 00                     | 00         | 00                     | 00         |                                                                                                                                                                                        |
|                                           | (1:0)                 | PLL Multiplier-M          | 2     | 01                     | 10*        | 01                     | 01         |                                                                                                                                                                                        |
| 0x05                                      | (2)                   | OSCIN to RXCLK            | 1     | 0                      | 0          | 0                      | 1*         | Full-duplex RXCLK normally at nibble rate.<br>*Exception on power-up.                                                                                                                  |
|                                           | (1)                   | Invert RXCLK              | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (0)                   | Disabled RXCLK            | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
| 0x06                                      | (7:6)                 | CLKOUT2 Divide            | 2     | 01                     | 01         | 01                     | 01         | Default setting is CLKOUT2 and CLKOUT1 enabled with divide-by-2.<br>*CLKOUT1 and CLKOUT2 disabled.                                                                                     |
|                                           | (5)                   | CLKOUT2 Invert            | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (4)                   | CLKOUT2 Disable           | 1     | 0                      | 0          | 0                      | 1*         |                                                                                                                                                                                        |
|                                           | (3:2)                 | CLKOUT1 Divide            | 2     | 01                     | 01         | 01                     | 01         |                                                                                                                                                                                        |
|                                           | (1)                   | CLKOUT1 Invert            | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                        |
|                                           | (0)                   | CLKOUT1 Disable           | 1     | 0                      | 0          | 0                      | 1*         |                                                                                                                                                                                        |

| Address<br>(Hex) <sup>1</sup>                           | Bit<br>Break-<br>down | Description                       | Width | Power-Up Default Value |            |                        |            | Comments                                                                                                                                                                                                               |
|---------------------------------------------------------|-----------------------|-----------------------------------|-------|------------------------|------------|------------------------|------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                         |                       |                                   |       | MODE = 0 (Half-Duplex) |            | MODE = 1 (Full-Duplex) |            |                                                                                                                                                                                                                        |
|                                                         |                       |                                   |       | CONFIG = 0             | CONFIG = 1 | CONFIG = 0             | CONFIG = 1 |                                                                                                                                                                                                                        |
| Rx PATH CONTROL                                         |                       |                                   |       |                        |            |                        |            |                                                                                                                                                                                                                        |
| 0x07                                                    | (5)                   | Initiate Offset Cal.              | 1     | 0                      | 0          | 0                      | 0          | Default setting has LPF ON and Rx path at nominal power bias setting.<br>*Rx path to low power.                                                                                                                        |
|                                                         | (4)                   | Rx Low Power                      | 1     | 0                      | 1*         | 0                      | 1*         |                                                                                                                                                                                                                        |
|                                                         | (0)                   | Rx Filter ON                      | 1     | 1                      | 1          | 1                      | 1          |                                                                                                                                                                                                                        |
| 0x08                                                    | (7:0)                 | Rx Filter Tuning Cutoff Frequency | 8     | 0x80                   | 0x61       | 0x80                   | 0x80       | Refer to Low-Pass Filter section.                                                                                                                                                                                      |
| Tx/Rx PATH GAIN CONTROL                                 |                       |                                   |       |                        |            |                        |            |                                                                                                                                                                                                                        |
| 0x09                                                    | (6)                   | Use SPI Rx Gain                   | 1     | 0x00                   | 0x00       | 0x00                   | 0x00       | Default setting is for hardware Rx gain code via PGA or Tx data port.                                                                                                                                                  |
|                                                         | (5:0)                 | Rx Gain Code                      | 6     |                        |            |                        |            |                                                                                                                                                                                                                        |
| 0x0A                                                    | (6)                   | Use SPI Tx Gain                   | 1     | 0x7F                   | 0x7F       | 0x7F                   | 0x7F       | Default setting is for Tx gain code via SPI control.                                                                                                                                                                   |
|                                                         | (5:0)                 | Tx Gain Code                      | 6     |                        |            |                        |            |                                                                                                                                                                                                                        |
| Tx AND Rx PGA CONTROL                                   |                       |                                   |       |                        |            |                        |            |                                                                                                                                                                                                                        |
| 0x0B                                                    | (6)                   | PGA Code for Tx                   | 1     | 0                      | 0          | 0                      | 0          | Default setting is RxPGA control active.<br>*Tx port with GAIN strobe (AD9875/AD9876 compatible).<br>**3-bit RxPGA gain map (AD9975 compatible).                                                                       |
|                                                         | (5)                   | PGA Code for Rx                   | 1     | 1                      | 1          | 1                      | 1          |                                                                                                                                                                                                                        |
|                                                         | (3)                   | Force GAIN strobe                 | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                                                        |
|                                                         | (2)                   | Rx Gain on Tx Port                | 1     | 0                      | 0          | 1*                     | 1*         |                                                                                                                                                                                                                        |
|                                                         | (1)                   | 3-Bit RxPGA Port                  | 1     | 0                      | 1**        | 0                      | 0          |                                                                                                                                                                                                                        |
| Tx DIGITAL FILTER AND INTERFACE                         |                       |                                   |       |                        |            |                        |            |                                                                                                                                                                                                                        |
| 0x0C                                                    | (7:6)                 | Interpolation Factor              | 2     | 01                     | 00         | 01                     | 01         | Default setting is 2x interpolation with LPF response. Data format is straight binary for half-duplex and twos complement for full-duplex interface.<br>*Full-duplex only.                                             |
|                                                         | (4)                   | Invert TXEN/TXSYNC                | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                                                        |
|                                                         | (2)                   | LS Nibble First*                  | 1     | N/A                    | N/A        | 0                      | 0          |                                                                                                                                                                                                                        |
|                                                         | (1)                   | TXCLK neg. edge                   | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                                                        |
|                                                         | (0)                   | Twos complement                   | 1     | 0                      | 0          | 1                      | 1          |                                                                                                                                                                                                                        |
| Rx INTERFACE AND ANALOG/DIGITAL LOOPBACK                |                       |                                   |       |                        |            |                        |            |                                                                                                                                                                                                                        |
| 0x0D                                                    | (7)                   | Analog Loopback                   | 1     | 0                      | 0          | 0                      | 0          | Data format is straight binary for half-duplex and twos complement for full-duplex interface. Analog loopback: ADC Rx data fed back to TxDAC. Digital loopback: Tx input data to Rx output port.<br>*Full-duplex only. |
|                                                         | (6)                   | Digital Loopback*                 | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                                                        |
|                                                         | (5)                   | Rx Port 3-State                   | 1     | N/A                    | N/A        | 0                      | 0          |                                                                                                                                                                                                                        |
|                                                         | (4)                   | Invert RXEN/RXSYNC                | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                                                        |
|                                                         | (2)                   | LS Nibble First*                  | 1     | N/A                    | N/A        | 0                      | 0          |                                                                                                                                                                                                                        |
|                                                         | (1)                   | RXCLK neg. edge                   | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                                                        |
|                                                         | (0)                   | Twos complement                   | 1     | 0                      | 0          | 1                      | 1          |                                                                                                                                                                                                                        |
| DIGITAL OUTPUT DRIVE STRENGTH, TxDAC OUTPUT, AND REV ID |                       |                                   |       |                        |            |                        |            |                                                                                                                                                                                                                        |
| 0x0E                                                    | (7)                   | Low Drive Strength                | 1     | 0                      | 0          | 0                      | 0          | Default setting is for high drive strength and IAMP enabled.                                                                                                                                                           |
|                                                         | (0)                   | TxDAC Output                      | 1     | 0                      | 0          | 0                      | 0          |                                                                                                                                                                                                                        |
| 0x0F                                                    | (3:0)                 | REV ID Number                     | 4     | 0x00                   | 0x00       | 0x00                   | 0x00       |                                                                                                                                                                                                                        |

| Address<br>(Hex) <sup>1</sup> | Bit<br>Break-<br>down | Description      | Width | Power-Up Default Value |            |                        |            | Comments                                                                      |
|-------------------------------|-----------------------|------------------|-------|------------------------|------------|------------------------|------------|-------------------------------------------------------------------------------|
|                               |                       |                  |       | MODE = 0 (Half-Duplex) |            | MODE = 1 (Full-Duplex) |            |                                                                               |
|                               |                       |                  |       | CONFIG = 0             | CONFIG = 1 | CONFIG = 0             | CONFIG = 1 |                                                                               |
| Tx IAMP GAIN AND BIAS CONTROL |                       |                  |       |                        |            |                        |            |                                                                               |
| 0x10                          | (7)                   | Select Tx Gain   | 1     | 0x44                   | 0x44       | 0x44                   | 0x44       | Secondary path G1 = 0, 1, 2, 3, 4.<br>Primary path N = 0, 1, 2, 3, 4.         |
|                               | (6:4)                 | G1               | 3     |                        |            |                        |            |                                                                               |
|                               | (2:0)                 | N                | 3     |                        |            |                        |            |                                                                               |
| 0x11                          | (6:4)                 | G2               | 3     | 0x62                   | 0x62       | 0x62                   | 0x62       | Secondary path stages:<br>G2 = 0 to 1.50 in 0.25 steps<br>and G3 = 0 to 6.    |
|                               | (2:0)                 | G3               | 3     |                        |            |                        |            |                                                                               |
| 0x12                          | (6:4)                 | Stand Secondary  | 3     | 0x01                   | 0x01       | 0x01                   | 0x01       | Standing current of primary<br>and secondary path.                            |
|                               | (2:0)                 | Stand Primary    | 3     |                        |            |                        |            |                                                                               |
| 0x13                          | (7:5)                 | CPGA Bias Adjust | 3     | 0x00                   | 0x00       | 0x00                   | 0x00       | Current bias setting for Rx<br>path's functional blocks.<br>Refer to Page 41. |
|                               | (4:3)                 | SPGA Bias Adjust | 2     |                        |            |                        |            |                                                                               |
|                               | (2:0)                 | ADC Bias Adjust  | 4     |                        |            |                        |            |                                                                               |

<sup>1</sup> Bits that are undefined should always be assigned a 0.

## REGISTER MAP DESCRIPTION

The AD9866 contains a set of programmable registers described in Table 11 that are used to optimize its numerous features, interface options, and performance parameters from its default register settings. Registers pertaining to similar functions have been grouped together and assigned adjacent addresses to minimize the update time when using the multibyte serial port interface (SPI) read/write feature. Bits that are undefined within a register should be assigned a 0 when writing to that register.

The default register settings were intended to allow some applications to operate without the use of an SPI. The AD9866 can be configured to support a half- or full-duplex digital interface via the MODE pin, with each interface having two possible default register settings determined by the setting of the CONFIG pin.

For instance, applications that need to use only the Tx or Rx path functionality of the AD9866 can configure it for a half-duplex interface (MODE = 0), and use the TXEN pin to select between the Tx or Rx signal path with the unused path remaining in a reduced power state. The CONFIG pin can be used to select the default interpolation ratio of the Tx path and RxPGA gain mapping.

## SERIAL PORT INTERFACE (SPI)

The serial port of the AD9866 has 3- or 4-wire SPI capability allowing read/write access to all registers that configure the device's internal parameters. Registers pertaining to the SPI are listed in Table 12. The default 3-wire serial communication port consists of a clock (SCLK), serial port enable (SEN), and a bidirectional data (SDIO) signal.  $\overline{\text{SEN}}$  is an active low control gating read and write cycle. When  $\overline{\text{SEN}}$  is high, SDO and SDIO are three-stated. The inputs to SCLK,  $\overline{\text{SEN}}$ , and SDIO contain a Schmitt trigger with a nominal hysteresis of 0.4 V centered about VDDH/2. The SDO pin remains three-stated in a 3-wire SPI interface.

**Table 12. SPI Registers Pertaining to SPI Options**

| Address (Hex) | Bit | Description          |
|---------------|-----|----------------------|
| 0x00          | (7) | Enable 4-wire SPI    |
|               | (6) | Enable SPI LSB first |

A 4-wire SPI can be enabled by setting the 4-wire SPI bit high, causing the output data to appear on the SDO pin instead of on the SDIO pin. The SDIO pin serves as an input-only throughout the read operation. Note that the SDO pin is active only during the transmission of data and remains three-stated at any other time.

An 8-bit instruction header must accompany each read and write operation. The instruction header is shown in Table 13. The MSB is an R/ $\overline{\text{W}}$  indicator bit with logic high indicating a read operation. The next two bits, N1 and N0, specify the number of bytes (one to four bytes) to be transferred during the data transfer cycle. The remaining five bits specify the address bits to be accessed during the data transfer portion. The data bits immediately follow the instruction header for both read and write operations.

**Table 13. Instruction Header Information**

| MSB                      |    |    |    |    |    |    | LSB |
|--------------------------|----|----|----|----|----|----|-----|
| 17                       | 16 | 15 | 14 | 13 | 12 | 11 | 10  |
| R/ $\overline{\text{W}}$ | N1 | N0 | A4 | A3 | A2 | A1 | A0  |

The AD9866 serial port can support both MSB (most significant bit) first and LSB (least significant bit) first data formats. Figure 45 illustrates how the serial port words are built for the MSB first and LSB first modes. The bit order is controlled by the SPI LSB first bit (Register 0, Bit 6). The default value is 0, MSB first. Multibyte data transfers in MSB format can be completed by writing an instruction byte that includes the register address of the last address to be accessed. The AD9866 automatically decrements the address for each successive byte required for the multibyte communication cycle.

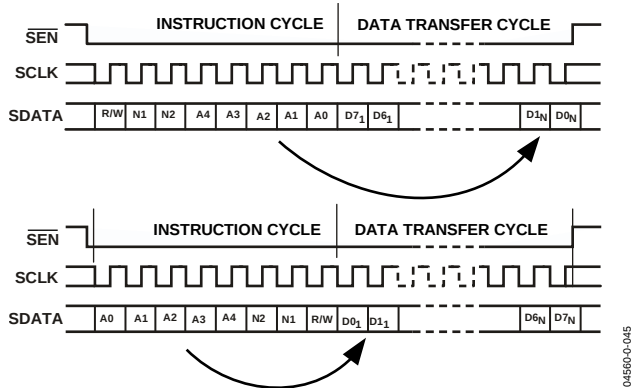


Figure 45. SPI Timing, MSB First (Upper) and LSB First (Lower)

When the SPI LSB first bit is set high, the serial port interprets both instruction and data bytes LSB first. Multibyte data transfers in LSB format can be completed by writing an instruction byte that includes the register address of the first address to be accessed. The AD9866 automatically increments the address for each successive byte required for the multibyte communication cycle.

Figure 46 illustrates the timing requirements for a write operation to the SPI port. After the serial port enable ( $\overline{\text{SEN}}$ ) signal goes low, data (SDIO) pertaining to the instruction header is read on the rising edges of the clock (SCLK). To initiate a write operation, the read/not-write bit is set low. After the instruction header is read, the eight data bits pertaining to the specified register are shifted into the SDIO pin on the rising edge of the next eight clock cycles. If a multibyte communication cycle is specified, the destination address is decremented (MSB first) and shifts in another eight bits of data. This process repeats until all the bytes specified in the instruction header (N1, N0 bits) are shifted into the SDIO pin.  $\overline{\text{SEN}}$  must remain low during the data transfer operation, only going high after the last bit is shifted into the SDIO pin.

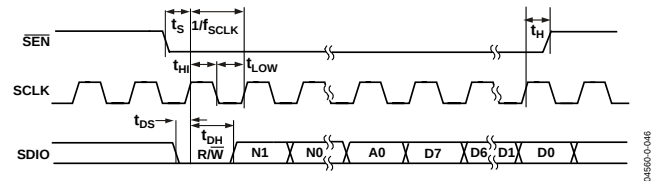


Figure 46. SPI Write Operation Timing

Figure 47 illustrates the timing for a 3-wire read operation to the SPI port. After  $\overline{\text{SEN}}$  goes low, data (SDIO) pertaining to the instruction header is read on the rising edges of SCLK. A read operation occurs if the read/not-write indicator is set high. After the address bits of the instruction header are read, the eight data bits pertaining to the specified register are shifted out of the SDIO pin on the falling edges of the next eight clock cycles. If a multibyte communication cycle is specified in the instruction header, a similar process as previously described for a multibyte SPI write operation applies. The SDO pin remains three-stated in a 3-wire read operation.

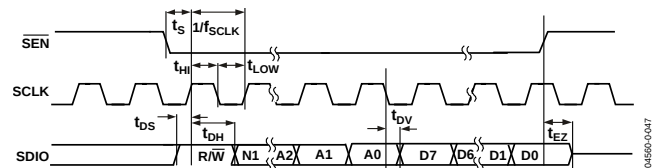


Figure 47. SPI 3-Wire Read Operation Timing

Figure 48 illustrates the timing for a 4-wire read operation to the SPI port. The timing is similar to the 3-wire read operation with the exception that data appears at the SDO pin, while the SDIO pin remains high impedance throughout the operation. The SDO pin is an active output only during the data transfer phase and remains three-stated at all other times.

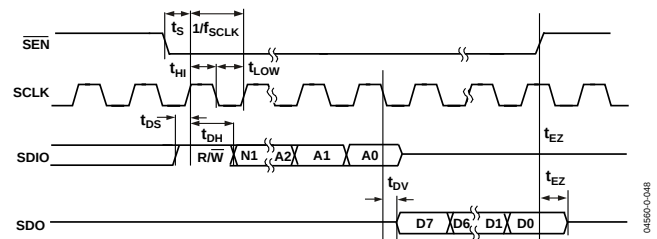


Figure 48. SPI 4-Wire Read Operation Timing

## DIGITAL INTERFACE

The digital interface port is configurable for half-duplex or full-duplex operation by pin-strapping the MODE pin low or high, respectively. In half-duplex mode, the digital interface port becomes a 10-bit bidirectional bus called the ADIO port. In full-duplex mode, the digital interface port is divided into two 6-bit ports called Tx[5:0] and Rx[5:0] for simultaneous Tx and Rx operations. In this mode, data is transferred between the ASIC and AD9866 in 6-bit nibbles. The AD9866 also features a flexible digital interface for updating the RxPGA and TxPGA gain registers via a 6-bit PGA port or Tx[5:0] port for fast updates, or via the SPI port for slower updates. See the RXPGA Control section for more information.

### HALF-DUPLEX MODE

The half-duplex mode functions as follows when the MODE pin is tied low. The bidirectional ADIO port is typically shared in burst fashion between the transmit path and receive path. Two control signals, TXEN and RXEN, from a DSP (or digital ASIC) control the bus direction by enabling the ADIO port's input latch and output driver, respectively. Two clock signals are also used: TXCLK to latch the Tx input data, and RXCLK to clock the Rx output data. The ADIO port can also be disabled by setting TXEN and RXEN low (default setting), thus allowing it to be connected to a shared bus.

Internally, the ADIO port consists of an input latch for the Tx path in parallel with an output latch with three-state outputs for the Rx path. TXEN is used to enable the input latch; RXEN is used to three-state the output latch. A five-sample-deep FIFO is used on the Tx and Rx paths to absorb any phase difference between the AD9866's internal clocks and the externally supplied clocks (TXCLK, RXCLK). The ADIO bus accepts input data-words into the transmit path when the TXEN pin is high, the RXEN pin is low, and a clock is present on the TXCLK pin, as shown in Figure 49.

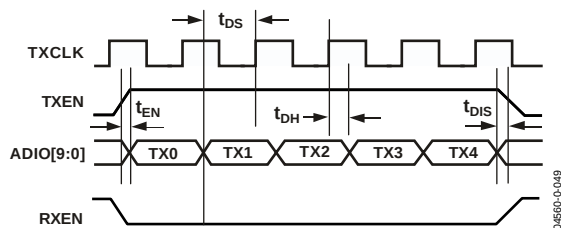


Figure 49. Transmit Data Input Timing Diagram

The Tx interpolation filter(s) following the ADIO port can be flushed with zeros, if the clock signal into the TXCLK pin is present for 33 clock cycles after TXEN goes low. Note that the data on the ADIO bus is irrelevant over this interval.

The output from the receive path is driven onto the ADIO bus when the RXEN pin is high, and a clock is present on the RXCLK pin. While the output latch is enabled by RXEN, valid data appears on the bus after a 6-clock-cycle delay due to the

internal FIFO delay. Note that Rx data is not latched back into the Tx path, if TXEN is high during this interval with TXCLK present. The ADIO bus becomes three-stated once the RXEN pin returns low. Figure 50 shows the receive path output timing.

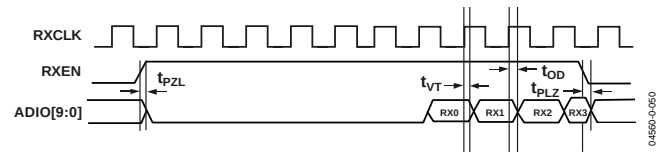


Figure 50. Receive Data Output Timing Diagram

To add flexibility to the digital interface port, several programming options are available in the SPI registers. These options are listed in Table 14. The default Tx and Rx data input formats are straight binary, but can be changed to twos complement. The default TXEN and RXEN settings are active high, but can be set to opposite polarities, thus allowing them to share the same control. In this case, the ADIO port can still be placed onto a shared bus by disabling its input latch via the control signal, and disabling the output driver via the SPI register. The clock timing can be independently changed on the transmit and receive paths by selecting either the rising or falling clock edge as the validating/sampling edge of the clock. Lastly, the output driver's strength can be reduced for lower data rate applications.

Table 14. SPI Registers for Half-Duplex Interface

| Address (Hex) | Bit | Description                |
|---------------|-----|----------------------------|
| 0x0C          | (4) | Invert TXEN                |
|               | (1) | TXCLK negative edge        |
|               | (0) | Twos complement            |
| 0x0D          | (5) | Rx port three-state        |
|               | (4) | Invert RXEN                |
|               | (1) | RXCLK negative edge        |
| 0x0E          | (0) | Twos complement            |
|               | (7) | Low digital drive strength |

The half-duplex interface can be configured to act like a slave or a master to the digital ASIC. An example of a slave configuration is shown in Figure 51. In this example, the AD9866 accepts all the clock and control signals from the digital ASIC. Because the sampling clocks for the DAC and ADC are derived internally from the OSCIN signal, it is required that the TXCLK and RXCLK signals be at exactly the same frequency as the OSCIN signal. The phase relationships among the TXCLK, RXCLK, and OSCIN signals can be arbitrary. If the digital ASIC cannot provide a low jitter clock source to OSCIN, use the AD9866 to generate the clock for its DAC and ADC, and pass the desired clock signal to the digital ASIC via CLKOUT1 or CLKOUT2.

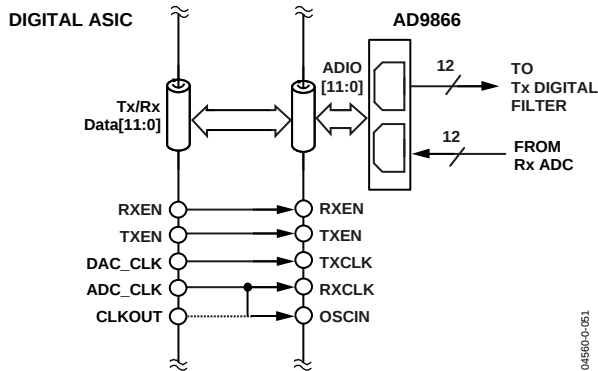


Figure 51. Example of a Half-Duplex Digital Interface with AD9866 Serving as the Slave

Figure 52 shows a half-duplex interface with the AD9866 acting as the master, generating all the required clocks. CLKOUT1 provides a clock equal to the bus data rate that is fed to the ASIC as well as back to the TXCLK and RXCLK inputs. This interface has the advantage of reducing the digital ASIC's pin count by three. The ASIC needs only to generate a bus control signal that controls the data flow on the bidirectional bus.

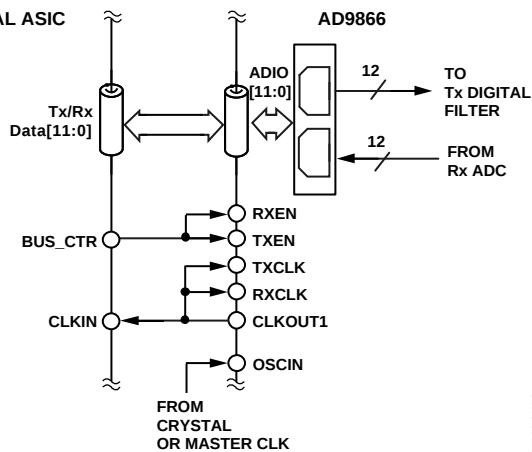


Figure 52. Example of a Half-Duplex Digital Interface with AD9866 Serving as the Master

## FULL-DUPLEX MODE

The full-duplex mode interface is selected when the MODE pin is tied high. It can be used for full- or half-duplex applications. The digital interface port is divided into two 6-bit ports called Tx[5:0] and Rx[5:0], allowing simultaneous Tx and Rx operations for full-duplex applications. In half-duplex applications, the Tx[5:0] port can also be used to provide a fast update of the RxPGA (AD9876 backward compatible) during an Rx operation. This feature is enabled by default and can be used to reduce the required pin count of the ASIC (refer to RxPGA Control section for details).

In either application, Tx and Rx data are transferred between the ASIC and AD9866 in 6-bit nibbles at twice the internal input/output word rates of the Tx interpolation filter and ADC. Note that the TxDAC update rate *must not* be less than the nibble rate. Therefore, the 2× or 4× interpolation filter must be used with a full-duplex interface.

The AD9866 acts as the master, providing RXCLK as an output clock that is used for the timing of both the Tx[5:0] and Rx[5:0] ports. RXCLK always runs at the nibble rate and can be inverted or disabled via an SPI register. Because RXCLK is derived from the clock synthesizer, it remains active, provided that this functional block remains powered on. A buffered version of the signal appearing at OSCIN can also be directed to RXCLK by setting Bit 2 of Register 0x05. This feature allows the AD9866 to be completely powered down (including the clock synthesizer) while serving as the master.

The Tx[5:0] port operates in the following manner with the SPI register default settings. Two consecutive nibbles of the Tx data are multiplexed together to form a 10-bit data-word in twos complement format. The clock appearing on the RXCLK pin is a buffered version of the internal clock used by the Tx[5:0] port's input latch with a frequency that is always twice the ADC sample rate ( $2 \times f_{ADC}$ ). Data from the Tx[5:0] port is read on the rising edge of this sampling clock, as illustrated in the timing diagram shown in Figure 53. Note, TXQUIET must remain high for the reconstructed Tx data to appear as an analog signal at the output of the TxDAC or IAMP.

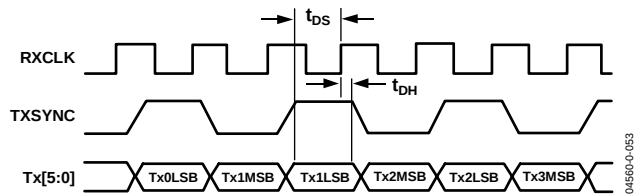


Figure 53. Tx[5:0] Port Full-Duplex Timing Diagram

The TXSYNC signal is used to indicate to which word a nibble belongs. While TXSYNC is low, the first nibble of every word is read as the most significant nibble. The second nibble of that same word is read on the following TXSYNC high level as the least significant nibble. If TXSYNC is low for more than one clock cycle, the last transmit data is read continuously until TXSYNC is brought high for the second nibble of a new transmit word. This feature can be used to flush the interpolator filters with zeros. Note that the GAIN signal must be kept low during a Tx operation.

The Rx[5:0] port operates in the following manner with the SPI register default settings. Two consecutive nibbles of the Rx data are multiplexed together to form a 12-bit data-word in twos complement format. The Rx data is valid on the rising edge of RXCLK, as illustrated in the timing diagram shown in Figure 54. The RXSYNC signal is used to indicate to which word a nibble belongs. While RXSYNC is low, the first nibble of every word is transmitted as the most significant nibble. The second nibble of that same word is transmitted on the following RXSYNC high level as the least significant nibble.

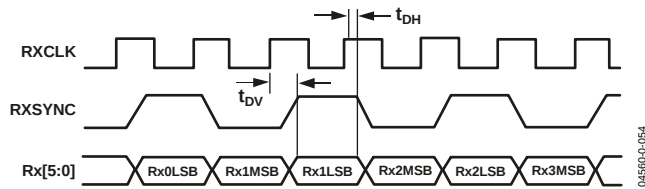


Figure 54. Full-Duplex Rx Port Timing

To add flexibility to the full-duplex digital interface port, several programming options are available in the SPI registers. These options are listed in Table 15. The timing for the Tx[5:0] and/or Rx[5:0] ports can be independently changed by selecting either the rising or falling clock edge as the sampling/validating edge of the clock. Inverting RXCLK (via Bit 1 or Register 0x05) affects both the Rx and Tx interface, because they both use RXCLK.

Table 15. SPI Registers for Full-Duplex Interface

| Address (Hex) | Bit | Description         |
|---------------|-----|---------------------|
| 0x05          | (2) | OSCIN to RXCLK      |
|               | (1) | Invert RXCLK        |
|               | (0) | Disable RXCLK       |
| 0x0B          | (2) | Rx gain on Tx port  |
| 0x0C          | (4) | Invert TXSYNC       |
|               | (3) | NA                  |
|               | (2) | LS nibble first     |
|               | (1) | TXCLK negative edge |
|               | (0) | Twos complement     |
| 0x0D          | (5) | Rx port three-state |
|               | (4) | Invert RXSYNC       |
|               | (3) | NA                  |
|               | (2) | LS nibble first     |
|               | (1) | RXCLK negative edge |
|               | (0) | Twos complement     |
| 0x0E          | (7) | Low drive strength  |

The default Tx and Rx data input formats are twos complement, but can be changed to straight binary. The default TXSYNC and RXSYNC settings can be changed such that the first nibble of the word appears while TXSYNC, RXSYNC, or both are high. Also, the least significant nibble can be selected as the first nibble of the word (LS nibble first). The output driver strength can also be reduced for lower data rate applications.

Figure 55 shows a possible digital interface between an ASIC and the AD9866. The AD9866 serves as the master generating the required clocks for the ASIC. This interface requires that the ASIC reserve 16 pins for the interface, assuming a 6-bit nibble width and the use of the Tx port for RxPGA gain control. Note that the ASIC pin allocation can be reduced by 3, if a 5-bit nibble width is used and the gain (or gain strobe) of the RxPGA is controlled via the SPI port.

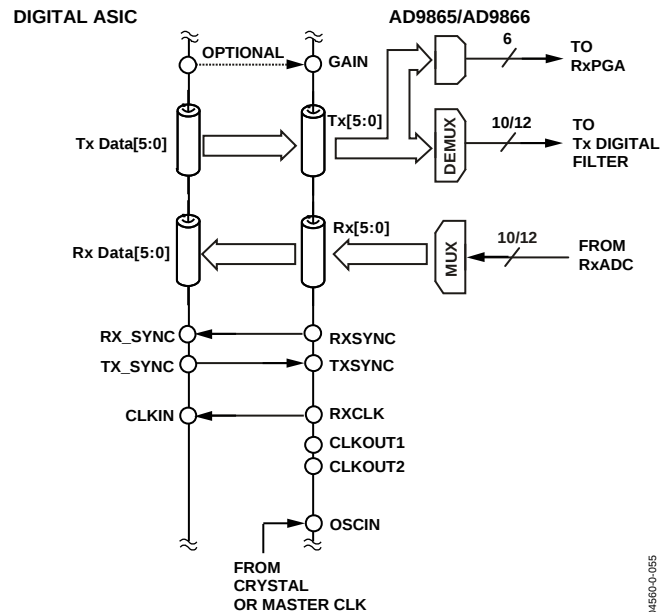


Figure 55. Example of a Full-Duplex Digital Interface with Optional RxPGA Gain Control via Tx[5:0]

## RxPGA CONTROL

The AD9866 contains a digital PGA in the Rx path that is used to extend the dynamic range. The RxPGA can be programmed over a  $-12$  dB to  $+48$  dB with 1 dB resolution using a 6-bit word, and with a 0 dB setting corresponding to a 2 V p-p input signal. The 6-bit word is fed into a LUT that is used to distribute the desired gain over three amplification stages within the Rx path. Upon power-up, the RxPGA gain register is set to its minimum gain of  $-12$  dB. The RxPGA gain mapping is shown in Figure 56. Table 16 lists the SPI registers pertaining to the RxPGA.

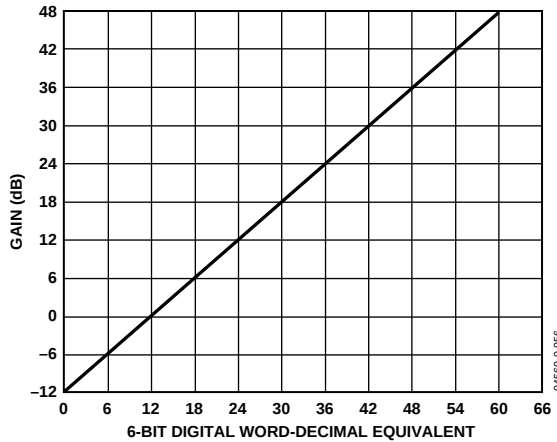


Figure 56. Digital Gain Mapping of RxPGA

Table 16. SPI Registers RxPGA Control

| Address (Hex) | Bit                             | Description                                                                                                                                                                                    |
|---------------|---------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0x09          | (6)<br>(5:0)                    | Enable RxPGA update via SPI<br>RxPGA gain code                                                                                                                                                 |
| 0x0B          | (6)<br>(5)<br>(3)<br>(2)<br>(1) | Select TxPGA via PGA[5:0]<br>Select RxPGA via PGA[5:0]<br>Enable software GAIN strobe – full-duplex<br>Enable RxPGA update via Tx[5:0] – full-duplex<br>3-bit RxPGA gain mapping – half-duplex |

The RxPGA gain register can be updated via the Tx[5:0] port, the PGA[5:0] port, or the SPI port. The first two methods allow fast updates of the RxPGA gain register and should be considered for digital AGC functions requiring a fast closed-loop response. The SPI port allows direct update and readback of the RxPGA gain register via Register 0x09 with an update rate limited to 1.6 MSPS (with SCLK = 32 MHz). Note that Bit 6 of Register 0x09 must be set for a read or write operation.

Updating the RxPGA via the Tx[5:0] port is an option only in full-duplex mode.<sup>1</sup> In this case, a high level on the GAIN pin<sup>2</sup> with TXSYNC low, programs the PGA setting on either the rising edge or falling edge of RXCLK, as shown in Figure 57. The GAIN pin must be held high, TXSYNC must be held low, and GAIN data must be stable for one or more clock cycles to update the RxPGA gain setting. A low level on the GAIN pin enables data to be fed to the digital interpolation filter. This

interface should be considered when upgrading existing designs from the AD9876 MxFE product or half-duplex applications trying to minimize an ASIC's pin count.

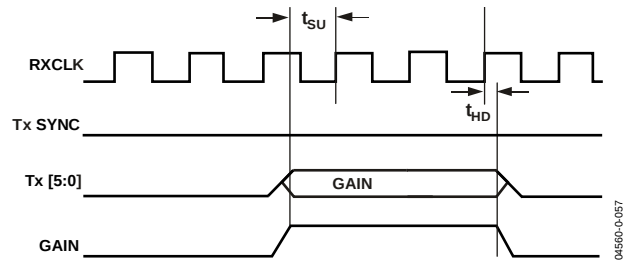


Figure 57. Updating RxPGA via Tx[5:0] in Full-Duplex Mode

Updating the RxPGA (or TxPGA) via the PGA[5:0] port is an option for both the half-duplex<sup>3</sup> and full-duplex interfaces. The PGA port consists of an input buffer that passes the 6-bit data appearing at its input directly to the RxPGA (or TxPGA) gain register with no gating signal required. Bit 5 or Bit 6 of Register 0x0B is used to select whether the data updates the RxPGA or TxPGA gain register. In applications that switch between RxPGA and TxPGA gain control via PGA[5:0], be careful that the RxPGA (or TxPGA) is not inadvertently loaded with the wrong data during a transition. In the case of an RxPGA to TxPGA transition, first deselect the RxPGA gain register, update the PGA[5:0] port with the desired TxPGA gain setting, and then select the TxPGA gain register.

The RxPGA also offers an alternative 3-bit word gain mapping option<sup>4</sup> that provides a  $-12$  dB to  $+36$  dB span in 8 dB increments as shown in Table 17. The 3-bit word is directed to PGA[5:3] with PGA[5] being the MSB. This feature is backward-compatible with the AD9975 MxFE, and allows direct interfacing to the CX11647 or INT5130 HomePlug 1.0 PHYs.

Table 17. PGA Timing for AD9975 Backward-Compatible Mode

| Digital Gain Setting |         | Gain (dB) |
|----------------------|---------|-----------|
| PGA[5:3]             | Decimal |           |
| 000                  | 0       | -12       |
| 001                  | 1       | -12       |
| 010                  | 2       | -4        |
| 011                  | 3       | 4         |
| 100                  | 4       | 12        |
| 101                  | 5       | 20        |
| 110                  | 6       | 28        |
| 111                  | 7       | 36        |

<sup>1</sup> Default setting for full-duplex mode (MODE = 1).

<sup>2</sup> The GAIN strobe can also be set in software via Register 0x0B, Bit 3 for continuous updating. This eliminates the requirement for external GAIN signal, reducing the ASIC pin count by 1.

<sup>3</sup> Default setting for half-duplex mode (MODE = 0).

<sup>4</sup> Default setting for MODE = 0 and CONFIG = 1.

## TXPGA CONTROL

The AD9866 also contains a digital PGA in the Tx path distributed between the TxDAC and IAMP. The TxPGA is used to control the peak current from the TxDAC and IAMP over a 7.5 dB and 19.5 dB span, respectively, with 0.5 dB resolution. A 6-bit word is used to set the TxPGA attenuation according to the mapping shown in Figure 58. The TxDAC gain mapping is applicable only when Bit 0 of Register 0x0E is set, and only the four LSBs of the 6-bit gain word are relevant.

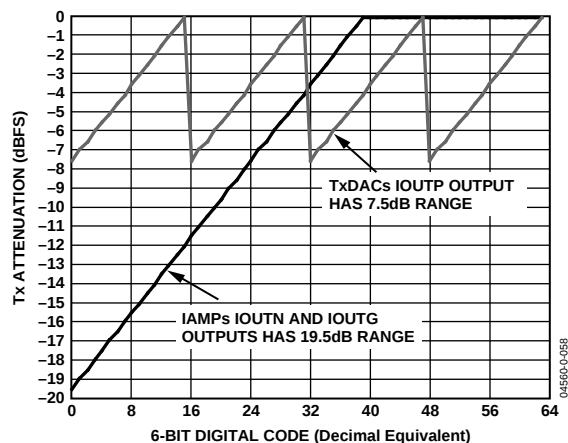


Figure 58. Digital Gain Mapping of TxPGA

The TxPGA register can be updated via the PGA[5:0] port or SPI port. The first method should be considered for fast updates of the TxPGA register. Its operation is similar to the description in the RxPGA Control section. The SPI port allows direct update and readback of the TxPGA register via Register 0x0A with an update rate limited to 1.6 MSPS (SCLK = 32 MHz). Bit 6 of Register 0x0A must be set for a read or write operation. Table 18 lists the SPI registers pertaining to the TxPGA. The TxPGA control register default setting is for minimum attenuation (0 dBFS) with the PGA[5:0] port disabled for Tx gain control.

Table 18. SPI Registers TxPGA Control

| Address (Hex) | Bit   | Description                  |
|---------------|-------|------------------------------|
| 0x0A          | (6)   | Enable TxPGA update via SPI  |
|               | (5:0) | TxPGA gain code              |
| 0x0B          | (6)   | Select TxPGA via PGA[5:0]    |
|               | (5)   | Select RxPGA via PGA[5:0]    |
| 0x0E          | (0)   | TxDAC output (IAMP disabled) |

## TRANSMIT PATH

The AD9866 (or AD9865) transmit path consists of a selectable digital 2×/4× interpolation filter, a 12-bit (or 10-bit) TxDAC, and a current-output amplifier (IAMP), as shown in Figure 59. Note that the additional two bits of resolution offered by the AD9866 (vs. the AD9865) result in a 10 dB to 12 dB reduction in the pass-band noise floor. The digital interpolation filter relaxes the Tx analog filtering requirements by simultaneously reducing the images from the DAC reconstruction process while increasing the analog filter's transition band. The digital interpolation filter can also be bypassed, resulting in lower digital current consumption.

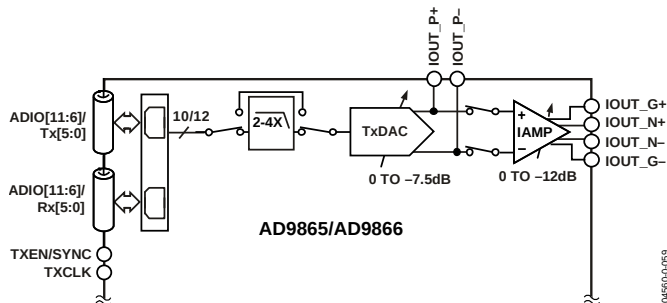


Figure 59. Functional Block Diagram of Tx Path

## DIGITAL INTERPOLATION FILTERS

The input data from the Tx port can be fed into a selectable 2×/4× interpolation filter or directly into the TxDAC (for a half-duplex only). The interpolation factor for the digital filter is set via SPI Register 0x0C with the settings shown in Table 19. The maximum input word rate,  $f_{DATA}$ , into the interpolation filter is 80 MSPS; the maximum DAC update rate is 200 MSPS. Therefore, applications with input word rates at or below 50 MSPS can benefit from 4× interpolation, while applications with input word rates between 50 MSPS and 80 MSPS can benefit from 2× interpolation.

Table 19. Interpolation Factor Set via SPI Register 0x0C

| Bits [7:6] | Interpolation Factor |
|------------|----------------------|
| 00         | 4                    |
| 01         | 2                    |
| 10         | 1 (half-duplex only) |
| 11         | Do not use           |

The interpolation filter consists of two cascaded half-band filter stages with each stage providing 2× interpolation. The first stage filter consists of 43 taps. The second stage filter, operating at the higher data rate, consists of 11 taps. The normalized wide band and pass-band filter responses (relative  $f_{DATA}$ ) for the 2× and 4× low-pass interpolation filters are shown in Figure 60 and Figure 61, respectively. These responses also include the inherent sinc(x) from the TxDAC reconstruction process and can be used to estimate any post analog filtering requirements.

The pipeline delays of the 2× and 4× filter responses are 21.5 and 24 clock cycles, respectively, relative to  $f_{DATA}$ . The filter delay is also taken into consideration for applications configured for a half-duplex interface with the half-duplex power-down mode enabled. This feature allows the user to set a programmable delay that powers down the TxDAC and IAMP only after the last Tx input sample has propagated through the digital filter. See the Power Control and Dissipation section for more details.

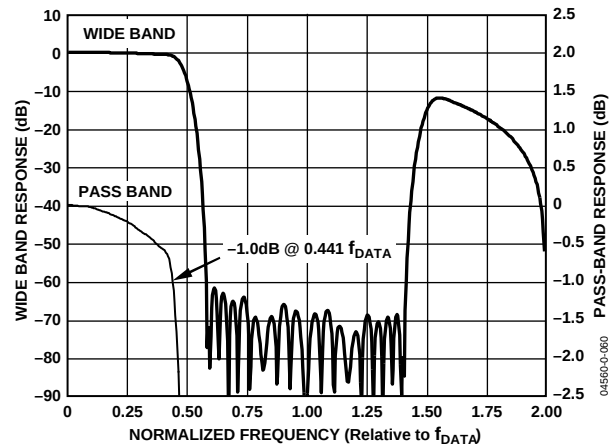


Figure 60. Frequency Response of 2× Interpolation Filter (Normalized to  $f_{DATA}$ )

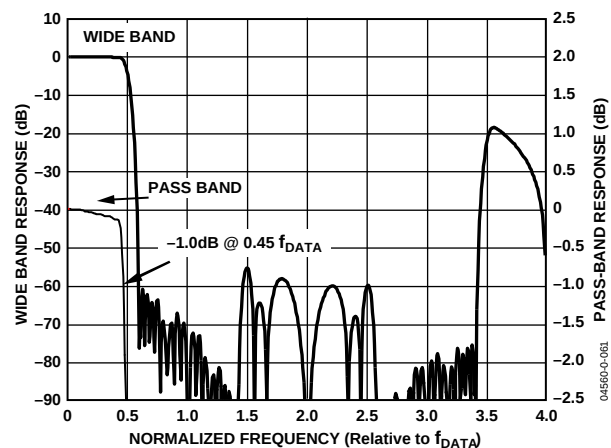


Figure 61. Frequency Response of 4× Interpolation Filter (Normalized to  $f_{DATA}$ )

## TxDAC AND IAMP ARCHITECTURE

The Tx path contains a TxDAC with a current amplifier, IAMP. The TxDAC reconstructs the output of the interpolation filter and sources a differential current output that can be directed to an external load or fed into the IAMP for further amplification. The TxDAC's and IAMP's peak current outputs are digitally programmable over a 0 to -7.5 dB and 0 to -19.5 dB range, respectively, in 0.5 dB increments. Note that this assumes default register settings for Register 0x10 and Register 0x11.

Applications demanding the highest spectral performance and/or lowest power consumption can use the TxDAC output directly. The TxDAC is capable of delivering a peak signal power-up to 10 dBm while maintaining respectable linearity performance, as shown in Figure 27 through Figure 38. For power-sensitive applications requiring the highest Tx power efficiency, the TxDAC's full-scale current output can be reduced to as low as 2 mA, and its load resistors sized to provide a suitable voltage swing that can be amplified by a low-power op amp-based driver.

Most applications requiring higher peak signal powers (up to 23 dBm) should consider using the IAMP. The IAMP can be configured as a current source for loads having a well defined impedance (50  $\Omega$  or 75  $\Omega$  systems), or a voltage source (with the addition of a pair of npn transistors) for poorly defined loads having varying impedance (such as power lines).

Figure 62 shows the equivalent schematic of the TxDAC and IAMP. The TxDAC provides a differential current output appearing at IOUTP+ and IOUTP-. It can be modeled as a differential current source generating a signal-dependent ac current, when  $\Delta I_s$  has a peak current of  $I$  along with two dc current sources, sourcing a standing current equal to  $I$ . The full-scale output current, IOUTFS, is equal to the sum of these standing current sources ( $IOUTFS = 2 \times I$ ).

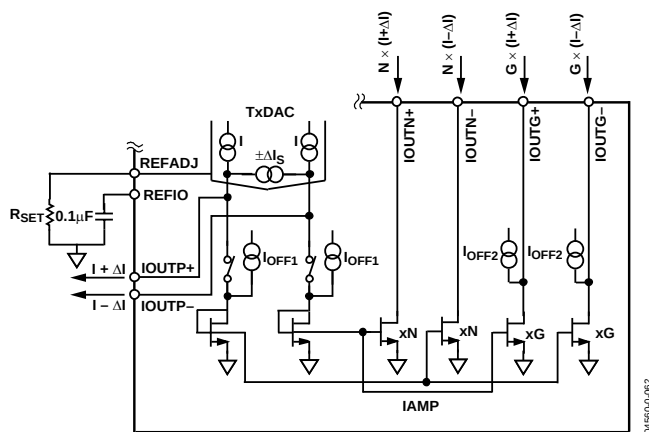


Figure 62. Equivalent Schematic of TxDAC and IAMP

The value of  $I$  is determined by the  $R_{SET}$  value at the REFADJ pin along with the Tx path's digital attenuation setting. With 0 dB attenuation, the value of  $I$  is

$$I = 16 \times (1.23/R_{SET}) \quad (1)$$

For example, an  $R_{SET}$  value of 1.96 k $\Omega$  results in  $I$  equal to 10.0 mA with IOUTFS equal to 20.0 mA. Note that the REFIO pin provides a nominal band gap reference voltage of 1.23 V and should be decoupled to analog ground via a 0.1  $\mu$ F capacitor.

The differential current output of the TxDAC is always connected to the IOUTP pins, but can be directed to the IAMP by clearing Bit 0 of Register 0x0E. As a result, the IOUTP pins *must* remain completely open, if the IAMP is to be used. The IAMP contains two sets of current mirrors that are used to replicate the TxDAC's current output with a selectable gain. The first set of current mirrors is designated as the primary path, providing a gain factor of  $N$  that is programmable from 0 to 4 in steps of 1 via Bits 2:0 of Register 0x10 with a default setting of  $N = 4$ . Bit 7 of this register *must* be set to overwrite the default settings of this register. This differential path exhibits the best linearity performance (see Figure 42) and is available at the IOUTN+ and IOUTN- pins. The maximum peak current per output is 100 mA and occurs when the TxDAC's standing current,  $I$ , is set for 12.5 mA ( $IOUTFS = 25$  mA).

The second set of current mirrors is designated as the secondary path providing a gain factor of  $G$  that is programmable from 0 to 36 via Bits 6:4 of Register 0x10, and Bits 6:0 of Register 0x11 with a default setting of  $G = 12$ . This differential path is intended to be used in the voltage mode configuration to bias the external npn transistors, because it exhibits degraded linearity performance (see Figure 43) relative to the primary path. It is capable of sinking up to 180 mA of peak current into either its IOUTG+ or IOUTG- pins. The secondary path actually consists of three gain stages ( $G1$ ,  $G2$ , and  $G3$ ), which are individually programmable as shown in Table 20. While many permutations may exist to provide a fixed gain of  $G$ , the linearity performance of a secondary path remains relatively independent of the various individual gain settings that are possible to achieve a particular overall gain factor.

Both sets of mirrors sink current, because they originate from NMOS devices. Therefore, each output pin requires a dc current path to a positive supply. Although the voltage output of each output pin can swing between 0.5 V and 7 V, optimum ac performance is typically achieved by limiting the ac voltage swing with a dc bias voltage set between 4 V to 5 V. Lastly, both the standing current,  $I$ , and the ac current,  $\Delta I_s$ , from the TxDAC are amplified by the gain factor ( $N$  and  $G$ ) with the total standing current drawn from the positive supply being equal to

$$2 \times (N + G) \times I$$

Programmable current sources  $I_{OFF1}$  and  $I_{OFF2}$  via Register 0x12 can be used to improve the primary and secondary path mirrors' linearity performance under certain conditions by increasing their signal-to-standing current ratio. This feature provides a

marginal improvement in distortion performance under large signal conditions when the peak ac current of the reconstructed waveform frequently approaches the dc standing current within the TxDAC (0 to -1 dBFS sine wave) causing the internal mirrors to turn off. However, the improvement in distortion performance diminishes as the crest factor (peak-to-rms ratio) of the ac signal increases. Most applications can disable these current sources (set to 0 mA via Register 0x12) to reduce the IAMP's current consumption.

**Table 20. SPI Registers for TxDAC and IAMP**

| Address (Hex) | Bit   | Description                                                       |
|---------------|-------|-------------------------------------------------------------------|
| 0x0E          | (0)   | TxDAC output                                                      |
| 0x10          | (7)   | Enable current mirror gain settings                               |
|               | (6:4) | Secondary path first stage gain of 0 to 4 with $\Delta = 1$       |
|               | (3)   | Not used                                                          |
|               | (2:0) | Primary path NMOS gain of 0 to 4 with $\Delta = 1$                |
| 0x11          | (7)   | Don't care                                                        |
|               | (6:4) | Secondary path second stage gain of 0 to 1.5 with $\Delta = 0.25$ |
|               | (3)   | Not used                                                          |
|               | (2:0) | Secondary path third stage gain of 0 to 5 with $\Delta = 1$       |
| 0x12          | (6:4) | IOFF2, secondary path standing current                            |
|               | (2:0) | IOFF1, primary path standing current                              |

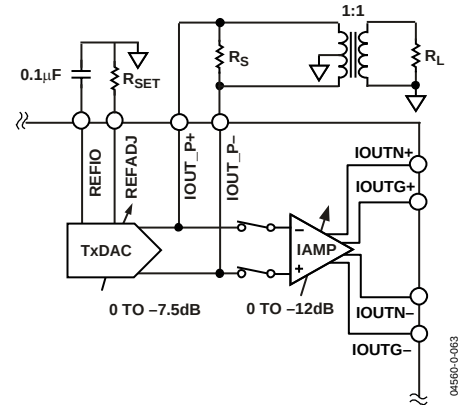
## Tx PROGRAMMABLE GAIN CONTROL

TxPGA functionality is also available to set the peak output current from the TxDAC or IAMP. The TxDAC and IAMP are digitally programmable via the PGA[5:0] port or SPI over a 0 dB to -7.5 dB and 0 dB to -19.5 dB range, respectively, in 0.5 dB increments.

The TxPGA can be considered as two cascaded attenuators with the TxDAC providing 7.5 dB range in 0.5 dB increments, and the IAMP providing 12 dB range in 6 dB increments. As a result, the IAMP's composite 19.5 dB span is valid only if Register 0x10 remains at its default setting of 0x44. Modifying this register setting corrupts the LUT and results in an invalid gain mapping.

## TxDAC OUTPUT OPERATION

The differential current output of the TxDAC is available at the IOUTP+ and IOUTP- pins and the IAMP should be disabled by setting Bit 0 of Register 0x0E. Any load connected to these pins must be ground referenced to provide a dc path for the current sources. Figure 63 shows the outputs of the TxDAC driving a doubly terminated 1:1 transformer with its center-tap tied to ground. The peak-to-peak voltage,  $V_{p-p}$ , across  $R_L$  (and IOUT+ to IOUT-) is equal to  $2 \times I \times (R_L/R_S)$ . With  $I = 10$  mA and  $R_L = R_S = 50 \Omega$ ,  $V_{p-p}$  is equal to 0.5 V with 1 dBm of peak power being delivered to  $R_L$  and 1 dBm being dissipated in  $R_S$ .



**Figure 63. TxDAC Output Directly via Center-Tap Transformer**

The TxDAC is capable of delivering up to 10 dBm peak power to a load,  $R_L$ . To increase the peak power for a fixed standing current, one must increase  $V_{p-p}$  across IOUTP+ and IOUTP- by increasing one or more of the following parameters:  $R_S$ ,  $R_L$  (if possible), and/or the turns ratio,  $N$ , of transformer. For example, the removal of  $R_S$  and the use of a 2:1 impedance ratio transformer in the previous example results in 10 dBm of peak power capabilities to the load. Note that increasing the power output capabilities of the TxDAC reduces the distortion performance due to the higher voltage swings seen at IOUTP+ and IOUTP-. See Figure 27 through Figure 38 for performance plots on the TxDAC's ac performance. Optimum distortion performance can typically be achieved by:

- Limiting the peak positive  $V_{IOUTP+}$  and  $V_{IOUTP-}$  to 0.8 V to avoid onset of TxDAC's output compression. (TxDAC's voltage compliance is around 1.2 V.)
- Limiting  $V_{p-p}$  seen at IOUTP+ and IOUTP- to less than 1.6 V.

Applications demanding higher output voltage swings and power drive capabilities can benefit from using the IAMP.

## IAMP CURRENT-MODE OPERATION

The IAMP can be configured for the current-mode operation as shown in Figure 64 for loads remaining relatively constant. In this mode, the primary path mirrors should be used to deliver the signal-dependent current to the load via a center-tapped transformer, because it provides the best linearity performance. Because the mirrors exhibit a high output impedance, they can be easily back-terminated (if required).

For peak signal currents ( $I_{OUTPK}$  up to 50 mA), only the primary path mirror gain should be used for optimum distortion performance and power efficiency. The primary path's gain should be set to 4, with the secondary path's gain stages set to 0 (Register 0x10 = 0x84). The TxDAC's standing current,  $I$ , can be set between 2.5 mA and 12.5 mA with the IOUTP outputs left open. The IOUTN outputs should be connected to the transformer, with the IOUTG (and IOUTP)

outputs left open for optimum linearity performance. The transformer<sup>1</sup> should be specified to handle the dc standing current,  $I_{\text{BIAS}}$ , drawn by the IAMP. Also, because  $I_{\text{BIAS}}$  remains signal independent, a series resistor (not shown) can be inserted between AVDD and the transformer's center-tap to reduce the IAMP's common-mode voltage,  $V_{\text{CM}}$ , and reduce the power dissipation on the IC. The  $V_{\text{CM}}$  bias should not exceed 5.0 V and the power dissipated in the IAMP alone is as follows:

$$P_{IAMP} = 2 \times (N + G) \times I \times V_{CM} \quad (2)$$

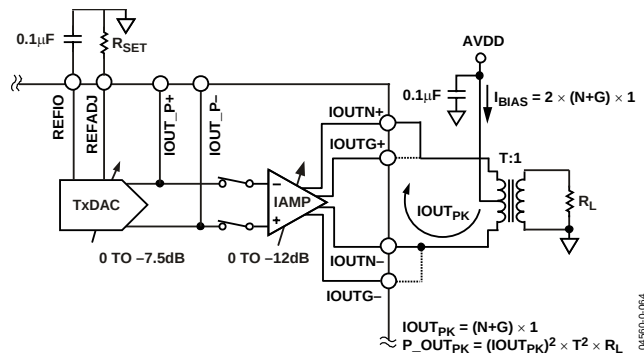


Figure 64. Current-Mode Operation

A step-down transformer<sup>1</sup> with a turn ratio,  $T$ , can be used to increase the output power,  $P_{OUT}$ , delivered to the load. This causes the output load,  $R_L$ , to be reflected back to the IAMP's differential output by  $T^2$ , resulting in a larger differential voltage swing seen at the IAMP's output. For example, the IAMP can deliver 24 dBm of peak power to a  $50\ \Omega$  load, if a 1.41:1 step-down transformer is used. This results in 5 V p-p voltage swings appearing at IOUTN+ and IOUTN- pins. Figure 42 shows how the third order intercept point, OIP3, of the IAMP varies as a function of common-mode voltage over a 2.5 MHz to 20.0 MHz span with a 2-tone signal having a peak power of approximately 24 dBm with  $IOUT_{PK} = 50\text{ mA}$ .

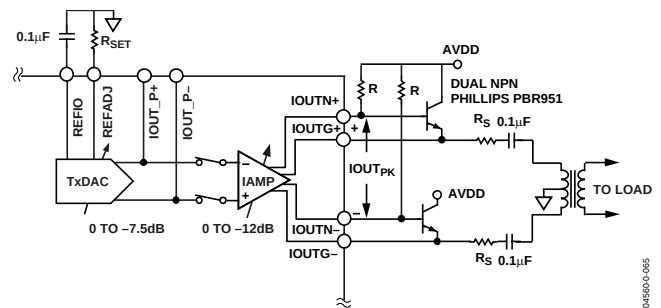
For applications requiring an  $IOUT_{PK}$  exceeding 50 mA, set the secondary's path to deliver the additional current to the load.  $IOUTG+$  and  $IOUTN+$  should be shorted as well as  $IOUTG-$  and  $IOUTN-$ . If  $IOUT_{PK}$  represents the peak current to be delivered to the load, then the current gain in the secondary path,  $G$ , can be set by the following equation:

$$G = IOUT_{PK}/12.5 - 4 \quad (3)$$

The linearity performance becomes limited by the secondary mirror path's distortion.

## IAMP VOLTAGE-MODE OPERATION

The voltage-mode configuration is shown in Figure 65. This configuration is suited for applications having a poorly defined load that can vary over a considerable range. A low impedance voltage driver can be realized with the addition of two external RF bipolar npn transistors (Phillips PBR951) and resistors. In this configuration, the current mirrors in the primary path (IOUTN outputs) feed into scaling resistors, R, generating a differential voltage into the bases of the npn transistors. These transistors are configured as source followers with the secondary path current mirrors appearing at IOUTG+ and IOUTG– providing a signal-dependent bias current. Note that the IOUTP outputs *must* remain open for proper operation.



*Figure 65. Voltage-Mode Operation*

The peak differential voltage signal developed across the npn's bases is as follows:

$$VOUT_{PK} = R \times (N \times I) \quad (4)$$

where:

$N$  is the gain setting of the primary mirror.

$I$  is the standing current of the TxDAC defined in Equation 1.

The common-mode bias voltage seen at IOUTN+ and IOUTN– is approximately  $AVDD - VOUT_{PK}$ , while the common-mode voltage seen at IOUTG+ and IOUTG– is approximately the npn’s  $V_{BE}$  drop below this level ( $AVDD - VOUT_{PK} - 0.65$ ). In the voltage-mode configuration, the total power dissipated within the IAMP is as follows:

$$P_{IAMP} = 2 \times I \{ (AVDD - VOUT_{PK}) \times N + (AVDD - VOUT_{PK} - 0.65) \times G \} \quad (5)$$

The emitters of the npn transistors are ac-coupled to the transformer<sup>1</sup> via a 0.1  $\mu\text{F}$  blocking capacitor and series resistor of 1  $\Omega$  to 2  $\Omega$ . Note that protection diodes are not shown for clarity purposes, but should be considered if interfacing to a power or phone line.

<sup>1</sup> The B6080 and BX6090 transformers from Pulse Engineering are worthy of consideration for current and voltage modes.

The amount of standing and signal-dependent current used to bias the npn transistors depends on the peak current,  $I_{OUT_{PK}}$ , required by the load. If the load is variable, determine the worst case,  $I_{OUT_{PK}}$ , and add 3 mA of margin to ensure that the npn transistors remain in the active region during peak load currents. The gain of the secondary path,  $G$ , and the TxDAC's standing current,  $I$ , can be set using the following equation:

$$I_{OUT_{PK}} + 3 \text{ mA} = G \times I \quad (6)$$

The voltage output driver exhibits a high output impedance if the bias currents for the npn transistors are removed. This feature is advantageous in half-duplex applications (for example, power lines) in which the Tx output driver must go into a high impedance state while in Rx mode. If the AD9866 is configured for the half-duplex mode ( $MODE = 0$ ), the IAMP, TxDAC, and interpolation filter are automatically powered down after a Tx burst (via TXEN), thus placing the Tx driver into a high impedance state while reducing its power consumption.

### IAMP CURRENT CONSUMPTION CONSIDERATIONS

The Tx path's analog current consumption is an important consideration when determining its contribution to the overall on-chip power dissipation. This is especially the case in full-duplex applications, where the power dissipation can exceed the maximum limit of 1.66 W, if the IAMP's  $I_{OUT_{PK}}$  is set to high. The analog current consumption includes the TxDAC's analog supply (Pin 43) along with the standing current from the IAMP's outputs. Equation 2 and Equation 5 can be used to calculate the power dissipated in the IAMP for the current and voltage-mode configuration. Figure 66 shows the current consumption for the TxDAC and IAMP as a function of the TxDAC's standing current,  $I$ , when only the IOUTN outputs are used. Figure 67 shows the current consumption for the TxDAC and IAMP as a function of the TxDAC's standing current,  $I$ , when the IOUTN and IOUTG outputs are used. Both figures are with the default current mirror gain settings of  $N = 4$  and  $G = 12$ .

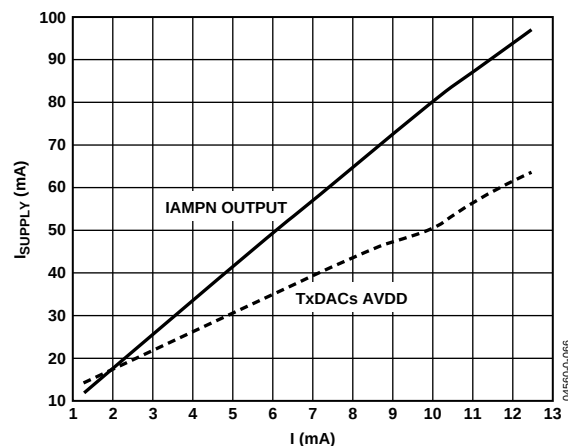


Figure 66. Current Consumption of TxDAC and IAMP in Current-Mode Operation with IOUTN Only (Default Settings)

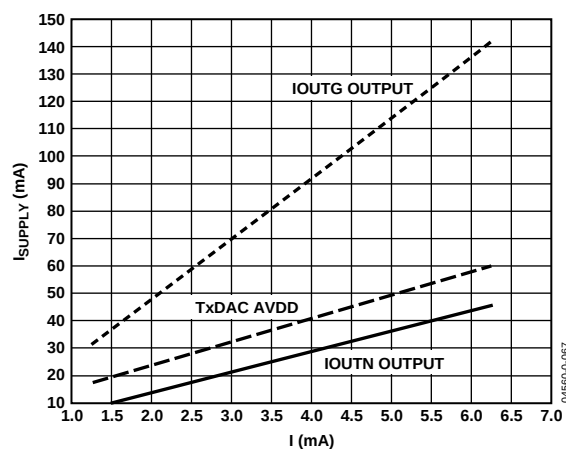


Figure 67. Current Consumption of TxDAC and IAMP in Current-Mode Operation with IOUTN Only (Default IAMP Settings)

## RECEIVE PATH

The receive path block diagram for the AD9866 (or AD9865) is shown in Figure 68. The receive signal path consists of a 3-stage RxPGA, a 3-pole programmable LPF, and a 12-bit (or 10-bit) ADC. Note that the additional 2 bits of resolution offered by the AD9866 (vs. the AD9865) result in a 3 dB to 5 dB lower noise floor depending on the RxPGA gain setting and LPF cutoff frequency. Also working in conjunction with the receive path is an offset correction circuit. These blocks are discussed in detail in the following sections. Note that the power consumption of the RxPGA can be modified via Register 0x13 as discussed in the Power Control and Dissipation section.

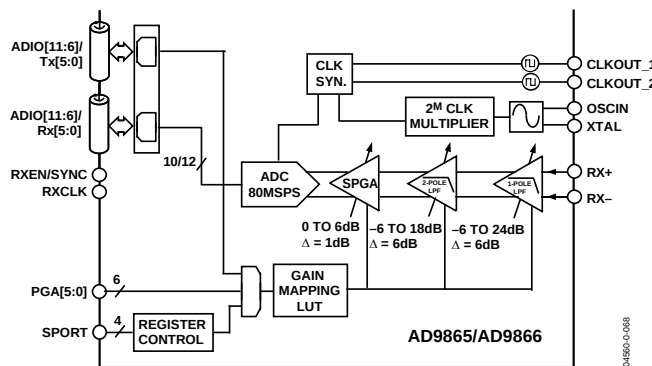


Figure 68. Functional Block Diagram of Rx Path

## RX PROGRAMMABLE GAIN AMPLIFIER

The RxPGA has a digitally programmable gain range from  $-12$  dB to  $+48$  dB with 1 dB resolution via a 6-bit word. Its purpose is to extend the dynamic range of the Rx path such that the input of the ADC is presented with a signal that scales within its fixed 2 V input span. There are multiple ways of setting the RxPGA's gain as discussed in the RxPGA Control section, as well as an alternative 3-bit gain mapping having a range of  $-12$  dB to  $+36$  dB with 8 dB resolution.

The RxPGA is comprised of two sections: a continuous time PGA (CPGA) for coarse gain and a switched capacitor PGA (SPGA) for fine gain resolution. The CPGA consists of two cascaded gain stages providing a gain range from  $-12$  dB to  $+42$  dB with 6 dB resolution. The first stage features a low noise preamplifier ( $< 3.0$  nV/ $\sqrt{\text{Hz}}$ ), thereby eliminating the need for an external preamplifier. The SPGA provides a gain range from 0 dB to 6 dB with 1 dB resolution. A look-up table (LUT) is used to select the appropriate gain setting for each stage.

The nominal differential input impedance of the RxPGA input appearing at the device RX+ and RX- input pins is  $400 \Omega / 4$  pF ( $\pm 20\%$ ) and remains relatively independent of gain setting. The PGA input is self-biased at a 1.3 V common-mode level allowing maximum input voltage swings of  $\pm 1.5$  V at RX+ and RX-. AC coupling the input signal to this stage via coupling capacitors (0.1  $\mu\text{F}$ ) is recommended to ensure that any external dc offset does not get amplified with high RxPGA gain settings, potentially exceeding the ADC input range.

To limit the RxPGA's self-induced input offset, an offset cancellation loop is included. This cancellation loop is automatically performed upon power-up and can also be initiated via SPI. During calibration, the RxPGA's first stage is internally shorted, and each gain stage set to a high gain setting. A digital servo loop slaves a calibration DAC, which forces the Rx input offset to be within  $\pm 32$  LSB for this particular high gain setting. Although the offset varies for other gain settings, the offset is typically limited to  $\pm 5\%$  of the ADC's 2 V input span. Note that the offset cancellation circuitry is intended to reduce the voltage offset attributed to only the RxPGA's input stage, not any dc offsets attributed to an external source.

The gain of the RxPGA should be set to minimize clipping of the ADC while utilizing most of its dynamic range. The maximum peak-to-peak differential voltage that does not result in clipping of the ADC is shown in Figure 69. While the graph suggests that maximum input signal for a gain setting of  $-12$  dB is 8.0 V p-p, the maximum input voltage into the PGA should be limited to less than 6 V p-p to prevent turning on ESD protection diodes. For applications having higher maximum input signals, consider adding an external resistive attenuator network. While the input sensitivity of the Rx path is degraded by the amount of attenuation on a dB-to-dB basis, the low noise characteristics of the RxPGA provide some design margin such that the external line noise remains the dominant source.

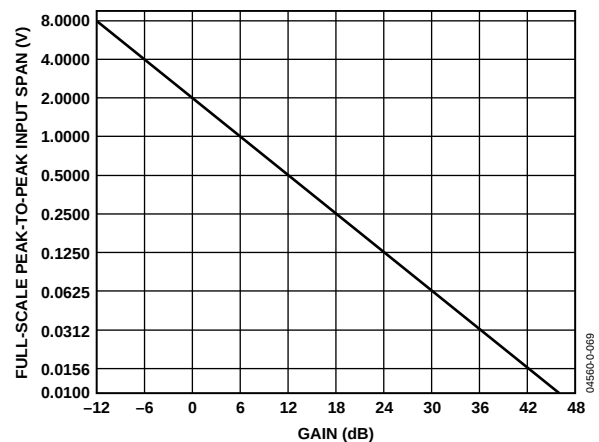


Figure 69. Maximum Peak-to-Peak Input vs. RxPGA Gain Setting that Does Not Result in ADC Clipping

## LOW-PASS FILTER

The low-pass filter (LPF) provides a third order response with a cutoff frequency that is typically programmable over a 15 MHz to 35 MHz span. Figure 68 shows that the first real pole is implemented within the first CPGA gain stage, and the complex pole pair is implemented in the second CPGA gain stage. Capacitor arrays are used to vary the different R-C time constants within these two stages in a manner that changes the cutoff frequency while preserving the normalized frequency response. Because absolute resistor and capacitor values are process-dependent, a

calibration routine lasting less than 100  $\mu$ s automatically occurs each time the target cutoff frequency register (Register 0x08) is updated, ensuring a repeatable cutoff frequency from device to device.

Although the default setting specifies that the LPF be active, it can also be bypassed providing a nominal  $f_{-3\text{ dB}}$  of 55 MHz.

Table 21 shows the SPI registers pertaining to the LPF.

**Table 21. SPI Registers for Rx Low-Pass Filter**

| Address (Hex) | Bit   | Description   |
|---------------|-------|---------------|
| 0x07          | (0)   | Enable Rx LPF |
| 0x08          | (7:0) | Target value  |

The normalized wideband gain response is shown in Figure 70. The normalized pass-band gain and group delay responses are shown in Figure 71. The normalized cutoff frequency,  $f_{-3\text{ dB}}$ , results in  $-3\text{ dB}$  attenuation. Also, the actual group delay time (GDT) response can be calculated given a programmed cutoff frequency using the following equation:

$$\text{Actual GDT} = \text{Normalized GDT} / (2.45 \times f_{-3\text{ dB}}) \quad (7)$$

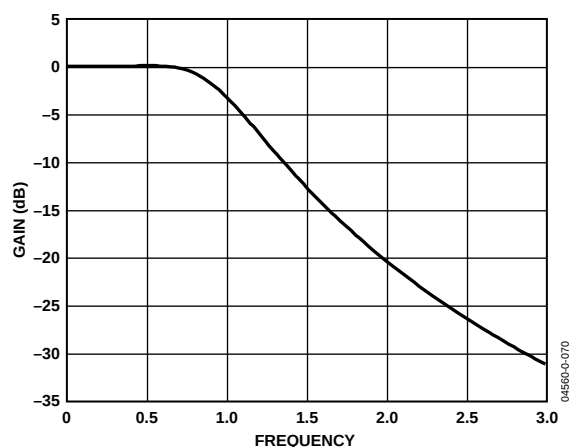


Figure 70. LPF's Normalized Wideband Gain Response

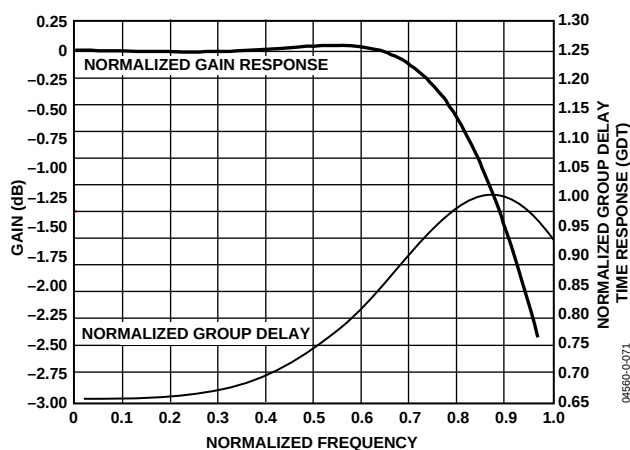


Figure 71. LPF's Normalized Pass-Band Gain and Group Delay Responses

The  $-3\text{ dB}$  cutoff frequency,  $f_{-3\text{ dB}}$ , is programmable by writing an 8-bit word, referred to as the target, to Register 0x08. The cutoff frequency is a function of the ADC sample rate,  $f_{\text{ADC}}$ , and to a lesser extent, the RxPGA gain setting (in dB). Figure 72 shows how the frequency response,  $f_{-3\text{ dB}}$ , varies as a function of the RxPGA gain setting.

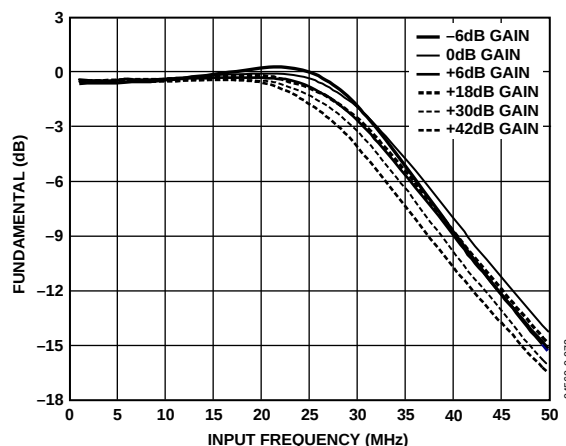


Figure 72. Effects of RxPGA Gain on LPF Frequency Response ( $f_{-3\text{ dB}} = 32\text{ MHz}$  (@  $0\text{ dB}$  and  $f_{\text{ADC}} = 80\text{ MSPS}$ )

The following formula<sup>1</sup> can be used to estimate  $f_{-3\text{ dB}}$  for a RxPGA gain setting of  $0\text{ dB}$ :

$$f_{-3\text{ dB}, 0\text{ dB}} = (128/\text{target}) \times (f_{\text{ADC}}/80) \times (f_{\text{ADC}}/30 + 23.83) \quad (8)$$

Figure 73 compares the measured and calculated  $f_{-3\text{ dB}}$  using this formula.

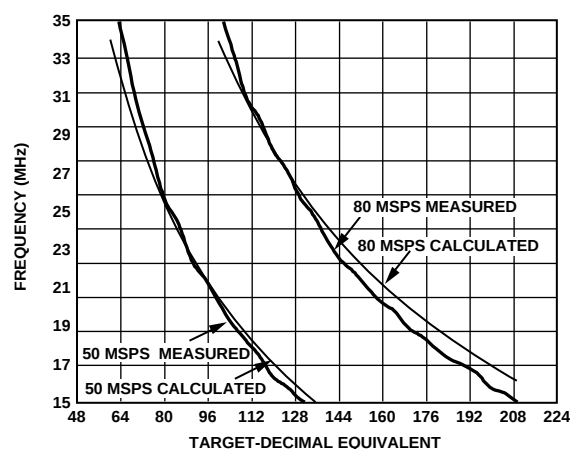


Figure 73. Measured and Calculated  $f_{-3\text{ dB}}$  vs. Target Value for  $f_{\text{ADC}} = 50\text{ MSPS}$  and  $80\text{ MSPS}$

<sup>1</sup> Empirically derived for a  $f_{-3\text{ dB}}$  range of 15 MHz to 35 MHz and  $f_{\text{ADC}}$  of 40 MSPS to 80 MSPS with an RxPGA =  $0\text{ dB}$ .

The following scaling factor can be applied to the previous formula to compensate for the RxPGA gain setting on  $f_{-3\text{ dB}}$ :

$$\text{Scale Factor} = 1 - (\text{RxPGA in dB})/382 \quad (9)$$

This scaling factor reduces the calculated  $f_{-3\text{ dB}}$  as the RxPGA is increased. Applications that need to maintain a minimum cut-off frequency,  $f_{-3\text{ dB\_MIN}}$ , for all RxPGA gain settings should first determine the scaling factor for the highest RxPGA gain setting to be used. Next, the  $f_{-3\text{ dB\_MIN}}$  should be divided by this scale factor to normalize to the 0 dB RxPGA gain setting ( $f_{-3\text{ dB\_0 dB}}$ ). Equation 8 can then be used to calculate the target value.

The LPF frequency response shows a slight sensitivity to temperature, as shown in Figure 74. Applications sensitive to temperature drift can recalibrate the LPF by rewriting the target value to Register 0x08.

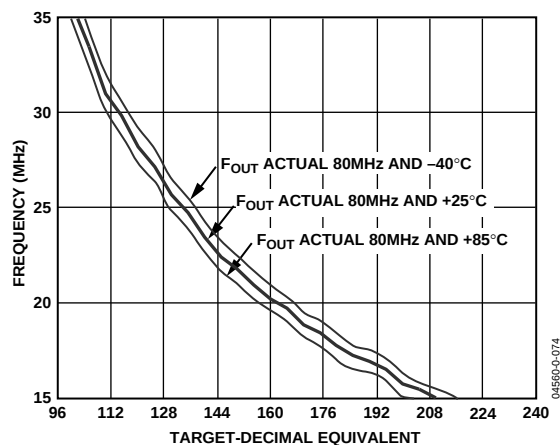


Figure 74. Temperature Drift of  $f_{-3\text{ dB}}$  for  $f_{\text{ADC}} = 80\text{ MSPS}$  and  $\text{RxPGA} = 0\text{ dB}$

## ANALOG-TO-DIGITAL CONVERTER (ADC)

The AD9866 features a 12-bit analog-to-digital converter (ADC) capable of up to 80 MSPS. Referring to Figure 68, the ADC is driven by the SPGA stage, which performs both the sample-and-hold and the fine gain adjust functions. A buffer amplifier (not shown) isolates the last CPGA gain stage from the dynamic load presented by the SPGA stage. The full-scale input span of the ADC is 2 V p-p, and depending on the PGA gain setting, the full-scale input span into the SPGA is adjustable from 1 V to 2 V in 1 dB increments.

A pipelined multistage ADC architecture is used to achieve high sample rates while consuming low power. The ADC distributes the conversion over several smaller A/D subblocks, refining the conversion with progressively higher accuracy as it passes the results from stage to stage on each clock edge. The ADC typically performs best when driven internally by a 50% duty cycle clock. This is especially the case when operating the ADC at high sample rate (55 MSPS to 80 MSPS) and/or lower internal bias levels, which adversely affect interstage settling time requirements.

The ADC sampling clock path also includes a duty cycle restorer circuit, which ensures that the ADC gets a near 50%

duty cycle clock even when presented with a clock source with poor symmetry (35/65). This circuit should be enabled, if the ADC sampling clock is a buffered version of the reference signal appearing at OSCIN (see the Clock Synthesizer section) and if this reference signal is derived from an oscillator or crystal whose specified symmetry cannot be guaranteed to be within 45/55 (or 55/45). This circuit can remain disabled, if the ADC sampling clock is derived from a divided down version of the clock synthesizer's VCO, because this clock is near 50%.

The ADC's power consumption can be reduced by 25 mA, with minimal effect on its performance, by setting Bit 4 of Register 0x07. Alternative power bias settings are also available via Register 0x13, as discussed in the Power Control and Dissipation section. Lastly, the ADC can be completely powered down for half-duplex operation, further reducing the AD9866's peak power consumption.

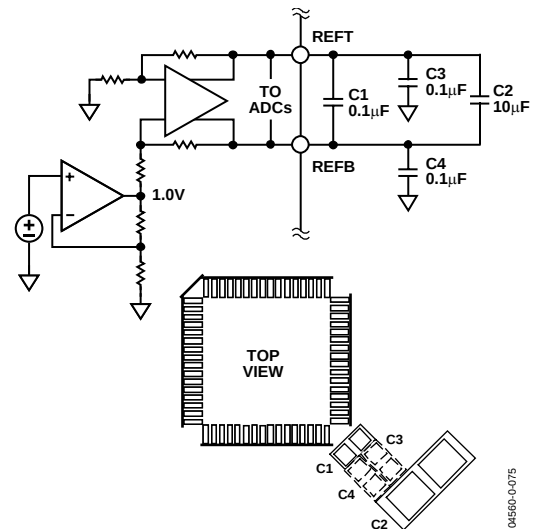


Figure 75. ADC Reference and Decoupling

The ADC has an internal voltage reference and reference amplifier as shown in Figure 75. The internal band gap reference generates a stable 1 V reference level that is converted to a differential 1 V reference centered about mid-supply ( $\text{AVDD}/2$ ). The outputs of the differential reference amplifier are available at the REFT and REFB pins and *must* be properly decoupled for optimum performance. The REFT and REFB pins are conveniently situated at the corners of the CSP package such that C1 (0603 type) can be placed directly across its pins. C3 and C4 can be placed underneath C1, and C2 (10 µF tantalum) can be placed furthest from the package.

Table 22. SPI Registers for Rx ADC

| Address (Hex) | Bit   | Description                |
|---------------|-------|----------------------------|
| 0x04          | (5)   | Duty cycle restore circuit |
|               | (4)   | ADC clock from PLL         |
| 0x07          | (4)   | ADC low power mode         |
| 0x13          | (2:0) | ADC power bias adjust      |

### AGC TIMING CONSIDERATIONS

When implementing a digital AGC timing loop, it is important to consider the Rx path latency and settling time of the Rx path in response to a change in gain setting. Figure 21 and Figure 24 show the RxPGA's settling response to a 60 dB and 5 dB change in gain setting when using the Tx[5:0] or PGA[5:0] port. While the RxPGA settling time may also show a slight dependency on the LPF's cutoff frequency, the ADC's pipeline delay along with the ADIO bus interface presents a more significant delay. The

amount of delay or latency depends on whether a half- or full-duplex is selected. An impulse response at the RxPGA's input can be observed after 10.0 ADC clock cycles ( $1/f_{\text{ADC}}$ ) in the case of a half-duplex interface and 10.5 ADC clock cycles in the case of a full-duplex interface. This latency along with the RxPGA settling time should be considered to ensure stability of the AGC loop.

## CLOCK SYNTHESIZER

The AD9866 generates all its internal sampling clocks, as well as two user-programmable clock outputs appearing at CLKOUT1 and CLKOUT2, from a single reference source as shown in Figure 76. The reference source can be either a fundamental frequency or an overtone quartz crystal connected between OSCIN and XTAL with the parallel resonant load components as specified by the crystal manufacturer. It can also be a TTL-level clock applied to OSCIN with XTAL left unconnected.

The data rate,  $f_{DATA}$ , for the Tx and Rx data paths must always be equal. Therefore, the ADC's sample rate,  $f_{ADC}$ , is always equal to  $f_{DATA}$ , while the TxDAC update rate is a factor of 1, 2, or 4 of  $f_{DATA}$ , depending on the interpolation factor selected. The data rate refers to the word rate and should not be confused with the nibble rate in full-duplex interface.

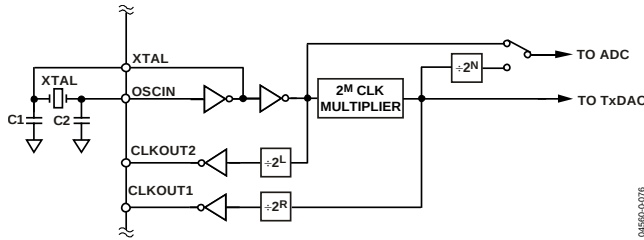


Figure 76. Clock Oscillator and Synthesizer

The  $2^M$  CLK multiplier contains a PLL (with integrated loop filter) and VCO capable of generating an output frequency that is a multiple of 1, 2, 4, or 8 of its input reference frequency,  $f_{OSCIN}$ , appearing at OSCIN. The input frequency range of  $f_{OSCIN}$  is between 20 MHz and 80 MHz, while the VCO can operate over a 40 MHz to 200 MHz span. For the best phase noise/jitter characteristics, it is advisable to operate the VCO with a frequency between 100 MHz and 200 MHz. The VCO output drives the TxDAC directly such that its update rate,  $f_{DAC}$ , is related to  $f_{OSCIN}$  by the following equation:

$$f_{DAC} = 2^M \times f_{OSCIN} \quad (10)$$

where  $M = 0, 1, 2$ , or  $3$ .

$M$  is the PLL's multiplication factor set in Register 0x04. The value of  $M$  is determined by the Tx path's word rate,  $f_{DATA}$ , and digital interpolation factor,  $F$ , as shown in the following equation:

$$M = \log_2 (F \times f_{DATA} / f_{OSCIN}) \quad (11)$$

Note: if the reference frequency appearing at OSCIN is chosen to be equal to the AD9866's Tx and Rx path's word rate, then  $M$  is simply equal to  $\log_2(F)$ .

The clock source for the ADC can be selected in Register 0x04 as a buffered version of the reference frequency appearing at OSCIN (default setting) or a divided version of the VCO output ( $f_{DAC}$ ). The first option is the default setting and most desirable if  $f_{OSCIN}$  is equal to the ADC sample rate,  $f_{ADC}$ . This option typically results in the best jitter/phase noise performance for the ADC sampling clock. The second option is suitable in cases

where  $f_{OSCIN}$  is a factor of 2 or 4 less than the  $f_{ADC}$ . In this case, the divider ratio,  $N$ , is chosen such that the divided down VCO output is equal to the ADC sample rate, as shown in the following equation:

$$f_{ADC} = f_{DAC} / 2^N \quad (12)$$

where  $N = 0, 1$ , or  $2$ .

Figure 77 shows the degradation in phase noise performance imparted onto the ADC's sampling clock for different VCO output frequencies. In this case, a 25 MHz, 1 V p-p sine wave was used to drive OSCIN and the PLL's  $M$  and  $N$  factor were selected to provide an  $f_{ADC}$  of 50 MHz for a VCO operating frequency of 50, 100, and 200 MHz. The RxPGA input was driven with a near full-scale, 12.5 MHz input signal with a gain setting of 0 dB. Operating the VCO at the highest possible frequency results in the best narrow and wideband phase noise characteristics. For comparison purposes, the clock source for the ADC was taken directly from OSCIN when driven by a 50 MHz square wave.

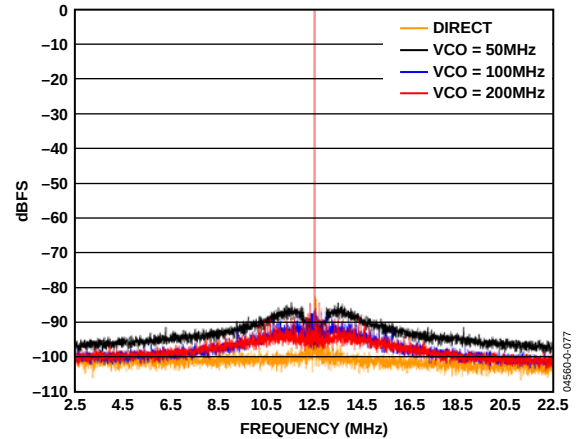


Figure 77. Comparison of Phase Noise Performance when ADC Clock Source is Derived from Different VCO Output Frequencies

The CLK synthesizer also has two clock outputs appearing at CLKOUT1 and CLKOUT2. They are programmable via Register 0x06. Both outputs can be inverted or disabled. The voltage levels appearing at these outputs are relative to DRVDD and remain active during a hardware or software reset. Table 23 shows the SPI registers pertaining to the clock synthesizer.

CLKOUT1 is a divided version of the VCO output and can be set to be a submultiple integer of  $f_{DAC}$  ( $f_{DAC} / 2^R$ , where  $R = 0, 1, 2$ , or  $3$ ). Because this clock is actually derived from the same set of dividers used within the PLL core, it is phase-locked to them such that its phase relationship relative to the signal appearing at OSCIN (or RXCLK) can be determined upon power-up. Also, this clock has near 50% duty cycle, because it is derived from the VCO. As a result, CLKOUT1 should be selected before CLKOUT2 as the primary source for system clock distribution.

CLKOUT2 is a divided version of the reference frequency,  $f_{\text{OSCIN}}$ , and can be set to be a submultiple integer of  $f_{\text{OSCIN}}$  ( $f_{\text{OSCIN}}/2^L$ , where  $L = 0, 1, \text{ or } 2$ ). With  $L$  set to 0, the output of CLKOUT2 is a delayed version of the signal appearing at OSCIN, exhibiting the same duty cycle characteristics. With  $L$  set to 1 or 2, the output of CLKOUT2 is a divided version of the OSCIN signal, exhibiting a near 50% duty cycle, but without having a deterministic phase relationship relative to CLKOUT1 (or RXCLK).

Table 23. SPI Registers for CLK Synthesizer

| Address (Hex) | Bit   | Description                    |
|---------------|-------|--------------------------------|
| 0x04          | (4)   | ADC CLK from PLL               |
|               | (3:2) | PLL divide factor (P)          |
|               | (1:0) | PLL multiplication factor (M ) |
| 0x06          | (7:6) | CLKOUT2 divide number          |
|               | (5)   | CLKOUT2 invert                 |
|               | (4)   | CLKOUT2 disable                |
|               | (3:2) | CLKOUT1 divide number          |
|               | (1)   | CLKOUT1 invert                 |
|               | (0)   | CLKOUT1 disable                |

## POWER CONTROL AND DISSIPATION

### POWER-DOWN

The AD9866 provides the ability to control the power-on state of various functional blocks. The state of the PWRDWN pin, along with the contents of Register 0x01 and Register 0x02, allow two user-defined power settings that are pin selectable. The default settings<sup>1</sup> are such that Register 0x01 has all blocks powered on (all Bits 0), while Register 0x02 has all blocks powered, down excluding the PLL, such that the clock signal remains available at CLKOUT1 and CLKOUT2. When the PWRDWN pin is low, the functional blocks corresponding to the bits in Register 0x01 are powered down. When the PWRDWN is high, the functional blocks corresponding to the bits in Register 0x02 are powered down. PWRDWN immediately affects the designated functional blocks with minimum digital delay.

**Table 24. SPI Registers Associated with Power-Down and Half-Duplex Power Savings**

| Address (Hex) | Bit   | Description        | Comments                                                                                |
|---------------|-------|--------------------|-----------------------------------------------------------------------------------------|
| 0x01          | (7)   | PLL                | PWRDWN = 0.<br><br>Default setting is all functional blocks powered on.                 |
|               | (6)   | TxDAC/IAMP         |                                                                                         |
|               | (5)   | TX Digital         |                                                                                         |
|               | (4)   | REF                |                                                                                         |
|               | (3)   | ADC CML            |                                                                                         |
|               | (2)   | ADC                |                                                                                         |
|               | (1)   | PGA BIAS           |                                                                                         |
|               | (0)   | RxPGA              |                                                                                         |
| 0x02          | (7)   | PLL                | PWRDWN = 1.<br><br>Default setting is all functional blocks powered off, excluding PLL. |
|               | (6)   | TxDAC/IAMP         |                                                                                         |
|               | (5)   | TX Digital         |                                                                                         |
|               | (4)   | REF                |                                                                                         |
|               | (3)   | ADC CML            |                                                                                         |
|               | (2)   | ADC                |                                                                                         |
|               | (1)   | PGA BIAS           |                                                                                         |
|               | (0)   | RxPGA              |                                                                                         |
| 0x03          | (7:3) | Tx OFF Delay       | Half-duplex power savings.                                                              |
|               | (2)   | Rx PWRDWN via TXEN |                                                                                         |
|               | (1)   | Enable Tx PWRDWN   |                                                                                         |
|               | (0)   | Enable Rx PWRDWN   |                                                                                         |

<sup>1</sup> With MODE = 1 and CONFIG = 1, Reg. 0x02 default settings are with all blocks powered off, with RXCLK providing a buffered version of the signal appearing at OSCIN. This setting results in the lowest power consumption upon power-up while still allowing AD9865 to generate the system clock via a crystal.

### HALF-DUPLEX POWER SAVINGS

Significant power savings can be realized in applications having a half-duplex protocol allowing only the Rx or Tx path to be operational at any instance. The power savings method depends on whether the AD9866 is configured for a full- or half-duplex interface. Functional blocks having fast power on/off times for the Tx and Rx path are controlled by the following bits: TxDAC/IAMP, TX Digital, ADC, and RxPGA.

In the case of a full-duplex digital interface (MODE = 1), one can set Register 0x01 to 0x60 and Register 0x02 to 0x05 (or vice versa) such that the AD9866's Tx and Rx path are never powered on simultaneously. The PWRDWN pin can then be used to control what path is powered on, depending on the burst type. During a Tx burst, the Rx path's PGA and ADC blocks can typically be powered down within 100 ns, while the Tx paths DAC, IAMP, and digital filter blocks are powered up within 0.5  $\mu$ s. For an Rx burst, the Tx path's can be powered down within 100 ns, while the Rx circuitry is powered up within 2  $\mu$ s.

Setting the TXQUIET pin low allows it to be used with the full-duplex interface to quickly power down the IAMP and disable the interpolation filter. This is meant to maintain backward compatibility with the AD9875/AD9876 MxFE's with the exception that the TxDAC remains powered if its IOUTP outputs are used. In most applications, the interpolation filter needs to be flushed with 0s before or after being powered down. This ensures that, upon power-up, the TxDAC (and IAMP) have a negligible differential dc offset, thus preventing spectral splatter due to an impulse transient.

Applications using a half-duplex interface (MODE = 0) can benefit from an additional power savings feature made available in Register 0x03. This register is effective only for a half-duplex interface. Besides providing power savings for half-duplex applications, this feature allows the AD9866 to be used in applications that need only its Rx (or Tx) path functionality through pin-strapping, making a serial port interface (SPI) optional. This feature also allows the PWRDWN pin to retain its default function as a master power control, as defined in Table 11.

The default settings for Register 0x03 provide fast power control of the functional blocks in the Tx and Rx signal paths (outlined above) using the TXEN pin. The TxDAC still remains powered on in this mode, while the IAMP is powered down. Significant current savings are typically realized when the IAMP is powered down.

For a Tx burst, the falling edge of TXEN is used to generate an internal delayed signal for powering down the Tx circuitry. Upon receipt of this signal, power-down of the Tx circuitry occurs within 100 ns. The user-programmable delay for the Tx path power-down is meant to match the pipeline delay of the last Tx burst sample such that power-down of the TxDAC and IAMP does not impact its transmission. A 5-bit field in Register 0x03 sets the delay from 0 to 31 TXCLK clock cycles, with the default being 31 (0.62  $\mu$ s with  $f_{TXCLK} = 50$  MSPS). The digital interpolation filter is automatically flushed with midscale samples prior to power-down, if the clock signal into the TXCLK pin is present for 33 additional clock cycles after TXEN returns low. For an Rx burst, the rising edge of TXEN is used to generate an internal signal (with no delay) that powers up the Tx circuitry within 0.5  $\mu$ s.

The Rx path power-on/power-off can be controlled by either TXEN or RXEN by setting Bit 2 of Register 0x03. In the default setting, the falling edge of TXEN powers up the Rx circuitry within 2  $\mu$ s, while the rising edge of TXEN powers down the Rx circuitry within 0.5  $\mu$ s. If RXEN is selected as the control signal, then its rising edge powers up the Rx circuitry and the falling edge powers it down. To disable the fast power-down of the Tx and/or Rx circuitry, set Bit 1 and/or Bit 0 to 0.

## POWER REDUCTION OPTIONS

The power consumption of the AD9866 can be significantly reduced from its default setting by optimizing the power consumption vs. performance of the various functional blocks in the Tx and Rx signal path. On the Tx path, minimum power consumption is realized when the TxDAC output is used directly and its standing current,  $I$ , is reduced to as low as 1 mA. Although a slight degradation in THD performance results at reduced standing currents, it often remains adequate for most applications, because the op amp driver typically limits the overall linearity performance of the Tx path. The load resistors used at the TxDAC outputs (IOUTP+ and IOUTP-) can be increased to generate an adequate differential voltage that can be further amplified via a power efficient op amp based driver solution. Figure 78 shows how the supply current for the TxDAC (Pin 43) is reduced from 55 mA to 14 mA as the standing current is reduced from 12.5 mA to 1.25 mA. Further Tx power savings can be achieved by bypassing or reducing the interpolation factor of the digital filter as shown in Figure 79.

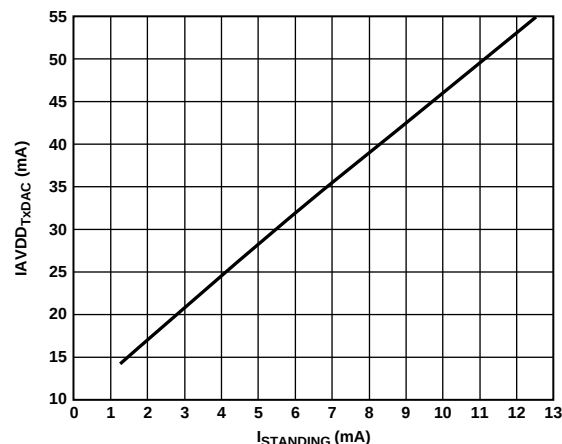


Figure 78. Reduction in TxDAC's Supply Current vs. Standing Current

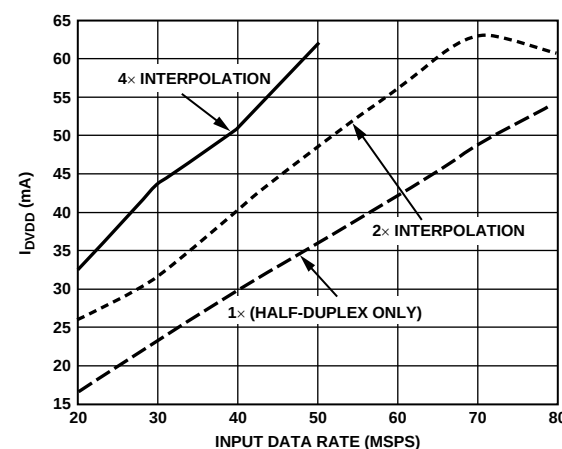


Figure 79. Digital Supply Current Consumption vs. Input Data Rate ( $DVDD = DRVDD = 3.3$  V and  $f_{OUT} = f_{DATA}/10$ )

Power consumption on the Rx path can be achieved by reducing the bias levels of the various amplifiers contained within the RxPGA and ADC. As previously noted, the RxPGA consists of two CPGA amplifiers and one SPGA amplifier. The bias levels of each of these amplifiers along with the ADC can be controlled via Register 0x13 as shown in Table 25. The default setting for Register 0x13 is 0x00.

Table 25. SPI Register for RxPGA and ADC Biasing

| Address (Hex) | Bit   | Description           |
|---------------|-------|-----------------------|
| 0x07          | (4)   | ADC low power         |
| 0x13          | (7:5) | CPGA bias adjust      |
|               | (4:3) | SPGA bias adjust      |
|               | (2:0) | ADC power bias adjust |

Because the CPGA processes signals in the continuous time domain, its performance vs. bias setting remains mostly independent of the sample rate. Table 26 shows how the typical current consumption seen at AVDD (Pins 35 and 40) varies as a function of Bits (7:5), while the remaining bits are maintained at their default settings of 0. Only four of the possible settings result in any reduction in current consumption relative to the default setting. Reducing the bias level typically results in a degradation in the THD vs. frequency performance as shown in Figure 80. This is due to a reduction of the amplifier's unity gain bandwidth, while the SNR performance remains relatively unaffected.

**Table 26. Analog Supply Current vs. CPGA Bias Settings at  $f_{ADC} = 65$  MSPS**

| Bit 7 | Bit 6 | Bit 5 | $\Delta$ mA |
|-------|-------|-------|-------------|
| 0     | 0     | 0     | 0           |
| 0     | 0     | 1     | -27         |
| 0     | 1     | 0     | -42         |
| 0     | 1     | 1     | -51         |
| 1     | 0     | 0     | -55         |
| 1     | 0     | 1     | 27          |
| 1     | 1     | 0     | 69          |
| 1     | 1     | 1     | 27          |

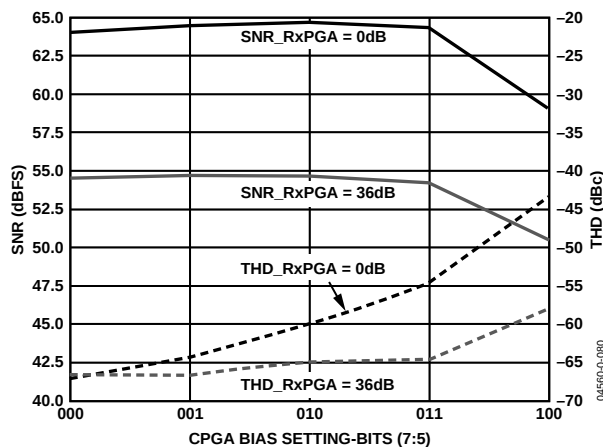


Figure 80. THD vs.  $f_{IN}$  Performance and RxPGA Bias Settings (000,001,010,100 with RxPGA = 0 and +36 dB and AIN = -1 dBFS, LPF set to 26 MHz and  $f_{ADC} = 50$  MSPS)

The SPGA is implemented as a switched capacitor amplifier; therefore, its performance vs. bias level is mostly dependent on the sample rate. Figure 81 shows how the typical current consumption seen at AVDD (Pin 35 and Pin 40) varies as a function of Bits (4:3) and sample rate, while the remaining bits are maintained at the default setting of 0. Figure 82 shows how the SNR and THD performance is affected for a 10 MHz sine wave input as the ADC sample rate is swept from 20 MHz to 80 MHz.

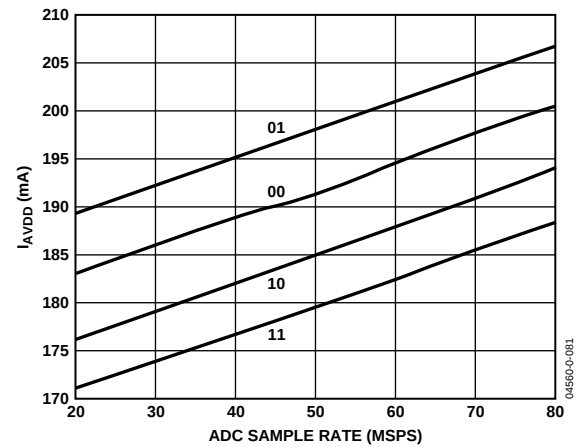


Figure 81. AVDD Current vs. SPGA Bias Setting and Sample Rate

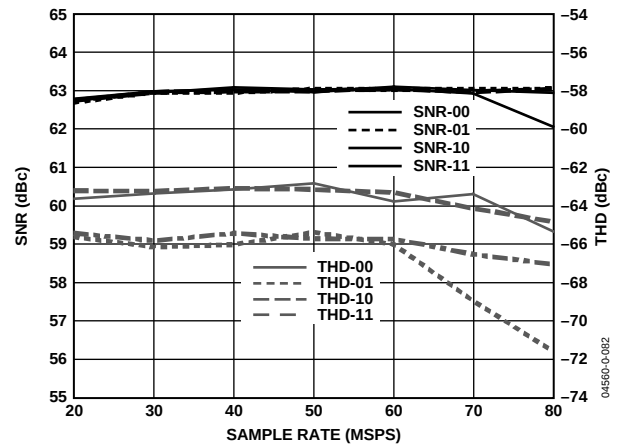


Figure 82. SNR and THD Performance vs.  $f_{ADC}$  and SPGA Bias Setting with RxPGA = 0 dB,  $f_{IN} = 10$  MHz, AIN = -1 dBFS

The ADC is based on a pipeline architecture with each stage consisting of a switched capacitor amplifier. Therefore, its performance vs. bias level is mostly dependent on the sample rate. Figure 83 shows how the typical current consumption seen at AVDD (Pin 35 and Pin 40) varies as a function of Bits (2:0) and sample rate, while the remaining bits are maintained at the default setting of 0. Setting Bit 4 or Register 0x07 corresponds to the 011 setting, and the settings of 101 and 111 result in higher current consumption. Figure 84 shows how the SNR and THD performance are affected for a 10 MHz sine wave input for the lower power settings as the ADC sample rate is swept from 20 MHz to 80 MHz.

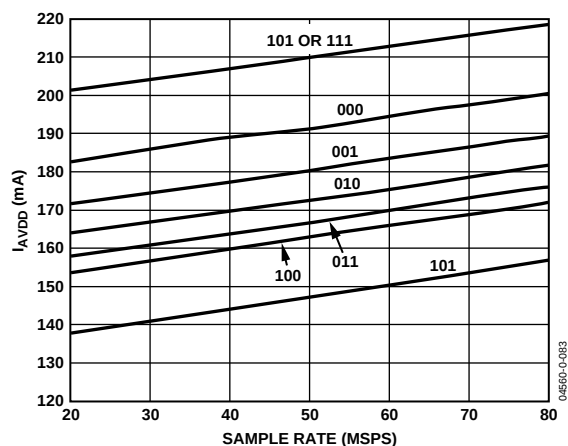


Figure 83. AVDD Current vs. ADC Bias Setting and Sample Rate

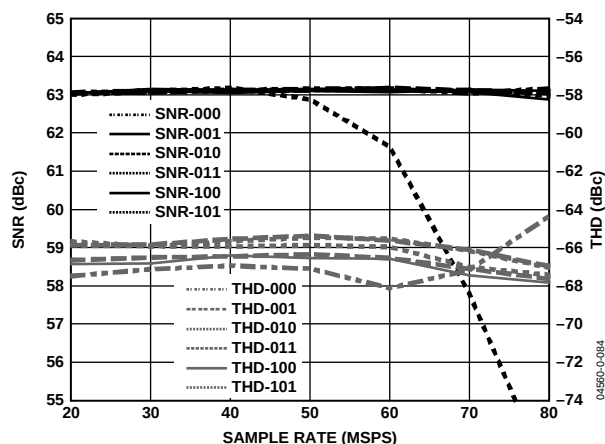


Figure 84. SNR and THD Performance vs.  $f_{ADC}$  and ADC Bias Setting with  $RxPGA = 0$  dB,  $f_{IN} = 10$  MHz,  $A_{IN} = -1$  dBFS

A sine wave input is a standard and convenient method of analyzing the performance of a system. However, the amount of power reduction that is possible is application dependent, based on the nature of the input waveform (such as frequency content, peak-to-rms ratio), the minimum ADC sample, and the minimum acceptable level of performance. Thus, it is advisable that power-sensitive applications optimize the power bias setting of the Rx path using an input waveform that is representative of the application.

## POWER DISSIPATION

The power dissipation of the AD9866 can become quite high in full-duplex applications in which the Tx and Rx paths are simultaneously operating with nominal power bias settings. In fact, some applications that use the IAMP may need to either reduce its peak power capabilities or reduce the power consumption of the Rx path, so that the device's maximum allowable power consumption,  $P_{MAX}$ , is not exceeded.

$P_{MAX}$  is specified at 1.66 W to ensure that the die temperature does not exceed 125°C at an ambient temperature of 85°C. This specification is based on the 64-pin LFSCP having a thermal resistance,  $\theta_{JA}$ , of 24°C/W with its heat slug soldered. (The  $\theta_{JA}$  is 30.8°C/W, if the heat slug remains unsoldered.) If a particular application's maximum ambient temperature,  $T_A$ , falls below 85°C, the maximum allowable power dissipation can be determined by the following equation:

$$P_{MAX} = 1.66 + (85 - T_A)/24 \quad (13)$$

Assuming the IAMP's common-mode bias voltage is operating off the same analog supply as the AD9866, the following equation can be used to calculate the maximum total current consumption,  $I_{MAX}$ , of the IC:

$$I_{MAX} = (P_{MAX} - P_{IAMP})/3.47 \quad (14)$$

With an ambient temperature of up to 85°C,  $I_{MAX}$  is 478 mA.

If the IAMP is operating off a different supply or in the voltage mode configuration, first calculate the power dissipated in the IAMP,  $P_{IAMP}$ , using Equation 2 or Equation 5, and then recalculate  $I_{MAX}$ , using Equation 14.

Figure 78, Figure 79, Figure 81, and Figure 83 can be used to calculate the current consumption of the Rx and Tx paths for a given setting.

## MODE SELECT UPON POWER-UP AND RESET

The AD9866 power-up state is determined by the logic levels appearing at the MODE and CONFIG pins. The MODE pin is used to select a half- or full-duplex interface by pin strapping it low or high, respectively. The CONFIG pin is used in conjunction with the MODE pin to determine the default settings for the SPI registers as outlined in Table 11.

The intent of these particular default settings is to allow some applications to avoid using the SPI (disabled by pin-strapping SEN high), thereby reducing implementation costs. For example, setting MODE low and CONFIG high configures the AD9866 to be backward-compatible with the AD9975, while setting MODE high and CONFIG low makes it backward-compatible with the AD9875. Other applications must use the SPI to configure the device.

A hardware ( $\overline{\text{RESET}}$  pin) or software (Bit 5 of Register 0x00) reset can be used to place the AD9866 into a known state of operation as determined by the state of the MODE and CONFIG pins. A dc offset calibration and filter tuning routine is also initiated upon a hardware reset, but not with a software reset. Neither reset method flushes the digital interpolation filters in the Tx path. Refer to the Half-Duplex Mode and Full-Duplex Mode sections for information on flushing the digital filters.

A hardware reset can be triggered by pulsing the  $\overline{\text{RESET}}$  pin low for a minimum of 50 ns. The SPI registers are instantly reset to their default settings upon  $\overline{\text{RESET}}$  going low, while the dc offset calibration and filter tuning routine is initiated upon  $\overline{\text{RESET}}$  returning high. To ensure sufficient power-on time of the various functional blocks,  $\overline{\text{RESET}}$  returning high should occur no less than 10 ms upon power-up. If a digital reset signal from a microprocessor reset circuit (such as ADM1818) is not available, a simple R-C network referenced to DVDD can be used to hold  $\overline{\text{RESET}}$  low for approximately 10 ms upon power-up.

### ANALOG AND DIGITAL LOOPBACK TEST MODES

The AD9866 features analog and digital loopback capabilities that can assist in system debug and final test. Analog loopback routes the digital output of the ADC back into the Tx data path prior to the interpolation filters such that the Rx input signal can be monitored at the output of the TxDAC or IAMP. As a result, the analog loopback feature can be used for a half- or full-duplex interface to allow testing of the functionality of the entire IC (excluding the digital data interface).

For example, the user can configure the AD9866 with similar settings as the target system, inject an input signal (sinusoidal waveform) into the Rx input, and monitor the quality of the reconstructed output from the TxDAC or IAMP to ensure a minimum level of performance. In this test, the user can exercise the RxPGA as well as validate the attenuation characteristics of the RxLPF. Note that the RxPGA gain setting should be selected such that the input does not result in clipping of the ADC.

Digital loopback can be used to test the full-duplex digital interface of the AD9866. In this test, data appearing on the Tx[5:0] port is routed back to the Rx[5:0] port, thereby confirming proper bus operation. The Rx port can also be three-stated for half- and full-duplex interfaces.

**Table 27. SPI Registers for Test Modes**

| Address (Hex) | Bit | Description         |
|---------------|-----|---------------------|
| 0x0D          | (7) | Analog loopback     |
|               | (6) | Digital loopback    |
|               | (5) | Rx port three-state |

## PCB DESIGN CONSIDERATIONS

Although the AD9866 is a mixed-signal device, the part should be treated as an analog component. The on-chip digital circuitry has been specially designed to minimize the impact of its digital switching noise on the MxFE's analog performance.

To achieve the best performance, the power, grounding, and layout recommendations in this section should be followed. Assembly instructions for the micro-lead frame package can be found in an application note from Amkor at: [www.amkor.com/products/notes\\_papers/MLF\\_AppNote\\_0902.pdf](http://www.amkor.com/products/notes_papers/MLF_AppNote_0902.pdf).

### COMPONENT PLACEMENT

If the three following guidelines of component placement are followed, chances for getting the best performance from the MxFE are greatly increased. First, manage the path of return currents flowing in the ground plane so that high frequency switching currents from the digital circuits do not flow on the ground plane under the MxFE or analog circuits. Second, keep noisy digital signal paths and sensitive receive signal paths as short as possible. Third, keep digital (noise generating) and analog (noise susceptible) circuits as far away from each other as possible.

To best manage the return currents, pure digital circuits that generate high switching currents should be closest to the power supply entry. This keeps the highest frequency return current paths short and prevents them from traveling over the sensitive MxFE and analog portions of the ground plane. Also, these circuits should be generously bypassed at each device, which further reduces the high frequency ground currents. The MxFE should be placed adjacent to the digital circuits, such that the ground return currents from the digital sections do not flow in the ground plane under the MxFE.

The AD9866 has several pins that are used to decouple sensitive internal nodes. These pins are REFIO, REFB, and REFT. The decoupling capacitors connected to these points should have low ESR and ESL. These capacitors should be placed as close to the MxFE as possible (see Figure 75) and be connected directly to the analog ground plane. The resistor connected to the REFADJ pin should also be placed close to the device and connected directly to the analog ground plane.

### POWER PLANES AND DECOUPLING

While the AD9866 evaluation board demonstrates a very good power supply distribution and decoupling strategy, it can be further simplified for many applications. The board has four layers: two signal layers, one ground plane, and one power plane. While the power plane on the evaluation board is split into multiple analog and digital subsections, a permissible alternative would be to have AVDD and CLKVDD share the same analog 3.3 V power plane. A separate analog plane/supply may be allocated to the IAMP, if its supply voltage differs from the 3.3 V required by AVDD and CLKVDD. On the digital side, DVDD and DRVDD can share the same 3.3 V digital power plane. This digital power plane brings the current used to power the digital portion of the MxFE and its output drivers. This digital plane should be kept from going underneath the analog components.

The analog and digital power planes allocated to the MxFE may be fed from the same low noise voltage source; however, they should be decoupled from each other to prevent the noise generated in the digital portion of the MxFE from corrupting the AVDD supply. This can be done by using ferrite beads between the voltage source and the respective analog and digital power planes with a low ESR, bulk decoupling capacitor on the MxFE side of the ferrite. Each of the MxFE's supply pins (AVDD, CLKVDD, DVDD, and DRVDD) should also have dedicated low ESR, ESL decoupling capacitors. The decoupling capacitors should be placed as close to the MxFE supply pins as possible.

### GROUND PLANES

The AD9866 evaluation board uses a single serrated ground plane to help prevent any high frequency digital ground currents from coupling over to the analog portion of the ground plane. The digital currents affiliated with the high speed data bus interface (Pin 1 to Pin 16) have the highest potential of generating problematic high frequency noise. A ground serration that contains these currents should reduce the effects of this potential noise source.

The ground plane directly underneath the MxFE should be continuous and uniform. The 64-lead LFCSP package is designed to provide excellent thermal conductivity. This is partly achieved by incorporating an exposed die paddle on the bottom surface of the package. However, to take full advantage of this feature, the PCB must have features to effectively conduct heat away from the package. This can be achieved by incorporating thermal pad and thermal vias on the PCB. While a thermal pad provides a solderable surface on the top surface of the PCB (to solder the package die paddle on the board), thermal vias are needed to provide a thermal path to inner and/or bottom layers of the PCB to remove the heat.

Lastly, all ground connections should be made as short as possible. This results in the lowest impedance return paths and the quietest ground connections.

**SIGNAL ROUTING**

The digital Rx and Tx signal paths should be kept as short as possible. Also, the impedance of these traces should have a controlled characteristic impedance of about 50  $\Omega$ . This prevents poor signal integrity and the high currents that can occur during undershoot or overshoot caused by ringing. If the signal traces cannot be kept shorter than about 1.5 inches, series termination resistors (33  $\Omega$  to 47  $\Omega$ ) should be placed close to all digital signal sources. It is a good idea to series-terminate all clock signals at their source, regardless of trace length.

The receive RX+ and RX– signals are the most sensitive signals on the entire board. Careful routing of these signals is essential for good receive path performance. The RX+ and RX– signals form a differential pair and should be routed together as a pair. By keeping the traces adjacent to each other, noise coupled onto the signals appears as common mode and is largely rejected by the MxFE receive input. Keeping the driving point impedance of the receive signal low and placing any low-pass filtering of the signals close to the MxFE further reduces the possibility of noise corrupting these signals.

## EVALUATION BOARD

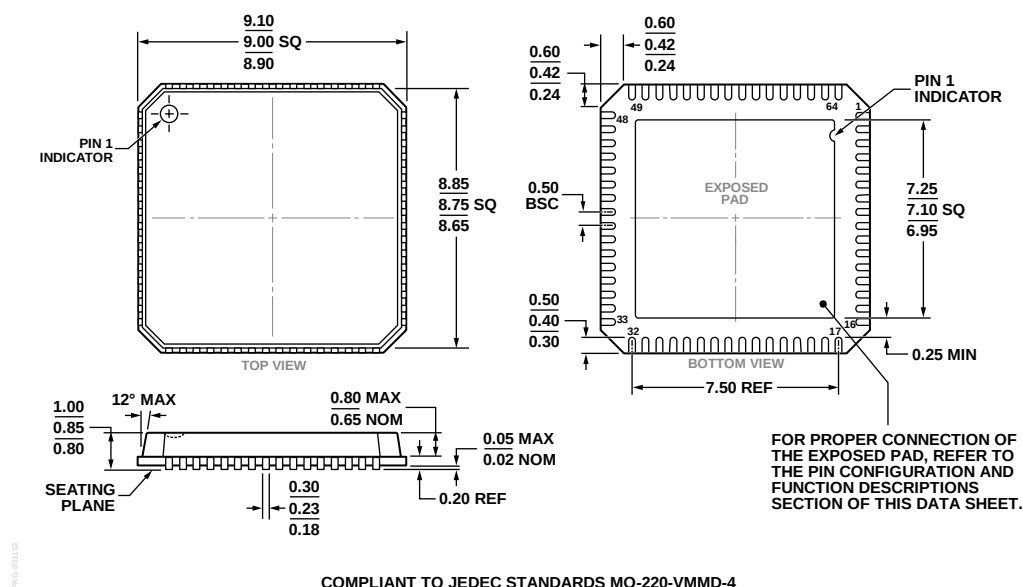
An evaluation board is available for the AD9865 and AD9866. The digital interface to the evaluation board can be configured for a half- or full-duplex interface. Two 40-pin and one 26-pin male right angle headers (0.100 inches) provide easy interfacing to test equipment such as digital data capture boards, pattern generators, or custom digital evaluation boards (FPGA, DSP, or ASIC). The reference clock source can originate from an external generator, crystal oscillator, or crystal. Software and an interface cable are included to allow for programming of the SPI registers via a PC.

The analog interface on the evaluation board provides a full analog front-end reference design for power line applications. It includes a power line socket, line transformer, protection diodes, and passive filtering components. An auxiliary path allows independent monitoring of the ac power line. The evaluation board allows complete optimization of power line reference designs based around the AD9865 or AD9866.

Alternatively, the evaluation board allows independent evaluation of the TxDAC, IAMP, and Rx paths via SMA connectors. The IAMP can be easily configured for a voltage or current mode interface via jumper settings. The TxDAC's performance can be evaluated directly or via an optional dual op amp driver stage. The Rx path includes a transformer and termination resistor, allowing for a calibrated differential input signal to be injected into its front end.

The Analog Devices, Inc. website offers more information on the AD9865/AD9866 evaluation board.

## OUTLINE DIMENSIONS



## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Package Description                              | Package Option |
|--------------------|-------------------|--------------------------------------------------|----------------|
| AD9866BCPZ         | −40°C to +85°C    | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-64-3        |
| AD9866BCPZRL       | −40°C to +85°C    | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-64-3        |

<sup>1</sup> Z = RoHS Compliant Part.